3V 8M-BIT
SERIAL NOR FLASH MEMORY WITH DUAL/QUAD SPI, QPI

Industrial Plus Grade

Publication Release Date: May 21, 2026

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com
微信扫码咨询客服

Table of Contents

1. GENERAL DESCRIPTIONS 4
2. FEATURES 4
3. PACKAGE TYPES AND PIN CONFIGURATIONS 5
   - 3.1 Pin Configuration SOP 150/208-mil 5
   - 3.2 Pad Configuration WSON 6x5-mm & XSON 2x3-mm 5
   - 3.3 Pin Description SOP 150/208-mil, WSON 6x5-mm, XSON 2x3-mm 5
   - 3.4 Ball Configuration WLCSP 6
   - 3.5 Ball Description WLCSP 6
4. PIN DESCRIPTIONS 7
   - 4.1 Chip Select (/CS) 7
   - 4.2 Serial Data Input, Output and IOs (DI, DO and IO0, IO1, IO2, IO3) 7
   - 4.3 Write Protect (/WP) 7
   - 4.4 HOLD (/HOLD) 7
   - 4.5 Serial Clock (CLK) 7
   - 4.6 Reset (/RESET) 7
5. FUNCTIONAL DESCRIPTIONS 9
   - 5.1 SPI / QPI Operations 9
     - 5.1.1 Standard SPI Instructions 9
     - 5.1.2 Dual SPI Instructions 9
     - 5.1.3 Quad SPI Instructions 10
     - 5.1.4 QPI Instructions 10
     - 5.1.5 Hold Function 10
     - 5.1.6 Software Reset & Hardware /RESET pin 11
   - 5.2 Write Protection 12
     - 5.2.1 Write Protect Features 12
6. STATUS AND CONFIGURATION REGISTERS 13
     - 6.1.1 Erase/Write In Progress (BUSY) – *Status Only* 13
     - 6.1.2 Write Enable Latch (WEL) – *Status Only* 13
     - 6.1.3 Block Protect Bits (BP2, BP1, BP0) – *Volatile/Non-Volatile Writable* 13
     - 6.1.4 Top/Bottom Block Protect (TB) – *Volatile/Non-Volatile Writable* 13
     - 6.1.5 Sector/Block Protect Bit (SEC) – *Volatile/Non-Volatile Writable* 14
     - 6.1.6 Complement Protect (CMP) – *Volatile/Non-Volatile Writable* 14
     - 6.1.7 Status Register Protect (SRP, SRL) 14
     - 6.1.8 Erase/Program Suspend Status (SUS) – *Status Only* 15
     - 6.1.9 Security Register Lock Bits (LB3, LB2, LB1,LB0) –*Volatile//Non-Volatile OTP Writable* 15
     - 6.1.10 Quad Enable (QE) – *Volatile/Non-Volatile Writable* 16
     - 6.1.11 Output Driver Strength (DRV1, DRV0) – *Volatile/Non-Volatile Writable* 16
     - 6.1.12 Reserved Bits – *Non Functional* 16
     - 6.1.13 W25Q80RV Status Register Memory Protection (CMP = 0) 17
     - 6.1.14 W25Q80RV Status Register Memory Protection (CMP = 1) 18
7. INSTRUCTIONS 19
   - 7.1 Device ID and Instruction Set Tables 19

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

7.1.1 Manufacturer and Device Identification 19
7.1.2 Command Set Table 1 (Standard SPI Commands) (1) 20
7.1.3 Command Set Table 2 (Dual/Quad SPI Commands) (1) 21
7.1.4 Command Set Table 3 (QPI Commands)(10) 22
7.2 Instruction Descriptions 24
7.2.1 Write Enable (06h) 24
7.2.2 Write Enable for Volatile Status Register (50h) 24
7.2.3 Write Disable (04h) 25
7.2.4 Read Status Register-1 (05h), Status Register-2 (35h) & Status Register-3 (15h) 25
7.2.5 Write Status Register-1 (01h), Status Register-2 (31h) & Status Register-3 (11h) 26
7.2.6 Read Data (03h) 28
7.2.7 Fast Read (0Bh) 29
Fast Read (0Bh) in QPI Mode 30
7.2.8 Fast Read Dual Output (3Bh) 31
7.2.9 Fast Read Quad Output (6Bh) 32
7.2.10 Fast Read Dual I/O (BBh) 33
7.2.11 Fast Read Quad I/O (EBh) 35
Fast Read Quad I/O (EBh) in QPI Mode 37
7.2.12 Set Burst with Wrap (77h) 38
7.2.13 Page Program (02h) 39
7.2.14 Quad Input Page Program (32h) 41
7.2.15 Sector Erase (20h) 42
7.2.16 32KB Block Erase (52h) 43
7.2.17 64KB Block Erase (D8h) 44
7.2.18 Chip Erase (C7h / 60h) 45
7.2.19 Erase / Program Suspend (75h) 46
7.2.20 Erase / Program Resume (7Ah) 48
7.2.21 Power-down (B9h) 49
7.2.22 Release Power-down / Device ID (ABh) 50
7.2.23 Read Manufacturer / Device ID (90h) 52
7.2.24 Read Manufacturer / Device ID Dual I/O (92h) 53
7.2.25 Read Manufacturer / Device ID Quad I/O (94h) 54
7.2.26 Read Unique ID Number (4Bh) 55
7.2.27 Read JEDEC ID (9Fh) 56
7.2.28 Read SFDP Register (5Ah) 57
7.2.29 Erase Security Registers (44h) 58
7.2.30 Program Security Registers (42h) 59
7.2.31 Read Security Registers (48h) 60
7.2.32 Set Read Parameters (C0h) 61
7.2.33 Burst Read with Wrap (0Ch) 63
7.2.34 Enter QPI Mode (38h) 64
7.2.35 Exit QPI Mode (FFh) 65
7.2.36 Enable Reset (66h) and Reset Device (99h) 66
8. ELECTRICAL CHARACTERISTICS 67
8.1 Absolute Maximum Ratings (1) 67

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

8.2 Operating Ranges 67
8.3 Power-Up Power-Down Timing and Requirements 68
8.3.1 Power Cycle Requirement 69
8.4 DC Electrical Characteristics(1)- 70
8.5 AC Measurement Conditions 71
8.6 AC Electrical Characteristics(9) 72
8.7 Serial Output Timing 74
8.8 Serial Input Timing 74
8.9 /HOLD Timing 74
8.10 WP Timing 74
9. PACKAGE SPECIFICATIONS 75
9.1 8-Pin SOP 150-mil (Package Code SN) 75
9.2 8-Pin SOP 208-mil (Package Code SS) 76
9.3 8-Pad WSON 6x5-mm (Package Code ZP) 77
9.4 8-Pad XSON 2x3x0.4-mm (Package Code XH) 78
9.5 8-Ball WLCSP (Package Code BY) 79
10. ORDERING INFORMATION 80
10.1 Valid Part Numbers and Top Side Marking 81
10.2 Initial delivery status 81
11. REVISION HISTORY 82

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

1. GENERAL DESCRIPTIONS

The W25Q80RV (8M-bit) Serial Flash memory provides a storage solution for systems with limited space, pins and power. The 25Q series offers flexibility and performance well beyond ordinary Serial Flash devices. They are ideal for code shadowing to RAM, executing code directly from Dual/Quad SPI (XIP) and storing voice, text and data. The device operates on a single 2.7V to 3.6V power supply with current consumption as low as 0.1µA for power-down.

The W25Q80RV array is organized into 4,096 programmable pages of 256-bytes each. Up to 256 bytes can be programmed at a time. Pages can be erased in groups of 16 (4KB sector erase), groups of 128 (32KB block erase), groups of 256 (64KB block erase) or the entire chip (chip erase). The W25Q80RV has 256 erasable sectors and 16 erasable blocks respectively. The small 4KB sectors allow for greater flexibility in applications that require data and parameter storage. (See Figure 2.)

The W25Q80RV supports the standard Serial Peripheral Interface (SPI), and a high performance Dual/Quad output as well as Dual/Quad I/O SPI: Serial Clock, Chip Select, Serial Data I/O0 (DI), I/O1 (DO), I/O2(/WP), and I/O3 (/HOLD). SPI clock frequencies of up to 133MHz are supported allowing equivalent clock rates of 266MHz (133MHz x 2) for Dual I/O and 532MHz (133MHz x 4) for Quad I/O when using the Fast Read Dual/Quad I/O commands. These transfer rates can outperform standard Asynchronous 8 and 16-bit Parallel Flash memories. The Read Command Bypass Mode allows for efficient memory access with as few as 8-clocks of command-overhead to read a 24-bit address, allowing true XIP (execute in place) operation.

A Hold pin, Write Protect pin and programmable write protection, with top or bottom array control, provide further control flexibility Additionally, the device supports JEDEC standard manufacturer and device ID and SFDP Register, a 64-bit Unique Serial Number and three 256-bytes Security Registers.

2. FEATURES

- **New Family of SpiFlash Memories**
  - W25Q80RV: 8M-bit / 1M-byte (1,048,576)
  - Standard SPI: CLK, /CS, DI, DO, /WP, /Hold
  - Dual SPI: CLK, /CS, IO_0, IO_1, /WP, /Hold
  - Quad SPI: CLK, /CS, IO_0, IO_1, IO_2, IO_3
  - Software & Hardware Reset
- **Highest Performance Serial Flash**
  - 133MHz Single, Dual/Quad SPI clocks
  - 266/532MHz equivalent Dual/Quad SPI
  - 66MB/S continuous data transfer rate
  - Min. 100K Program-Erase cycles
  - More than 20-year data retention
- **Efficient "Continuous Read"**
  - Continuous Read with 8/16/32/64-Byte Wrap
  - As few as 8 clocks to address memory
  - Allows true XIP (execute in place) operation
  - Outperforms X16 Parallel Flash
- **Low Power, Wide Temperature Range**
  - Single 2.7 to 3.6V supply
  - -40°C to +105°C operating range
  - <1µA Power-down (typ.)
- **Flexible Architecture with 4KB sectors**
  - Uniform Sector/Block Erase (4K/32K/64K-Byte)
  - Program 1 to 256 byte per programmable page
  - Erase/Program Suspend & Resume
- **Advanced Security Features**
  - Software and Hardware Write-Protect
  - Power Supply Lock-Down and
  - Special OTP protection
  - Top/Bottom, Complement array protection
  - 64-Bit Unique ID for each device
  - Discoverable Parameters (SFDP) Register
  - 3X256-Bytes Security Registers with OTP locks
  - Volatile & Non-volatile Status Register Bits
- **Space Efficient Packaging:**
  - 8-pin SOP 150-mil
  - 8-pin SOP 208-mil
  - 8-pad XSON 2X3mm(1)
  - 8-pad WSON 6x5-mm
  - Contact Winbond for KGD and other options

Note:
1. These package types are special order, please contact Winbond for more information.

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

3. PACKAGE TYPES AND PIN CONFIGURATIONS

3.1 Pin Configuration SOP 150/208-mil

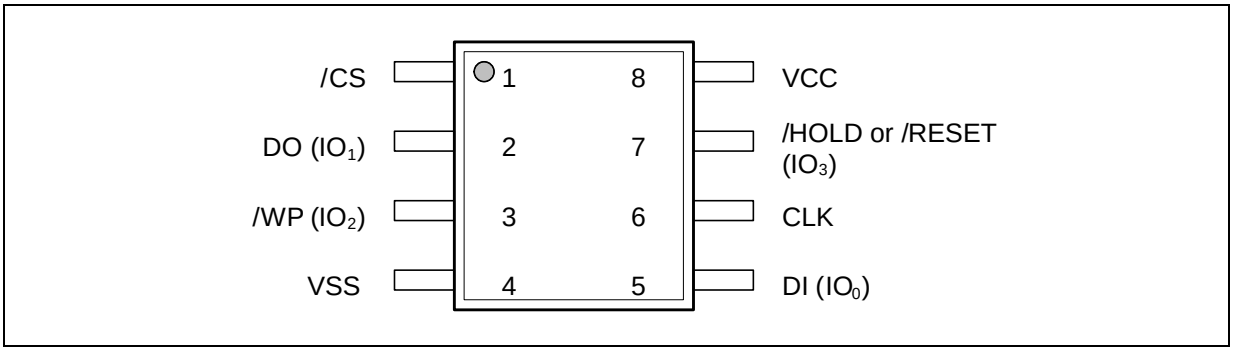


Figure 1a. Pin Assignments, 8-pin SOP 150/208-MIL (Package Code SN, SS)

3.2 Pad Configuration WSON 6x5-mm & XSON 2x3-mm

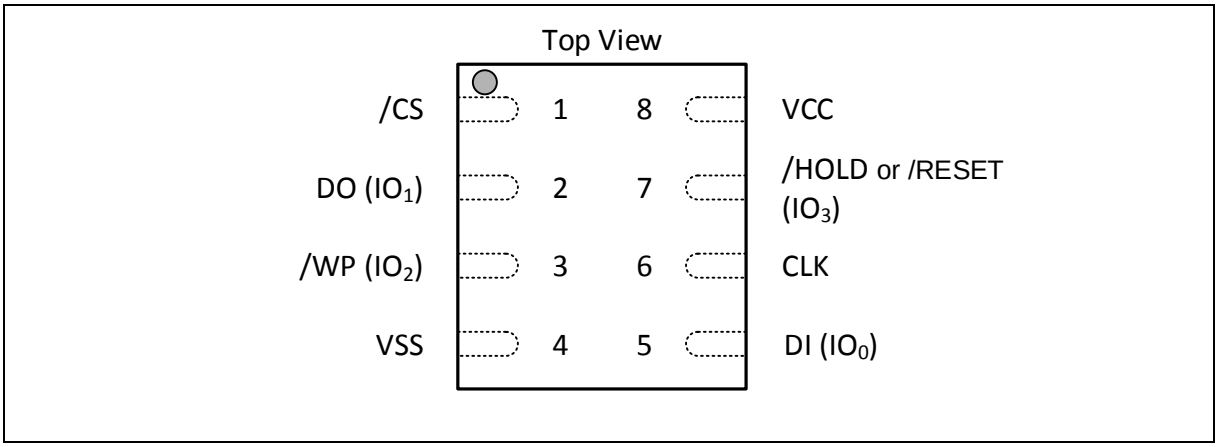


Figure 1b. Pad Assignments, 8-pad WSON 6x5-mm, USON 2X3-mm (Package Code ZP & XH)

3.3 Pin Description SOP 150/208-mil, WSON 6x5-mm, XSON 2x3-mm

PIN NO.	PIN NAME	I/O	FUNCTION
1	/CS	I	Chip Select Input
2	DO (IO1)	I/O	Data Output (Data Input Output 1)(1)
3	/WP (IO2)	I/O	Write Protect Input (Data Input Output 2)(2)
4	VSS		Ground
5	DI (IO0)	I/O	Data Input (Data Input Output 0)(1)
6	CLK	I	Serial Clock Input
7	/HOLD or /RESET (IO3)	I/O	Hold or Reset Input (Data Input Output 3)(2)
8	VCC		Power Supply

Notes:

1. IO0 and IO1 are used for Standard and Dual SPI commands
2. IO0 – IO3 are used for Quad SPI commands, /HOLD (or /RESET) functions are only available for Standard/Dual SPI.

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

3.4 Ball Configuration WLCSP

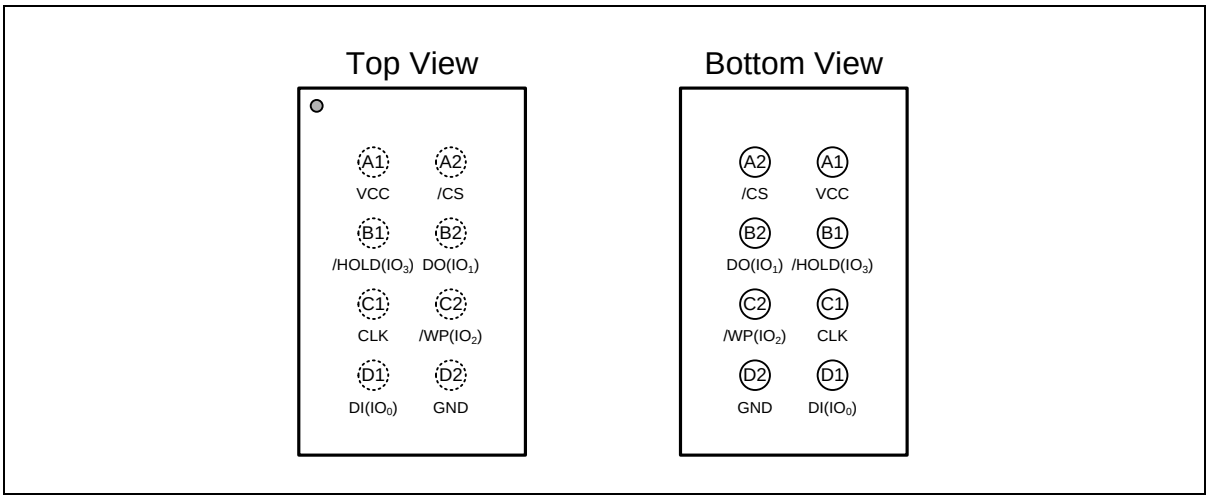


Figure 1c. W25QRV Ball Assignments, 8-ball WLCSP (Package Code BY)

3.5 Ball Description WLCSP

BALL NO.	PIN NAME	I/O	FUNCTION
A1	VCC		Power Supply
A2	/CS	I	Chip Select Input
B1	/HOLD (IO3)	I/O	Hold Input (Data Input Output 3)*2
B2	DO (IO1)	I/O	Data Output (Data Input Output 1)*1
C1	CLK	I	Serial Clock Input
C2	/WP (IO2)	I/O	Write Protect Input (Data Input Output 2)*2
D1	DI (IO0)	I/O	Data Input (Data Input Output 0)*1
D2	GND		Ground

Notes:

1. IO0 and IO1 are used for Standard and Dual SPI instructions
2. IO0 – IO3 are used for Quad SPI instructions

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

4. PIN DESCRIPTIONS

4.1 Chip Select (/CS)

The SPI Chip Select (/CS) pin enables and disables device operation. When /CS is high the device is deselected and the Serial Data Output (DO, or IO0, IO1, IO2, IO3) pins are at high impedance. When deselected, the devices power consumption will be at standby levels unless an internal erase, program or write status register cycle is in progress. When /CS is brought low the device will be selected, power consumption will increase to active levels and commands can be written to and data read from the device. After power-up, /CS must transition from high to low before a new command will be accepted. The /CS input must track the VCC supply level at power-up and power-down (see “Write Protection” and Figure 58). If needed a pull-up resister on the /CS pin can be used to accomplish this.

4.2 Serial Data Input, Output and IOs (DI, DO and IO0, IO1, IO2, IO3)

The W25Q80RV supports standard SPI, Dual SPI and Quad SPI operation. Standard SPI commands use the unidirectional DI (input) pin to serially write commands, addresses or data to the device on the rising edge of the Serial Clock (CLK) input pin. Standard SPI also uses the unidirectional DO (output) to read data or status from the device on the falling edge of CLK.

Dual and Quad SPI commands use the bidirectional IO pins to serially write commands, addresses or data to the device on the rising edge of CLK and read data or status from the device on the falling edge of CLK. Quad SPI commands require the non-volatile Quad Enable bit (QE) in Status Register-2 to be set. When QE=1, the /WP pin becomes IO2 and /HOLD pin becomes IO3.

4.3 Write Protect (/WP)

The Write Protect (/WP) pin can be used to prevent the Status Register from being written. Used in conjunction with the Status Register’s Block Protect (CMP, SEC, TB, BP2, BP1 and BP0) bits and Status Register Protect (SRP) bits, a portion as small as a 4KB sector or the entire memory array can be hardware protected. The /WP pin is active low. When the QE bit of Status Register-2 is set for Quad I/O, the /WP pin function is not available since this pin is used for IO2. See Figure 1a-c for the pin configuration of Quad I/O operation.

4.4 HOLD (/HOLD)

The /HOLD pin allows the device to be paused while it is actively selected. When /HOLD is brought low, while /CS is low, the DO pin will be at high impedance and signals on the DI and CLK pins will be ignored (don’t care). When /HOLD is brought high, device operation can resume. The /HOLD function can be useful when multiple devices are sharing the same SPI signals. The /HOLD pin is active low. When the QE bit of Status Register-2 is set for Quad I/O, the /HOLD pin function is not available since this pin is used for IO3. See Figure 1a-e for the pin configuration of Quad I/O operation.

4.5 Serial Clock (CLK)

The SPI Serial Clock Input (CLK) pin provides the timing for serial input and output operations. ("See SPI Operations")

4.6 Reset (/RESET)

The /RESET pin allows the device to be reset by the controller. For 8-pin packages, when QE=0, the IO3 pin can be configured either as a /HOLD pin or as a /RESET pin depending on Status Register setting. When QE=1, the /HOLD or /RESET function is not available for 8-pin configuration.

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

Block Diagram

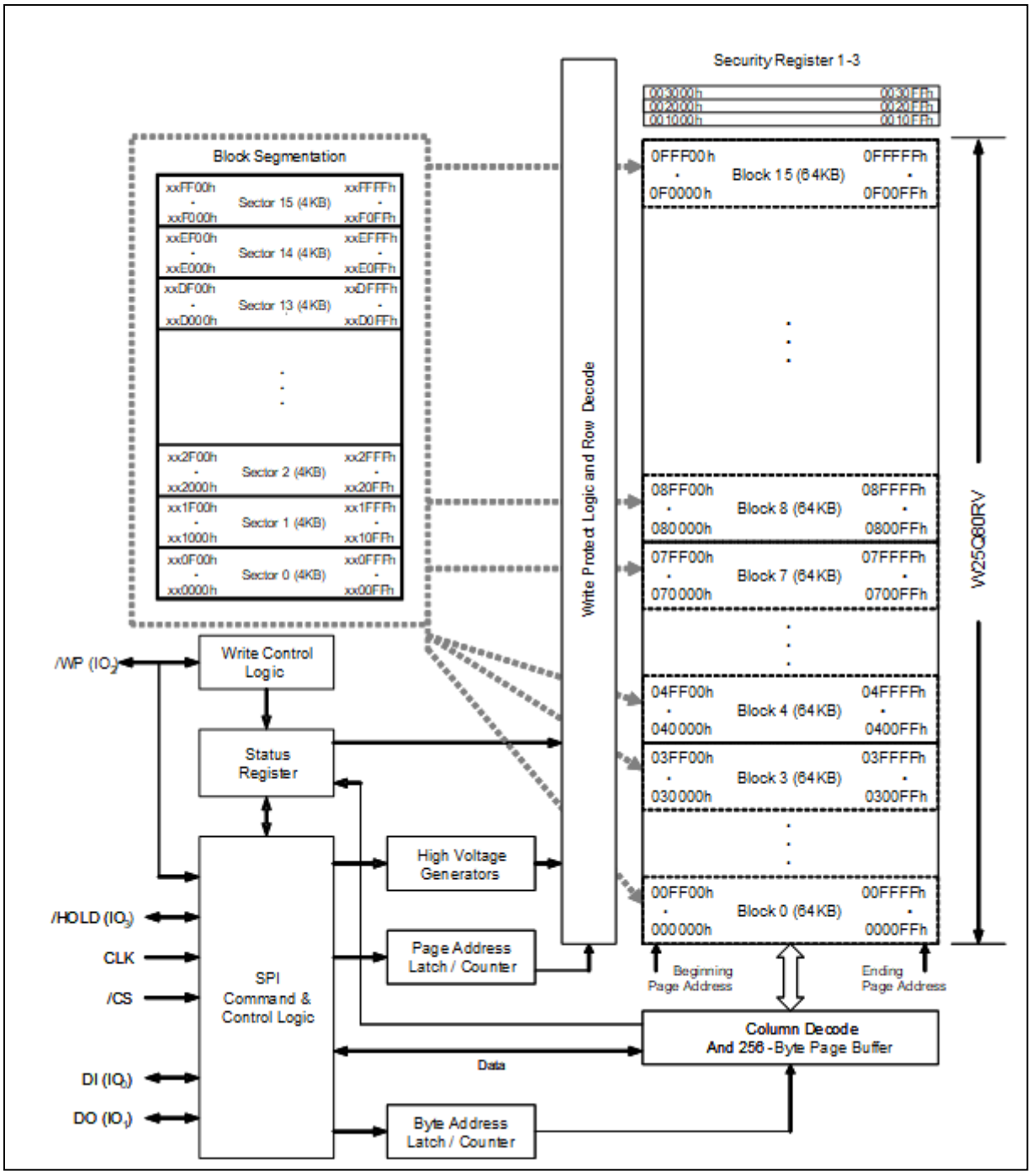


Figure 2. W25Q80RV Serial Flash Memory Block Diagram

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

5. FUNCTIONAL DESCRIPTIONS

5.1 SPI / QPI Operations

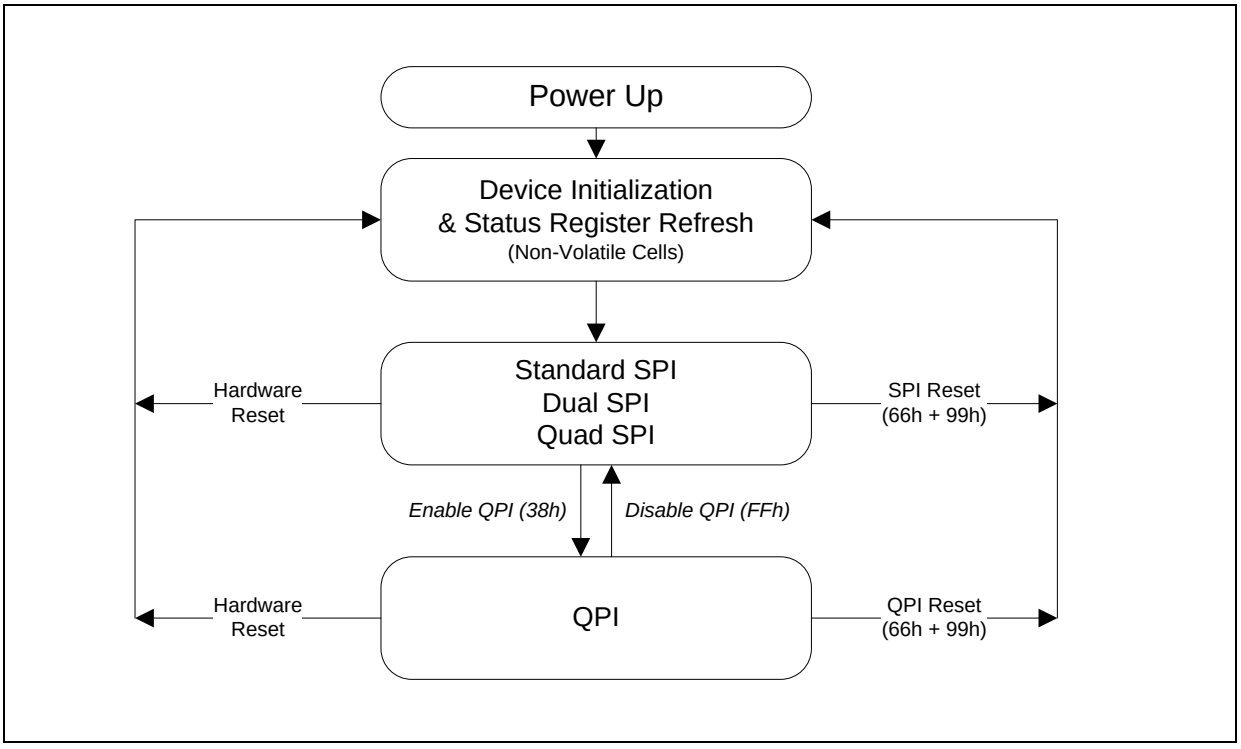


Figure 3. W25Q80RV Serial Flash Memory Operation Diagram

5.1.1 Standard SPI Instructions

The W25Q80RV is accessed through an SPI compatible bus consisting of four signals: Serial Clock (CLK), Chip Select (/CS), Serial Data Input (DI) and Serial Data Output (DO). Standard SPI commands use the DI input pin to serially write commands, addresses or data to the device on the rising edge of CLK. The DO output pin is used to read data or status from the device on the falling edge of CLK.

SPI bus operation Mode 0 (0,0) and 3 (1,1) are supported. The primary difference between Mode 0 and Mode 3 concerns the normal state of the CLK signal when the SPI bus master is in standby and data is not being transferred to the Serial Flash. For Mode 0, the CLK signal is normally low on the falling and rising edges of /CS. For Mode 3, the CLK signal is normally high on the falling and rising edges of /CS.

5.1.2 Dual SPI Instructions

The W25Q80RV supports Dual SPI operation when using commands such as “Fast Read Dual Output (3Bh)” and “Fast Read Dual I/O (BBh)”. These commands allow data to be transferred to or from the device at two to three times the rate of ordinary Serial Flash devices. The Dual SPI Read commands are ideal for quickly downloading code to RAM upon power-up (code-shadowing) or for executing non-speed-critical code directly from the SPI bus (XIP). When using Dual SPI commands, the DI and DO pins become bidirectional I/O pins: IO0 and IO1.

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

5.1.3 Quad SPI Instructions

The W25Q80RV supports Quad SPI operation when using commands such as “Fast Read Quad Output (6Bh)”, and “Fast Read Quad I/O (EBh). These commands allow data to be transferred to or from the device four to six times the rate of ordinary Serial Flash. The Quad Read commands offer a significant improvement in continuous and random access transfer rates allowing fast code-shadowing to RAM or execution directly from the SPI bus (XIP). When using Quad SPI commands the DI and DO pins become bidirectional IO0 and IO1, and the /WP and /HOLD pins become IO2 and IO3 respectively. Quad SPI commands require the non-volatile Quad Enable bit (QE) in Status Register-2 to be set.

5.1.4 QPI Instructions

The W25Q80RV supports Quad Peripheral Interface (QPI) operations only when the device is switched from Standard/Dual/Quad SPI mode to QPI mode using the “Enter QPI (38h)” command. The typical SPI protocol requires that the byte-long command code being shifted into the device only via DI pin in eight serial clocks. The QPI mode utilizes all four IO pins to input the command code, thus only two serial clocks are required. This can significantly reduce the SPI command overhead and improve system performance in an XIP environment. Standard/Dual/Quad SPI mode and QPI mode are exclusive. Only one mode can be active at any given time. “Enter QPI (38h)” and “Exit QPI (FFh)” commands are used to switch between these two modes. Upon power-up or after a software reset using “Reset (99h)” command, the default state of the device is Standard/Dual/Quad SPI mode. To enable QPI mode, the non-volatile Quad Enable bit (QE) in Status Register-2 is required to be set. When using QPI commands, the DI and DO pins become bidirectional IO0 and IO1, and the /WP and /HOLD pins become IO2 and IO3 respectively. See Figure 3 for the device operation modes.

5.1.5 Hold Function

For Standard SPI and Dual SPI operations, the /HOLD signal allows the W25Q80RV operation to be paused while it is actively selected (when /CS is low). The /HOLD function may be useful in cases where the SPI data and clock signals are shared with other devices. For example, consider if the page buffer was only partially written when a priority interrupt requires use of the SPI bus. In this case the /HOLD function can save the state of the command and the data in the buffer so programming can resume where it left off once the bus is available again. The /HOLD function is only available for standard SPI and Dual SPI operation, not during Quad SPI or QPI. The Quad Enable Bit QE in Status Register-2 is used to determine if the pin is used as /HOLD pin or data I/O pin. When QE=0 (factory default), the pin is /HOLD, when QE=1, the pin will become an I/O pin, /HOLD function is no longer available.

To initiate a /HOLD condition, the device must be selected with /CS low. A /HOLD condition will activate on the falling edge of the /HOLD signal if the CLK signal is already low. If the CLK is not already low, the /HOLD condition will activate after the next falling edge of CLK. The /HOLD condition will terminate on the rising edge of the /HOLD signal if the CLK signal is already low. If the CLK is not already low, the /HOLD condition will terminate after the next falling edge of CLK. During a /HOLD condition, the Serial Data Output (DO) is high impedance, and Serial Data Input (DI) and Serial Clock (CLK) are ignored. The Chip Select (/CS) signal should be kept active (low) for the full duration of the /HOLD operation to avoid resetting the internal logic state of the device.

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

5.1.6 Software Reset & Hardware /RESET pin

The W25Q80RV can be reset to the initial power-on state by a software Reset sequence, either in SPI mode or QPI mode. This sequence must include two consecutive commands: Enable Reset (66h) & Reset (99h). If the command sequence is successfully accepted, the device will take approximately 30uS (t_{RST}) to reset. No command will be accepted during the reset period.

For the 8PIN package types, W25Q80RV can also be configured to utilize a hardware /RESET pin. The HOLD/RST bit in the Status Register-3 is the configuration bit for /HOLD pin function or RESET pin function. When HOLD/RST=0 (factory default), the pin acts as a /HOLD pin as described above; when HOLD/RST=1, the pin acts as a /RESET pin. Drive the /RESET pin low for a minimum period of ~1us (tRESET*) will reset the device to its initial power-on state. Any on-going Program/Erase operation will be interrupted and data corruption may happen. While /RESET is low, the device will not accept any command input.

If QE bit is set to 1, the /HOLD or /RESET function will be disabled, the pin will become one of the four data I/O pins.

Hardware /RESET pin has the highest priority among all the input signals. Driving /RESET low for a minimum period of ~1us (tRESET*) will interrupt any on-going external/internal operations, regardless of the status of other SPI signals (/CS, CLK, IOs, /WP and/or /HOLD).

Note:

1. While a faster /RESET pulse (as short as a few hundred nanoseconds) will often reset the device, a 1us minimum is recommended to ensure reliable operation.

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

5.2 Write Protection

Applications that use non-volatile memory must take into consideration the possibility of noise and other adverse system conditions that may compromise data integrity. To address this concern, the W25Q80RV provides several means to protect the data from inadvertent writes.

5.2.1 Write Protect Features

- Device resets when VCC is below threshold
- Time delay write disable after Power-up
- Write enable/disable commands and automatic write disable after erase or program
- Software and Hardware (/WP pin) write protection using Status Registers
- Write Protection using Power-down command
- Lock Down write protection for Status Register until the next power-up
- One Time Program (OTP) write protection for array and Security Registers using Status Register*

  * Note: This feature is available upon special flow. Please contact Winbond for details.

Upon power-up or at power-down, the W25Q80RV will maintain a reset condition while VCC is below the threshold value of V_{WI}, (See Power-up Timing and Voltage Levels and Figure 58). While reset, all operations are disabled and no commands are recognized. During power-up and after the VCC voltage exceeds V_{WI}, all program and erase related commands are further disabled for a time delay of t_{PUW}. This includes the Write Enable, Page Program, Sector Erase, Block Erase, Chip Erase and the Write Status Register commands. Note that the chip select pin (/CS) must track the VCC supply level at power-up until the VCC-min level and t_{VSL} time delay is reached, and it must also track the VCC supply level at power-down to prevent adverse command sequence. If needed, a pull-up resister on /CS can be used to accomplish this.

After power-up the device is automatically placed in a write-disabled state with the Status Register Write Enable Latch (WEL) set to a 0. A Write Enable command must be issued before a Page Program, Sector Erase, Block Erase, Chip Erase or Write Status Register command will be accepted. After completing a program, erase or write command the Write Enable Latch (WEL) is automatically cleared to a write-disabled state of 0.

Software controlled write protection is facilitated using the Write Status Register command and setting the Status Register Protect (SRP, SRL) and Block Protect (CMP, SEC, TB, BP[2:0]) bits. These settings allow a portion or the entire memory array to be configured as read only. Used in conjunction with the Write Protect (/WP) pin, changes to the Status Register can be enabled or disabled under hardware control. See Status Register section for further information. Additionally, the Power-down command offers an extra level of write protection as all commands are ignored except for the Release Power-down command.

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

6. STATUS AND CONFIGURATION REGISTERS

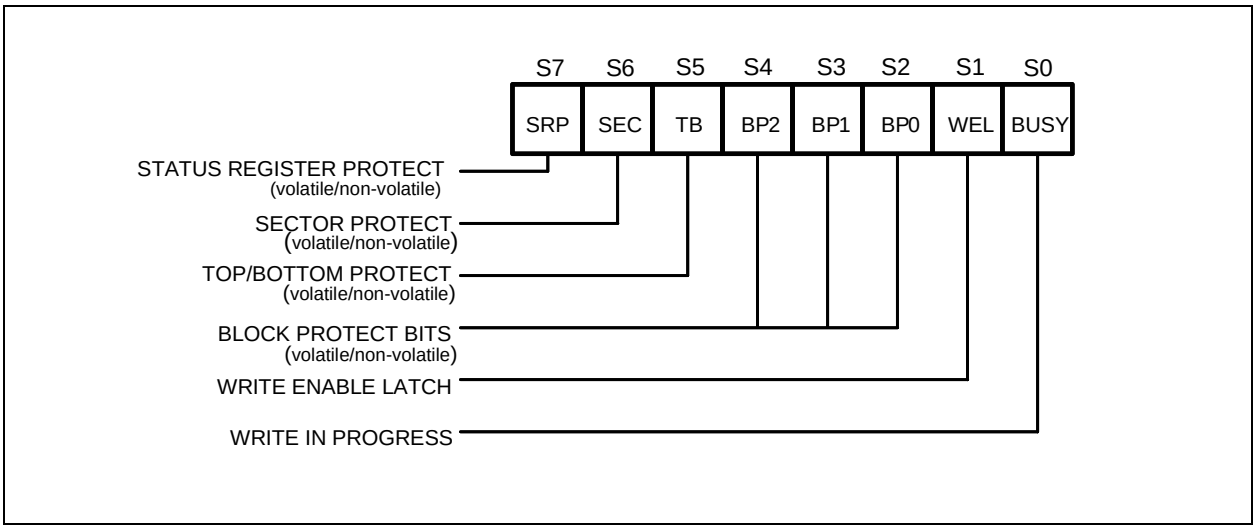


Figure 4a. Status Register-1

6.1.1 Erase/Write In Progress (BUSY) – *Status Only*

BUSY is a read only bit in the status register (S0) that is set to a 1 state when the device is executing a Page Program, Quad Page Program, Sector Erase, Block Erase, Chip Erase, Write Status Register or Erase/Program Security Register command. During this time the device will ignore further commands except for the Read Status Register and Erase/Program Suspend command (see tW, tPP, tSE, tBE, and tCE in AC Characteristics). When the program, erase or write status/security register command has completed, the BUSY bit will be cleared to a 0 state indicating the device is ready for further commands.

6.1.2 Write Enable Latch (WEL) – *Status Only*

Write Enable Latch (WEL) is a read only bit in the status register (S1) that is set to 1 after executing a Write Enable Instruction. The WEL status bit is cleared to 0 when the device is write disabled. A write disable state occurs upon power-up or after any of the following commands: Write Disable, Page Program, Quad Page Program, Sector Erase, Block Erase, Chip Erase, Write Status Register, Erase Security Register and Program Security Register.

6.1.3 Block Protect Bits (BP2, BP1, BP0) – *Volatile/Non-Volatile Writable*

The Block Protect Bits (BP2, BP1, BP0) are non-volatile read/write bits in the status register (S4, S3, and S2) that provide Write Protection control and status. Block Protect bits can be set using the Write Status Register Instruction (see tW in AC characteristics). All, none or a portion of the memory array can be protected from Program and Erase commands (see Status Register Memory Protection table). The factory default setting for the Block Protection Bits is 0, none of the array protected.

6.1.4 Top/Bottom Block Protect (TB) – *Volatile/Non-Volatile Writable*

The non-volatile Top/Bottom bit (TB) controls if the Block Protect Bits (BP2, BP1, BP0) protect from the Top (TB=0) or the Bottom (TB=1) of the array as shown in the Status Register Memory Protection table. The factory default setting is TB=0. The TB bit can be set with the Write Status Register Instruction depending on the state of the SRP, SRL and WEL bits.

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

6.1.5 Sector/Block Protect Bit (SEC) – *Volatile/Non-Volatile Writable*

The non-volatile Sector/Block Protect bit (SEC) controls if the Block Protect Bits (BP2, BP1, BP0) protect either 4KB Sectors (SEC=1) or 64KB Blocks (SEC=0) in the Top (TB=0) or the Bottom (TB=1) of the array as shown in the Status Register Memory Protection table. The default setting is SEC=0.

6.1.6 Complement Protect (CMP) – *Volatile/Non-Volatile Writable*

The Complement Protect bit (CMP) is a non-volatile read/write bit in the status register (S14). It is used in conjunction with SEC, TB, BP2, BP1 and BP0 bits to provide more flexibility for the array protection. Once CMP is set to 1, previous array protection set by SEC, TB, BP2, BP1 and BP0 will be reversed. For instance, when CMP=0, a top 64KB block can be protected while the rest of the array is not; when CMP=1, the top 64KB block will become unprotected while the rest of the array become read-only. Please refer to the Status Register Memory Protection table for details. The default setting is CMP=0.

6.1.7 Status Register Protect (SRP, SRL)

The Status Register Protect bits (SRP) are non-volatile read/write bits in the status register (S7). The SRP bit controls the method of write protection: software protection or hardware protection. The Status Register Lock bits (SRL) are non-volatile/volatile read/write bits in the status register (S8). The SRL bit controls the method of write protection: temporary lock-down or permanently one time program.

SRL	SRP	/WP	Status Register	Description
0	0	X	Software Protection	/WP pin has no control. The Status register can be written to after a Write Enable command, WEL=1. [Factory Default]
0	1	0	Hardware Protected	When /WP pin is low the Status Register locked and cannot be written to.
0	1	1	Hardware Unprotected	When /WP pin is high the Status register is unlocked and can be written to after a Write Enable command, WEL=1.
1	X	X	Power Supply Lock-Down	Status Register is protected and cannot be written to again until the next power-down, power-up cycle.(1)
1	X	X	One Time Program(2)	Status Register is permanently protected and cannot be written to. (**enabled by adding prefix command AAh, 55h)**

Note:

1. When SRL =1, a power-down, power-up cycle will change SRL =0 state.
2. Please contact Winbond for details regarding the special command sequence.

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

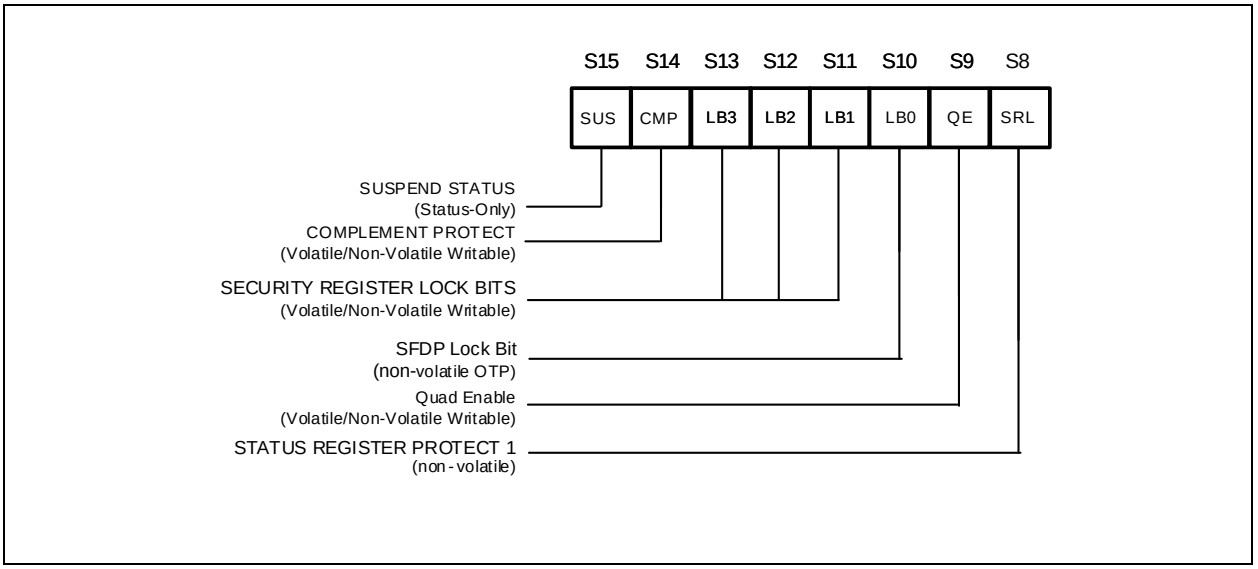


Figure 4b. Status Register-2

6.1.8 Erase/Program Suspend Status (SUS) – *Status Only*

The Suspend Status bit is a read only bit in the status register (S15) that is set to 1 after executing a Erase/Program Suspend (75h) command. The SUS status bit is cleared to 0 by Erase/Program Resume (7Ah) command as well as a power-down, power-up cycle.

6.1.9 Security Register Lock Bits (LB3, LB2, LB1,LB0) –*Volatile//Non-Volatile OTP Writable*

The Security Register Lock Bits (LB3, LB2, LB1,LB0) are non-volatile One Time Program (OTP) bits in Status Register (S13, S12, S11,S10) that provide the write protect control and status to the Security Registers. The default state of LB3-1 is 0, Security Registers are unlocked. LB3-1 can be set to 1 individually using the Write Status Register command. LB3-0 are One Time Programmable (OTP), once it's set to 1, the corresponding 256-Byte Security Register will become read-only permanently.

The default state of LB0 is 1, SFDP Register is locked.

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

6.1.10 Quad Enable (QE) – *Volatile/Non-Volatile Writable*

The Quad Enable (QE) bit is a non-volatile read/write bit in the status register (S9) that allows Quad SPI and QPI operation. When the QE bit is set to a 0 state (please contact Winbond), the /HOLD is enabled. When the QE bit is set to a 1(factory default for Quad Enabled part numbers with ordering option "JQ"), the Quad IO2 and IO3 pins are enabled, and /HOLD function is disabled.

QE bit is required to be set to a 1 before issuing an "Enter QPI (38h)" to switch the device from Standard/Dual/Quad SPI to QPI, otherwise the command will be ignored. When the device is in QPI mode, QE bit will remain to be 1. A "Write Status Register" command in QPI mode cannot change QE bit from a "1" to a "0".

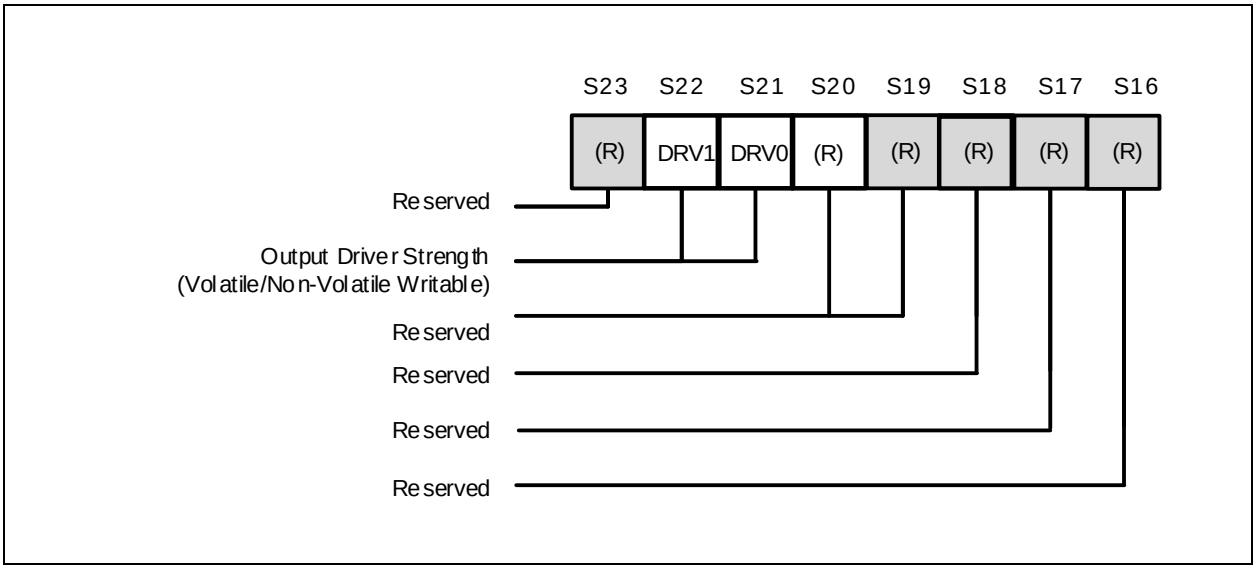


Figure 4c. Status Register-3

6.1.11 Output Driver Strength (DRV1, DRV0) – *Volatile/Non-Volatile Writable*

The DRV1 & DRV0 bits are used to determine the output driver strength for the Read operations.

DRV1, DRV0	Driver Strength
0, 0	25-ohm
0, 1	33-ohm
1, 0	50-ohm(default)
1, 1	100-ohm

6.1.12 Reserved Bits – *Non Functional*

There are a few reserved Status Register bits that may be read out as a "0" or "1". It is recommended to ignore the values of those bits. During a "Write Status Register" command, the Reserved Bits can be written as "0", but there will not be any effect.

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

6.1.13 W25Q80RV Status Register Memory Protection (CMP = 0)

STATUS REGISTER(1)					W25Q80RV (8M-BIT) MEMORY PROTECTION(2)			
SEC	TB	BP2	BP1	BP0	BLOCK(S)	ADDRESSES	DENSITY	PORTION
X	X	0	0	0	NONE	NONE	NONE	NONE
0	0	0	0	1	15	0F0000h – 0FFFFFh	64KB	Upper 1/16
0	0	0	1	0	14 and 15	0E0000h – 0FFFFFh	128KB	Upper 1/8
0	0	0	1	1	12 thru 15	0C0000h – 0FFFFFh	256KB	Upper 1/4
0	0	1	0	0	8 thru 15	080000h – 0FFFFFh	512KB	Upper 1/2
0	1	0	0	1	0	000000h – 00FFFFh	64KB	Lower 1/16
0	1	0	1	0	0 and 1	000000h – 01FFFFh	128KB	Lower 1/8
0	1	0	1	1	0 thru 3	000000h – 03FFFFh	256KB	Lower 1/4
0	1	1	0	0	0 thru 7	000000h – 07FFFFh	512KB	Lower 1/2
1	0	0	0	1	15	0FF000h – 0FFFFFh	4KB	Upper 1/256
1	0	0	1	0	15	0FE000h – 0FFFFFh	8KB	Upper 1/128
1	0	0	1	1	15	0FC000h – 0FFFFFh	16KB	Upper 1/64
1	0	1	0	0	15	0F8000h – 0FFFFFh	32KB	Upper 1/32
1	1	0	0	1	0	000000h – 000FFFh	4KB	Lower 1/256
1	1	0	1	0	0	000000h – 001FFFh	8KB	Lower 1/128
1	1	0	1	1	0	000000h – 003FFFh	16KB	Lower 1/64
1	1	1	0	0	0	000000h – 007FFFh	32KB	Lower 1/32
X	X	1	1	1	0 thru 15	000000h – 0FFFFFh	1MB	ALL

Notes:
1. X = don't care
2. L = Lower; U = Upper
3. If any Erase or Program command specifies a memory region that contains a protected data portion, this command will be ignored.

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

6.1.14 W25Q80RV Status Register Memory Protection (CMP = 1)

STATUS REGISTER(1)					W25Q80RV (8M-BIT) MEMORY PROTECTION(2)			
SEC	TB	BP2	BP1	BP0	BLOCK(S)	ADDRESSES	DENSITY	PORTION
X	X	0	0	0	0 thru 15	000000h – 0FFFFFh	1MB	ALL
0	0	0	0	1	0 thru 14	000000h – 0EFFFFh	960KB	Lower 15/16
0	0	0	1	0	0 thru 13	000000h – 0DFFFFh	896KB	Lower 7/8
0	0	0	1	1	0 thru 11	000000h – 0BFFFFh	768KB	Lower 3/4
0	0	1	0	0	0 thru 7	000000h – 07FFFFh	512KB	Lower 1/2
0	1	0	0	1	1 thru 15	010000h – 0FFFFFh	960KB	Upper 15/16
0	1	0	1	0	2 thru 15	020000h – 0FFFFFh	896KB	Upper 7/8
0	1	0	1	1	4 thru 15	040000h – 0FFFFFh	768KB	Upper 3/4
0	1	1	0	0	8 thru 15	080000h – 0FFFFFh	512KB	Upper 1/2
1	0	0	0	1	0 thru 15	000000h – 0FEFFFh	1,020KB	Lower 255/256
1	0	0	1	0	0 thru 15	000000h– 0FDFFFh	1,016KB	Lower 127/128
1	0	0	1	1	0 thru 15	000000h – 0FBFFFh	1,008KB	Lower 63/64
1	0	1	0	0	0 thru 15	000000h – 0F7FFFh	992KB	Lower 31/32
1	1	0	0	1	0 thru 15	001000h – 0FFFFFh	1,020KB	Upper 255/256
1	1	0	1	0	0 thru 15	002000h – 0FFFFFh	1,016KB	Upper 127/128
1	1	0	1	1	0 thru 15	004000h – 0FFFFFh	1,008KB	Upper 63/64
1	1	1	0	0	0 thru 15	008000h – 0FFFFFh	992KB	Upper 31/32
X	X	1	1	1	NONE	NONE	NONE	NONE

Notes:
1. X = don't care
2. L = Lower; U = Upper
3. If any Erase or Program command specifies a memory region that contains a protected data portion, this command will be ignored.

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

7. INSTRUCTIONS

The Standard/Dual/Quad SPI command set of the W25Q80RV consists of 48 basic commands that are fully controlled through the SPI bus (see Instruction Set Table1-2). Instructions are initiated with the falling edge of Chip Select (/CS). The first byte of data clocked into the DI input provides the command code. Data on the DI input is sampled on the rising edge of clock with most significant bit (MSB) first.

The QPI command set of the W25Q80RV consists of 35 basic commands that are fully controlled through the SPI bus (see Instruction Set Table 3). Instructions are initiated with the falling edge of Chip Select (/CS). The first byte of data clocked through IO[3:0] pins provides the command code. Data on all four IO pins are sampled on the rising edge of clock with most significant bit (MSB) first. All QPI commands, addresses, data and dummy bytes are using all four IO pins to transfer every byte of data with every two serial clocks (CLK).

Instructions vary in length from a single byte to several bytes and may be followed by address bytes, data bytes, dummy bytes (don't care), and in some cases, a combination. Instructions are completed with the rising edge of edge /CS. Clock relative timing diagrams for each command are included in Figures 5 through 57. All read commands can be completed after any clocked bit. However, all commands that Write, Program or Erase must complete on a byte boundary (/CS driven high after a full 8-bits have been clocked) otherwise the command will be ignored. This feature further protects the device from inadvertent writes. Additionally, while the memory is being programmed or erased, or when the Status Register is being written, all commands except for Read Status Register will be ignored until the program or erase cycle has completed.

7.1 Device ID and Instruction Set Tables

7.1.1 Manufacturer and Device Identification

MANUFACTURER ID	**(MF7 - MF0)**	
Winbond Serial Flash	EFh	
Device ID	**(ID7 - ID0)**	**(ID15 - ID0)**
Instruction	**ABh, 90h, 92h, 94h**	**9Fh**
W25Q80RV-Q	13h	4014h

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

7.1.2 Command Set Table 1 (Standard SPI Commands) (1)

Data Input Output	Byte 1	Byte 2	Byte 3	Byte 4	Byte 5	Byte 6	Byte 7
Number of Clock(1-1-1)	**8**	**8**	**8**	**8**	**8**	**8**	**8**
Write Enable	**06h**						
Volatile SR Write Enable	**50h**						
Write Disable	**04h**						
Release Power-down / ID	**ABh**	Dummy	Dummy	Dummy	(ID7-ID0)(2)		
Manufacturer/Device ID	**90h**	Dummy	Dummy	00h	(MF7-MF0)	(ID7-ID0)	
JEDEC ID	**9Fh**	(MF7-MF0)	(ID15-ID8)	(ID7-ID0)			
Read Unique ID	**4Bh**	Dummy	Dummy	Dummy	Dummy	(UID63-0)	
Read Data	**03h**	A23-A16	A15-A8	A7-A0	(D7-D0)		
Fast Read	**0Bh**	A23-A16	A15-A8	A7-A0	Dummy	(D7-D0)	
Page Program	**02h**	A23-A16	A15-A8	A7-A0	D7-D0	D7-D0(3)	
Sector Erase (4KB)	**20h**	A23-A16	A15-A8	A7-A0			
Block Erase (32KB)	**52h**	A23-A16	A15-A8	A7-A0			
Block Erase (64KB)	**D8h**	A23-A16	A15-A8	A7-A0			
Chip Erase	**C7h/60h**						
Read Status Register-1	**05h**	(S7-S0)(2)					
Write Status Register-1	**01h**	(S7-S0)					
Read Status Register-2	**35h**	(S15-S8)(2)					
Write Status Register-2	**31h**	(S15-S8)					
Read Status Register-3	**15h**	(S23-S16)(2)					
Write Status Register-3	**11h**	(S23-S16)					
Read SFDP Register	**5Ah**	A23-A16	A15-A8	A7–A0	dummy	(D7-0)	
Erase Security Register(4)	**44h**	A23-A16	A15-A8	A7-A0			
Program Security Register(4)	**42h**	A23-A16	A15-A8	A7-A0	D7-D0	D7-D0(3)	
Read Security Register((4)	**48h**	A23-A16	A15-A8	A7-A0	Dummy	(D7-D0)	
Erase / Program Suspend	**75h**						
Erase / Program Resume	**7Ah**						
Power-down	**B9h**						
Set Read Parameters	**C0h**	P7-P0					
Enter QPI Mode	**38h**						
Enable Reset	**66h**						
Reset Device	**99h**						

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

7.1.3 Command Set Table 2 (Dual/Quad SPI Commands) (1)

Data Input Output	Byte 1	Byte 2	Byte 3	Byte 4	Byte 5	Byte 6	Byte 7	Byte 8	Byte 9
Number of Clock(1-1-2)	**8**	**8**	**8**	**8**	**4**	**4**	**4**	**4**	**4**
Fast Read Dual Output	**3Bh**	A23-A16	A15-A8	A7-A0	Dummy	Dummy	(D7-D0)(6)	…	
Number of Clock(1-2-2)	**8**	**4**	**4**	**4**	**4**	**4**	**4**	**4**	**4**
Fast Read Dual I/O	**BBh**	A23-A16(5)	A15-A8(5)	A7-A0(5)	M7-M0	(D7-D0)(6)	…		
Mftr./Device ID Dual I/O	**92h**	A23-A16(5)	A15-A8(5)	00(5)	Dummy(17)	(MF7-MF0) (6)	(ID7-ID0)(6)		
Number of Clock(1-1-4)	**8**	**8**	**8**	**8**	**2**	**2**	**2**	**2**	**2**
Quad Input Page Program	**32h**	A23-A16	A15-A8	A7-A0	(D7-D0)(8)	(D7-D0)(3)	…		
Fast Read Quad Output	**6Bh**	A23-A16	A15-A8	A7-A0	Dummy	Dummy	Dummy	Dummy	(D7-D0)(9)
Number of Clock(1-4-4)	**8**	**2**(7)	**2**(7)	**2**(7)	**2**	**2**	**2**	**2**	**2**
Mftr./Device ID Quad I/O	**94h**	A23-A16	A15-A8	00	Dummy(13)	Dummy	Dummy	(MF7-MF0)	(ID7-ID0)
Fast Read Quad I/O	**EBh**	A23-A16	A15-A8	A7-A0	M7-M0(13)	Dummy(11)	Dummy(11)	(D7-D0)	…
Set Burst with Wrap	**77h**	Dummy	Dummy	Dummy	W7-W0				

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

7.1.4 Command Set Table 3 (QPI Commands)(10)

Data Input Output	Byte 1	Byte 2	Byte 3	Byte 4	Byte 5	Byte 6	Byte 7
Number of Clock (4-4-4)	**2**	**2**	**2**	**2**	**2**	**2**	**2**
Write Enable	**06h**						
Volatile SR Write Enable	**50h**						
Write Disable	**04h**						
Release Power-down / ID	**ABh**	Dummy	Dummy	Dummy	(ID7-ID0)(2)		
Manufacturer/Device ID	**90h**	Dummy	Dummy	00h	(MF7-MF0)	(ID7-ID0)	
JEDEC ID	**9Fh**	(MF7-MF0)	(ID15-ID8)	(ID7-ID0)			
Set Read Parameters	**C0h**	P7-P0					
Page Program	**02h**	A23-A16	A15-A8	A7-A0	D7-D0(9)	D7-D0(3)	…
Sector Erase (4KB)	**20h**	A23-A16	A15-A8	A7-A0			
Block Erase (32KB)	**52h**	A23-A16	A15-A8	A7-A0			
Block Erase (64KB)	**D8h**	A23-A16	A15-A8	A7-A0			
Chip Erase	**C7h/60h**						
Read Status Register-1	**05h**	(S7-S0)(2)					
Write Status Register-1	**01h**	(S7-S0)					
Read Status Register-2	**35h**	(S15-S8)(2)					
Write Status Register-2	**31h**	(S15-S8)					
Read Status Register-3	**15h**	(S23-S16)(2)					
Write Status Register-3	**11h**	(S23-S16)					
Power-down	**B9h**						
Enable Reset	**66h**						
Reset Device	**99h**						
Exit QPI Mode	**FFh**						
Data Input Output	**Byte 1**	**Byte 2**	**Byte 3**	**Byte 4**	**Byte 5**	**Byte 6**	**Byte 7**
Number of Clock (4-4-4)	**2**	**2**	**2**	**2**	**2**	**4**	**2**
Fast Read	**0Bh**	A23-A16	A15-A8	A7-A0	Dummy	Dummy(11)	(D7-D0)
Burst Read with Wrap	**0Ch**	A23-A16	A15-A8	A7-A0	Dummy	Dummy(11)	(D7-D0)
Fast Read Quad I/O	**EBh**	A23-A16	A15-A8	A7-A0	M7-M0(13)	Dummy(11)	(D7-D0)

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

Notes:

1. Data bytes are shifted with Most Significant Bit first. Byte fields with data in parenthesis "( )" indicate data output from the device on either 1, 2 or 4 IO pins.
2. The Status Register contents and Device ID will repeat continuously until /CS terminates the command.
3. At least one byte of data input is required for Page Program, Quad Page Program and Program Security Registers, up to 256 bytes of data input. If more than 256 bytes of data are sent to the device, the addressing will wrap to the beginning of the page and overwrite previously sent data.
4. Security Register Address:
   Security Register 1: A23-16 = 00h; A15-8 = 10h; A7-0 = byte address
   Security Register 2: A23-16 = 00h; A15-8 = 20h; A7-0 = byte address
   Security Register 3: A23-16 = 00h; A15-8 = 30h; A7-0 = byte address
5. Dual SPI address input format:
   IO0 = A22, A20, A18, A16, A14, A12, A10, A8 A6, A4, A2, A0, M6, M4, M2, M0
   IO1 = A23, A21, A19, A17, A15, A13, A11, A9 A7, A5, A3, A1, M7, M5, M3, M1
6. Dual SPI data output format:
   IO0 = (D6, D4, D2, D0)
   IO1 = (D7, D5, D3, D1)
7. Quad SPI address input format:
   IO0 = A20, A16, A12, A8, A4, A0, M4, M0
   IO1 = A21, A17, A13, A9, A5, A1, M5, M1
   IO2 = A22, A18, A14, A10, A6, A2, M6, M2
   IO3 = A23, A19, A15, A11, A7, A3, M7, M3

   Set Burst with Wrap input format:
   IO0 = x, x, x, x, x, x, W4, x
   IO1 = x, x, x, x, x, x, W5, x
   IO2 = x, x, x, x, x, x, W6, x
   IO3 = x, x, x, x, x, x, x, x
8. Quad SPI data input/output format:
   IO0 = (D4, D0, …..)
   IO1 = (D5, D1, …..)
   IO2 = (D6, D2, …..)
   IO3 = (D7, D3, …..)
9. Fast Read Quad I/O data output format:
   IO0 = (x, x, x, x, D4, D0, D4, D0)
   IO1 = (x, x, x, x, D5, D1, D5, D1)
   IO2 = (x, x, x, x, D6, D2, D6, D2)
   IO3 = (x, x, x, x, D7, D3, D7, D3)
10. QPI Command, Address, Data input/output format:
    CLK # 0 1 2 3 4 5 6 7 8 9 10 11
    IO0 = C4, C0, A20, A16, A12, A8, A4, A0, D4, D0, D4, D0
    IO1 = C5, C1, A21, A17, A13, A9, A5, A1, D5, D1, D5, D1
    IO2 = C6, C2, A22, A18, A14, A10, A6, A2, D6, D2, D6, D2
    IO3 = C7, C3, A23, A19, A15, A11, A7, A3, D7, D3, D7, D3
11. The number of dummy clocks for QPI Fast Read, QPI/SPI Fast Read Quad I/O & QPI Burst Read with Wrap is controlled by read parameter P7 – P4.
12. The wrap around length for QPI Burst Read with Wrap is controlled by read parameters P3 – P0.
13. The first dummy is M7-M0 should be set to Fxh, if Read Command bypass mode doesn't use.

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

7.2 Instruction Descriptions

7.2.1 Write Enable (06h)

The Write Enable command (Figure 5) sets the Write Enable Latch (WEL) bit in the Status Register to a 1. The WEL bit must be set prior to every Page Program, Quad Page Program, Sector Erase, Block Erase, Chip Erase, Write Status Register and Erase/Program Security Registers command. The Write Enable command is entered by driving /CS low, shifting the command code "06h" into the Data Input (DI) pin on the rising edge of CLK, and then driving /CS high.

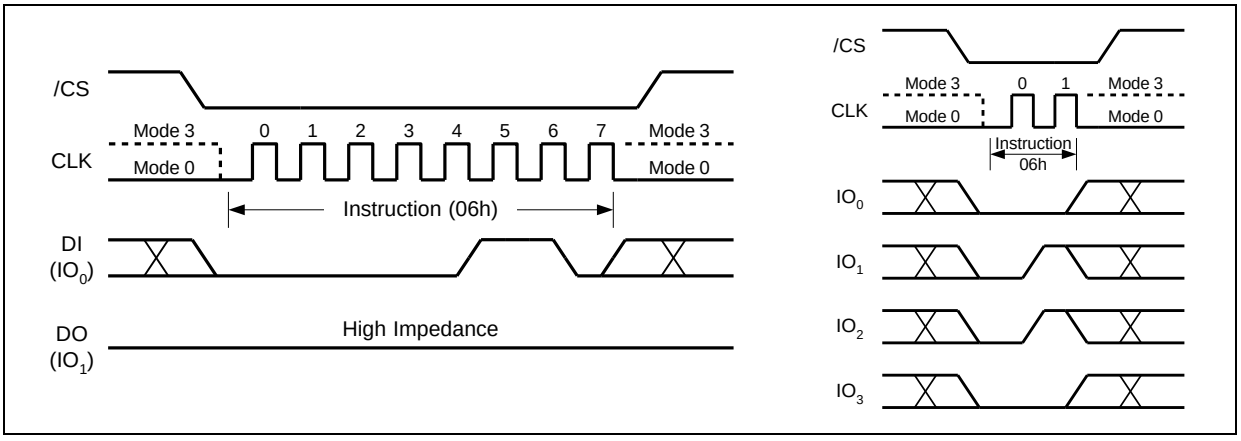


Figure 5. Write Enable Instruction for SPI Mode (left) or QPI Mode (right)

7.2.2 Write Enable for Volatile Status Register (50h)

The non-volatile Status Register bits described in section 7.1 can also be written to as volatile bits. This gives more flexibility to change the system configuration and memory protection schemes quickly without waiting for the typical non-volatile bit write cycles or affecting the endurance of the Status Register non-volatile bits. To write the volatile values into the Status Register bits, the Write Enable for Volatile Status Register (50h) command must be issued prior to a Write Status Register (01h/31h/11h) command. Write Enable for Volatile Status Register command (Figure 6) will not set the Write Enable Latch (WEL) bit, it is only valid for the Write Status Register command to change the volatile Status Register bit values.

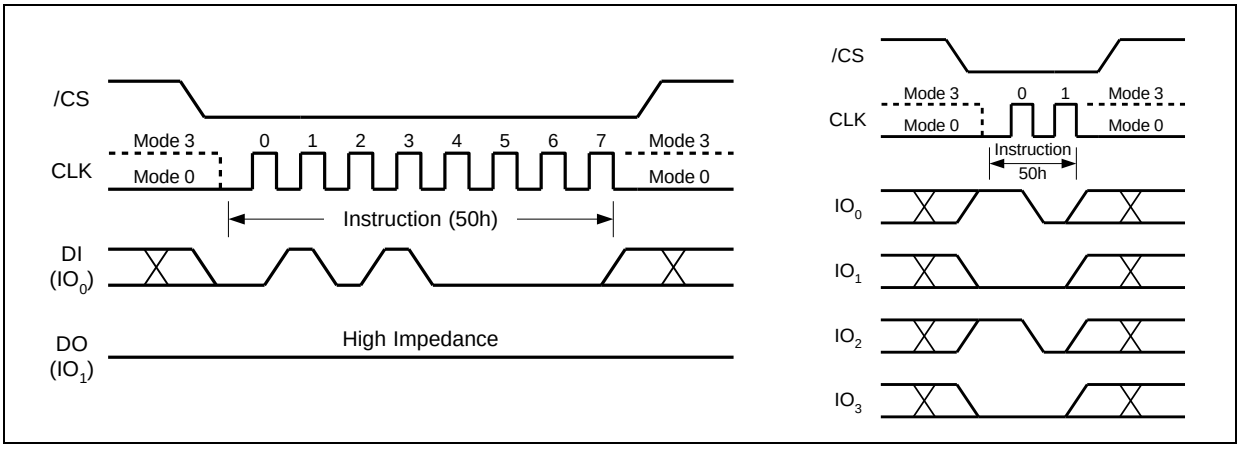


Figure 6. Write Enable for Volatile Status Register Instruction for SPI Mode (left) or QPI Mode (right)

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

7.2.3 Write Disable (04h)

The Write Disable command (Figure 7) resets the Write Enable Latch (WEL) bit in the Status Register to a 0. The Write Disable command is entered by driving /CS low, shifting the command code “04h” into the DI pin and then driving /CS high. Note that the WEL bit is automatically reset after Power-up and upon completion of the Write Status Register, Erase/Program Security Registers, Page Program, Quad Page Program, Sector Erase, Block Erase, Chip Erase and Reset commands.

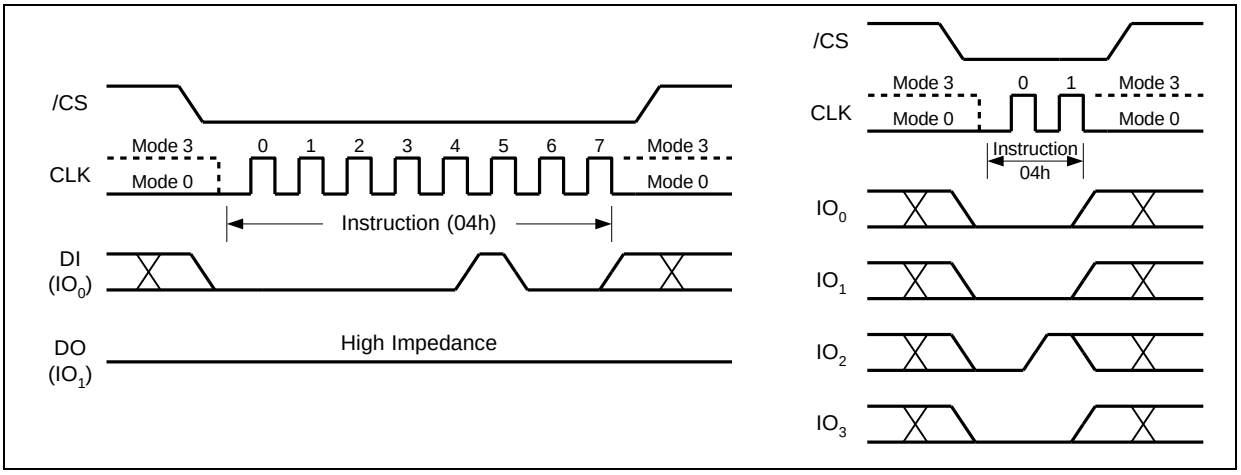


Figure 7. Write Disable Instruction for SPI Mode (left) or QPI Mode (right)

7.2.4 Read Status Register-1 (05h), Status Register-2 (35h) & Status Register-3 (15h)

The Read Status Register commands allow the 8-bit Status Registers to be read. The command is entered by driving /CS low and shifting the command code “05h” for Status Register-1, “35h” for Status Register-2 or “15h” for Status Register-3 into the DI pin on the rising edge of CLK. The status register bits are then shifted out on the DO pin at the falling edge of CLK with most significant bit (MSB) first as shown in Figure 8. Refer to section 7.1 for Status Register descriptions.

The Read Status Register command may be used at any time, even while a Program, Erase or Write Status Register cycle is in progress. This allows the BUSY status bit to be checked to determine when the cycle is complete and if the device can accept another command. The Status Register can be read continuously, as shown in Figure 8. The command is completed by driving /CS high.

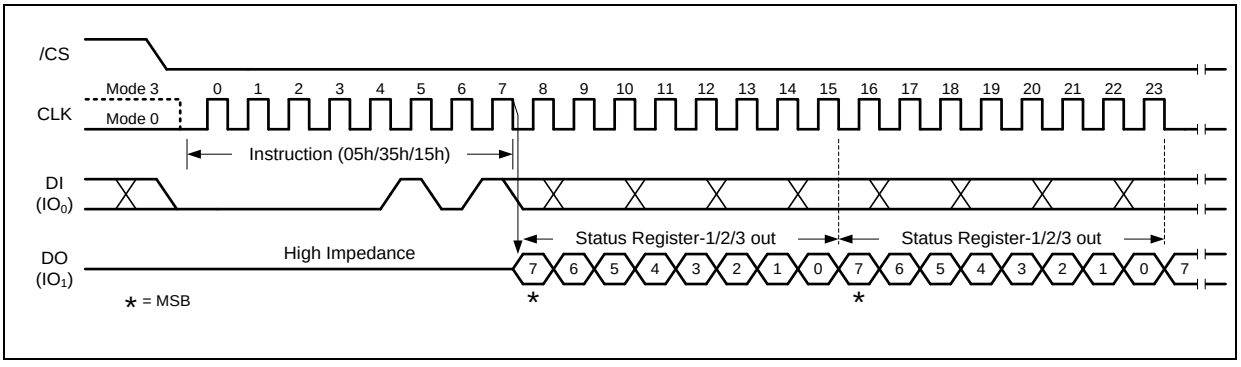


Figure 8a. Read Status Register Instruction (SPI Mode)

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

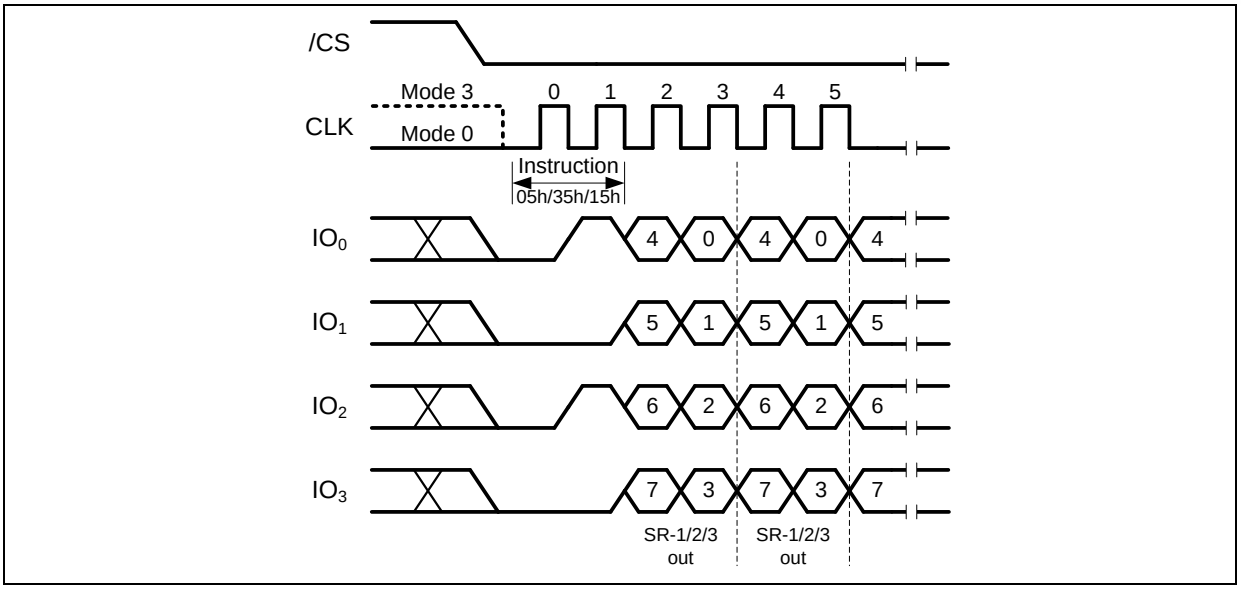


Figure 8b. Read Status Register Instruction (QPI Mode)

7.2.5 Write Status Register-1 (01h), Status Register-2 (31h) & Status Register-3 (11h)

The Write Status Register command allows the Status Registers to be written. The writable Status Register bits include: SRP, SEC, TB, BP[2:0] in Status Register-1; CMP, LB[3:1], QE, SRL in Status Register-2; HOLD/RST, DRV1, DRV0 in Status Register-3. All other Status Register bit locations are read-only and will not be affected by the Write Status Register command. LB[3:1] are non-volatile OTP bits, once it is set to 1, it cannot be cleared to 0.

To write non-volatile Status Register bits, a standard Write Enable (06h) command must previously have been executed for the device to accept the Write Status Register command (Status Register bit WEL must equal 1). Once write enabled, the command is entered by driving /CS low, sending the command code “01h/31h/11h”, and then writing the status register data byte as illustrated in Figure 9a & 9b.

To write volatile Status Register bits, a Write Enable for Volatile Status Register (50h) command must have been executed prior to the Write Status Register command (Status Register bit WEL remains 0). However, SRL and LB[3:1] cannot be changed from “1” to “0” because of the OTP protection for these bits. Upon power off or the execution of a Software/Hardware Reset, the volatile Status Register bit values will be lost, and the non-volatile Status Register bit values will be restored.

During a non-volatile Status Register write operation (06h combined with 01h/31h/11h), after /CS is driven high, the self-timed Write Status Register cycle will commence for a time duration of t_W (See AC Characteristics). While the Write Status Register cycle is in progress, the Read Status Register command may still be accessed to check the status of the BUSY bit. The BUSY bit is a 1 during the Write Status Register cycle and a 0 when the cycle is finished and ready to accept other commands again. After the Write Status Register cycle has finished, the Write Enable Latch (WEL) bit in the Status Register will be cleared to 0.

During a volatile Status Register write operation (50h combined with 01h/31h/11h), after /CS is driven high, the Status Register bits will be refreshed to the new values within the time period of t_{SHSL2} (See AC Characteristics). The BUSY bit will remain 0 during the Status Register bit refresh period.

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

The Write Status Register command can be used in both SPI mode and QPI mode. However, the QE bit cannot be written to when the device is in the QPI mode, because QE=1 is required for the device to enter and operate in the QPI mode.

Refer to section 7.1 for Status Register descriptions.

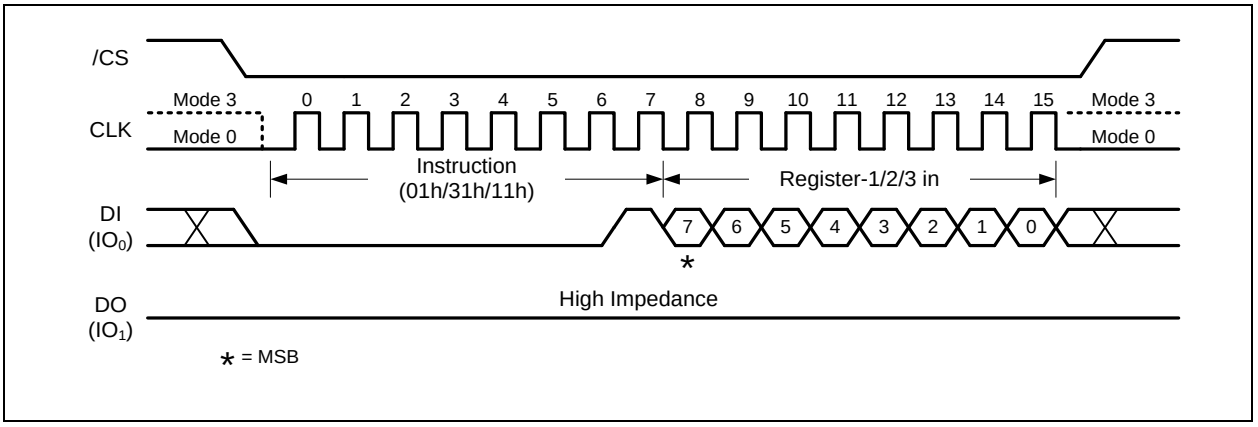


Figure 9a. Write Status Register-1/2/3 Instruction (SPI Mode)

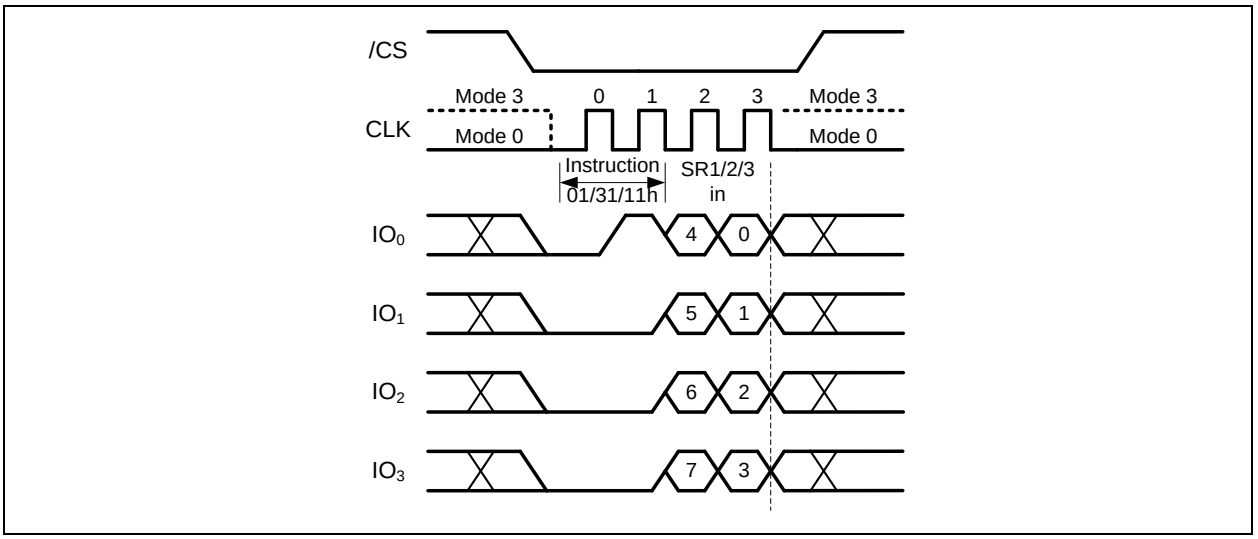


Figure 9b. Write Status Register-1/2/3 Instruction (QPI Mode)

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

7.2.6 Read Data (03h)

The Read Data command allows one or more data bytes to be sequentially read from the memory. The command is initiated by driving the /CS pin low and then shifting the command code “03h” followed by a 24-bit address (A23-A0) into the DI pin. The code and address bits are latched on the rising edge of the CLK pin. After the address is received, the data byte of the addressed memory location will be shifted out on the DO pin at the falling edge of CLK with most significant bit (MSB) first. The address is automatically incremented to the next higher address after each byte of data is shifted out allowing for a continuous stream of data. This means that the entire memory can be accessed with a single command as long as the clock continues. The command is completed by driving /CS high.

The Read Data command sequence is shown in Figure 14. If a Read Data command is issued while an Erase, Program or Write cycle is in process (BUSY=1), the command is ignored and will not have any effects on the current cycle. The Read Data command allows clock rates from D.C. to a maximum of f_R (see AC Electrical Characteristics).

The Read Data (03h) command is only supported in Standard SPI mode.

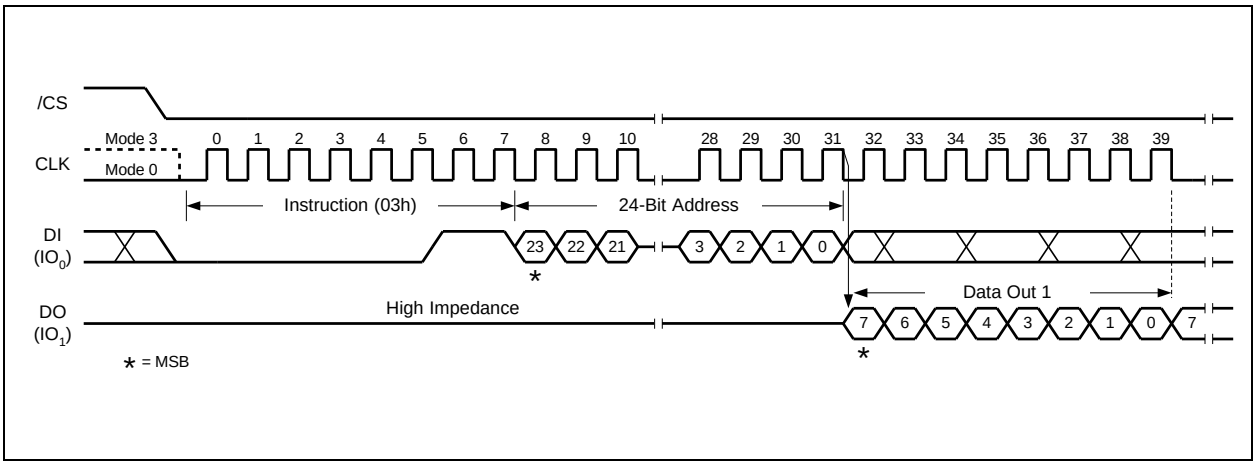


Figure 14. Read Data Instruction (SPI Mode only)

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

7.2.7 Fast Read (0Bh)

The Fast Read command is similar to the Read Data command except that it can operate at the highest possible frequency of FR (see AC Electrical Characteristics). This is accomplished by adding eight “dummy” clocks after the 24-bit address as shown in Figure 16. The dummy clocks allow the devices internal circuits additional time for setting up the initial address. During the dummy clocks, the data value on the DO pin is a “don’t care”.

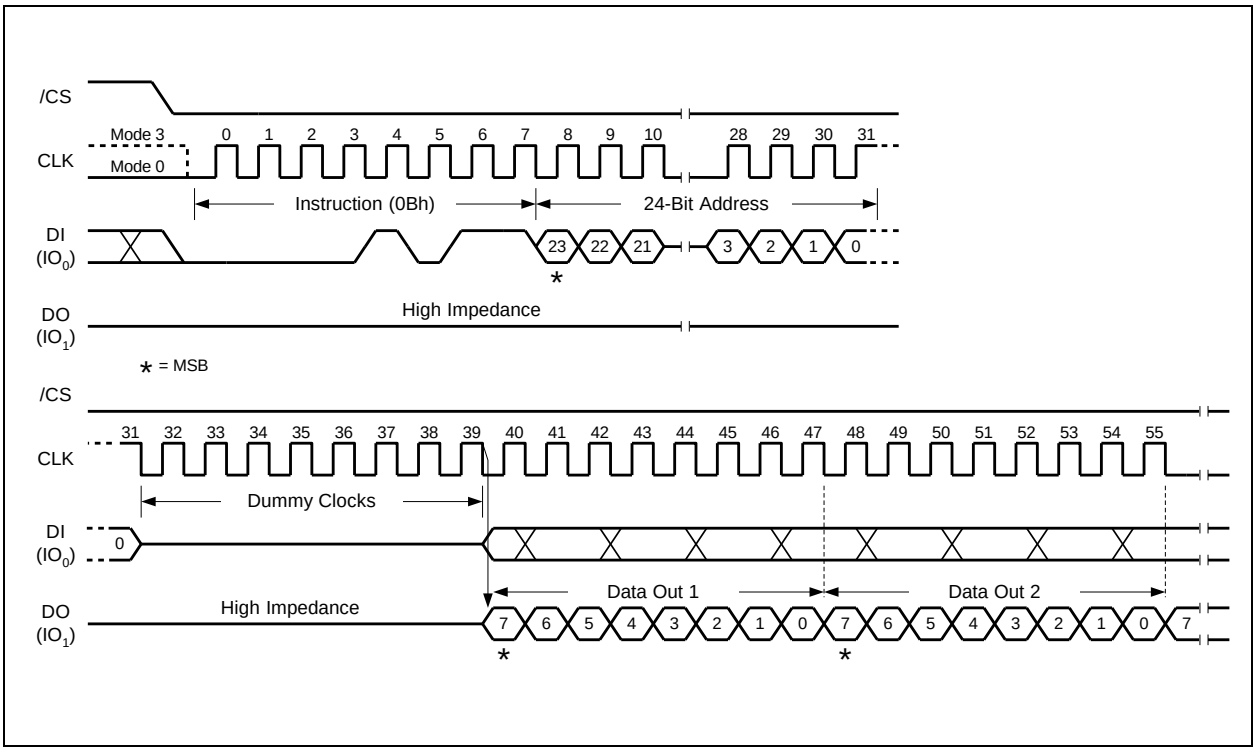


Figure 16a. Fast Read Instruction (SPI Mode)

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

Fast Read (0Bh) in QPI Mode

The Fast Read command is also supported in QPI mode. When QPI mode is enabled, the number of dummy clocks is configured by the “Set Read Parameters (C0h)” command to accommodate a wide range of applications with different needs for either maximum Fast Read frequency or minimum data access latency. Depending on the Read Parameter Bits P[6:4] setting, the number of dummy clocks can be configured as either 6, 8, 10, 12, 14 or 16. The default number of dummy clocks upon power up or after a Reset command is 6.

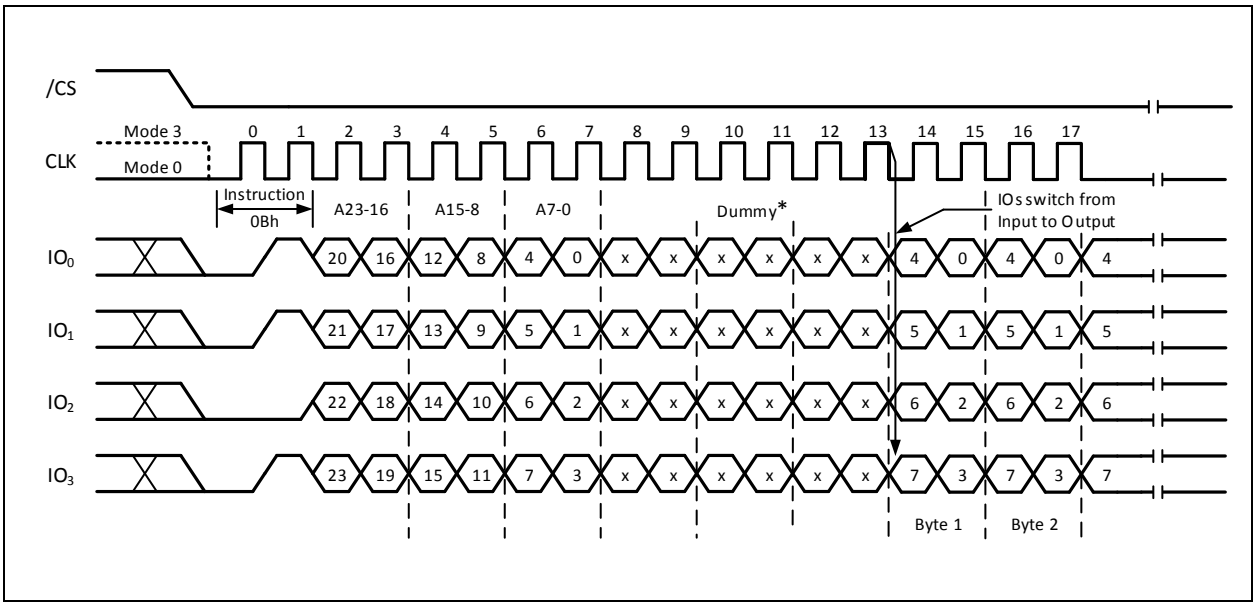


Figure 16b. Fast Read Instruction (QPI Mode)

* "Set Read Parameters" command (C0h) can set the number of dummy clocks.

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

7.2.8 Fast Read Dual Output (3Bh)

The Fast Read Dual Output (3Bh) command is similar to the standard Fast Read (0Bh) command except that data is output on two pins; IO_0 and IO_1. This allows data to be transferred at twice the rate of standard SPI devices. The Fast Read Dual Output command is ideal for quickly downloading code from Flash to RAM upon power-up or for applications that cache code-segments to RAM for execution.

Similar to the Fast Read command, the Fast Read Dual Output command can operate at the highest possible frequency of FR (see AC Electrical Characteristics). This is accomplished by adding eight “dummy” clocks after the 24-bit address as shown in Figure 18. The dummy clocks allow the device's internal circuits additional time for setting up the initial address. The input data during the dummy clocks is “don’t care”. However, the IO_0 pin should be high-impedance prior to the falling edge of the first data out clock.

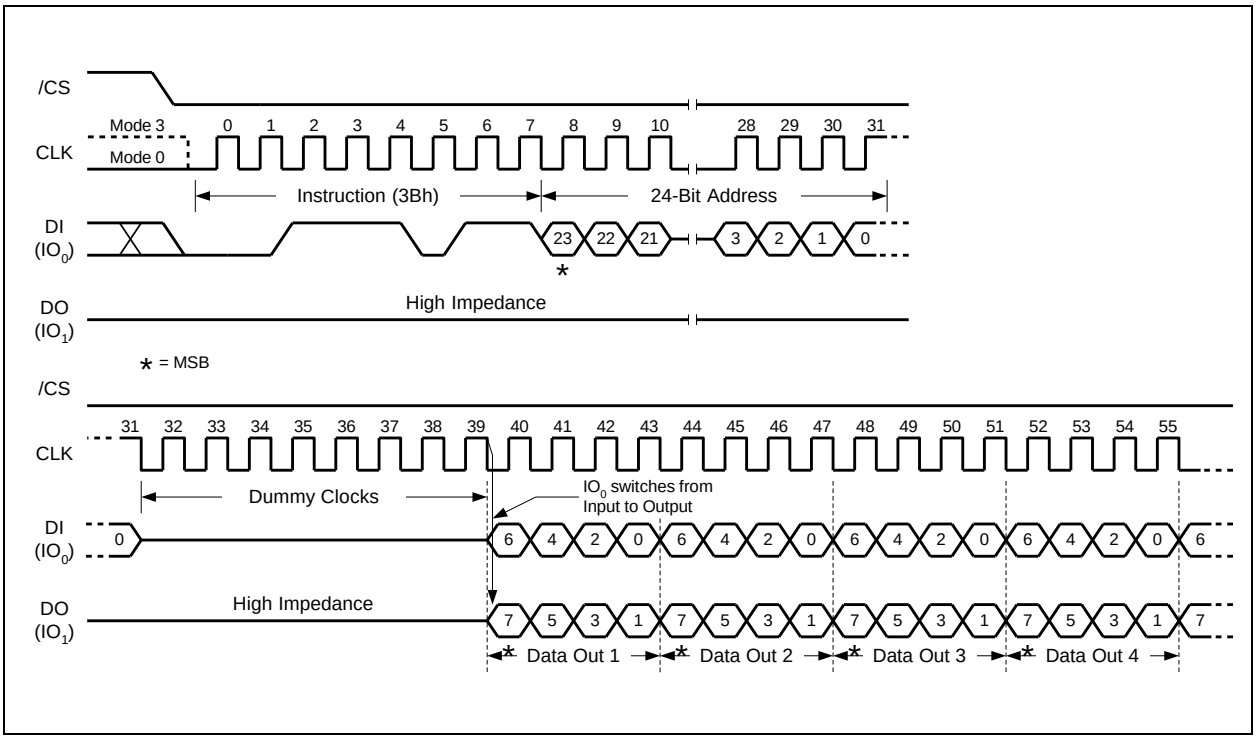


Figure 18. Fast Read Dual Output Instruction (SPI Mode only)

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

7.2.9 Fast Read Quad Output (6Bh)

The Fast Read Quad Output (6Bh) command is similar to the Fast Read Dual Output (3Bh) command except that data is output on four pins, IO_0, IO_1, IO_2, and IO_3. The Quad Enable (QE) bit in Status Register-2 must be set to 1 before the device will accept the Fast Read Quad Output Instruction. The Fast Read Quad Output Instruction allows data to be transferred at four times the rate of standard SPI devices.

The Fast Read Quad Output command can operate at the highest possible frequency of F_R (see AC Electrical Characteristics). This is accomplished by adding eight "dummy" clocks after the 24-bit address as shown in Figure 20. The dummy clocks allow the device's internal circuits additional time for setting up the initial address. The input data during the dummy clocks is "don't care". However, the IO pins should be high-impedance prior to the falling edge of the first data out clock.

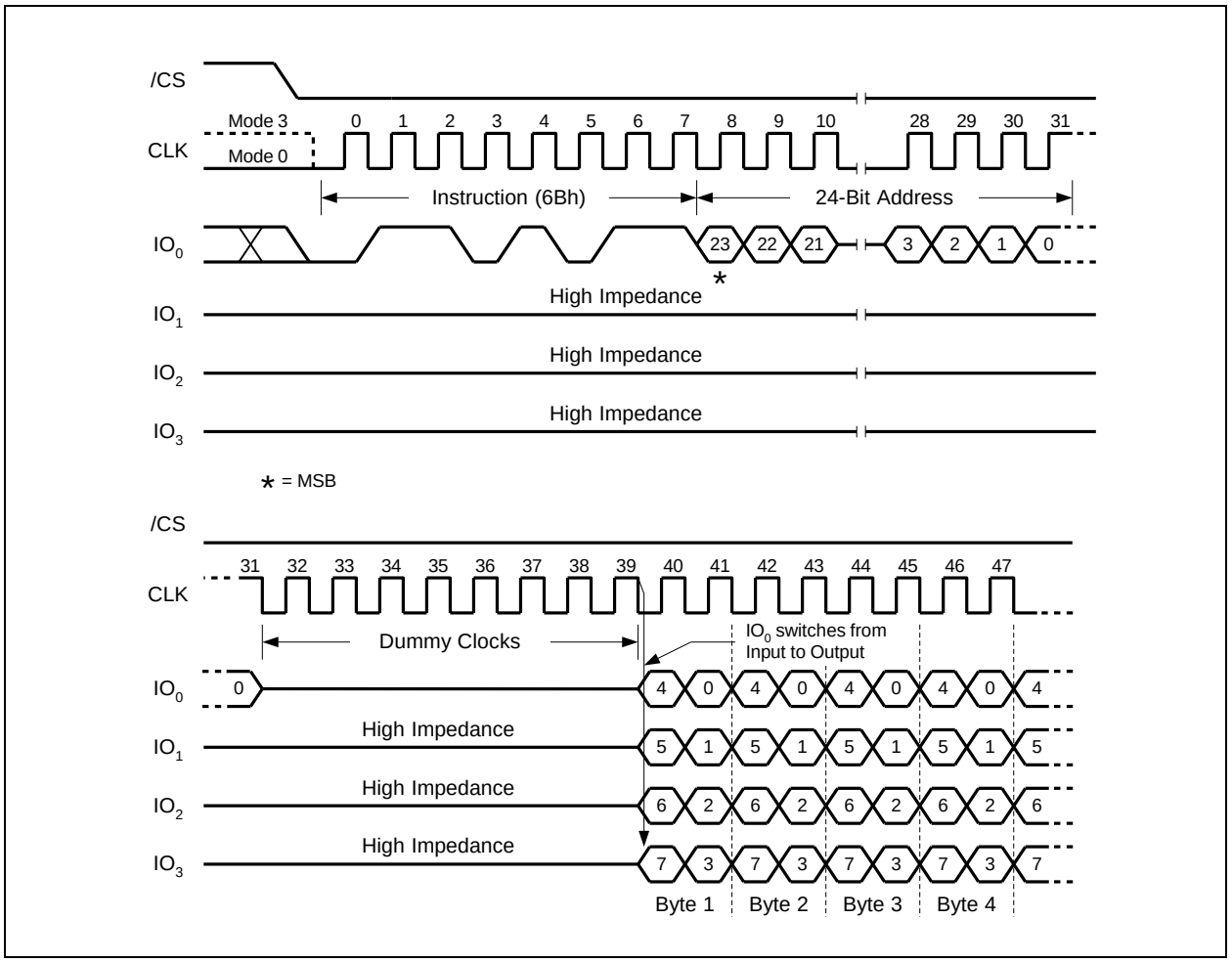


Figure 20. Fast Read Quad Output Instruction (SPI Mode only)

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

7.2.10 Fast Read Dual I/O (BBh)

The Fast Read Dual I/O (BBh) command allows for improved random access while maintaining two IO pins, IO_0 and IO_1. It is similar to the Fast Read Dual Output (3Bh) command but with the capability to input the Address bits (A23-0) two bits per clock. This reduced command overhead may allow for code execution (XIP) directly from the Dual SPI in some applications.

Fast Read Dual I/O with "Read Command Bypass Mode"

The Fast Read Dual I/O command can further reduce command overhead through setting the "Read Command Bypass Mode" bits (M7-0) after the input Address bits (A23-0), as shown in Figure 22a. The upper nibble of the (M7-4) controls the length of the next Fast Read Dual I/O command through the inclusion or exclusion of the first byte command code. The lower nibble bits of the (M3-0) are don't care ("x"). However, the IO pins should be high-impedance prior to the falling edge of the first data out clock.

If the "Read Command Bypass Mode" bits M5-4 = (1,0), then the next Fast Read Dual I/O command (after /CS is raised and then lowered) does not require the BBh command code, as shown in Figure 22b. This reduces the command sequence by eight clocks and allows the Read address to be immediately entered after /CS is asserted low. If the "Read Command Bypass Mode" bits M5-4 do not equal to (1,0), the next command (after /CS is raised and then lowered) requires the first byte command code, thus returning to normal operation. It is recommended to input FFFFh on IO0 for the next command (16 clocks), to ensure M4 = 1 and return the device to normal operation.

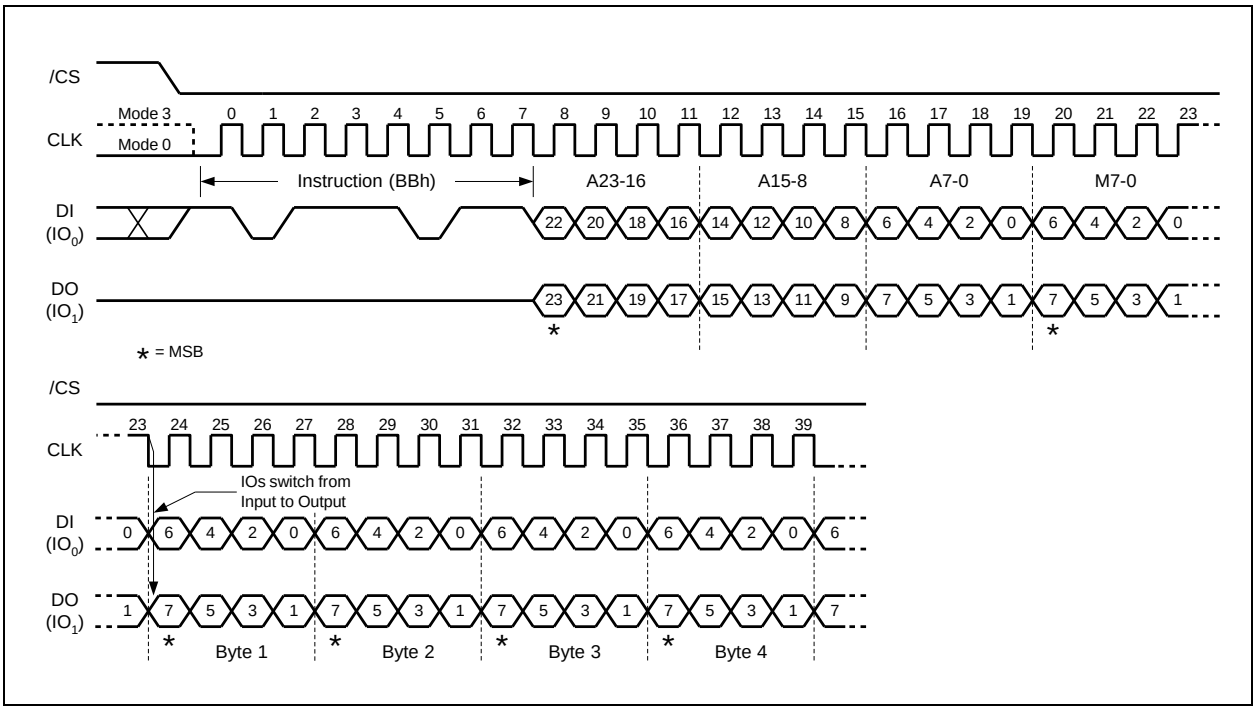


Figure 22a. Fast Read Dual I/O Instruction (Initial command or previous M5-4 ≠ 10, SPI Mode only)

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

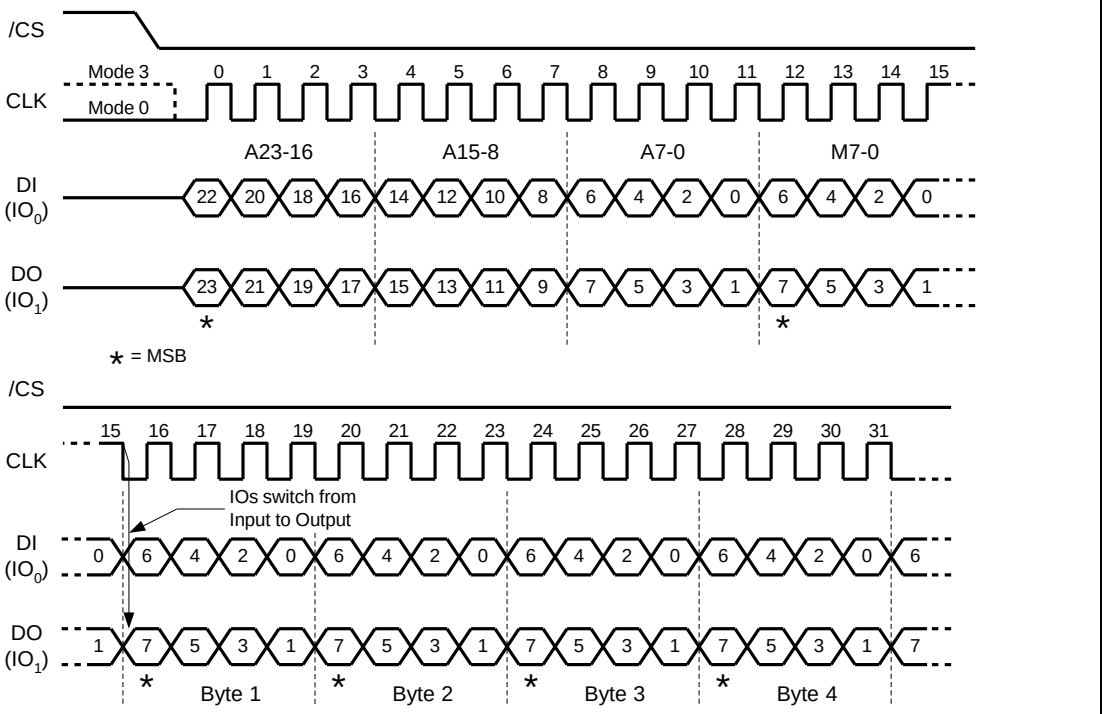


Figure 22b. Fast Read Dual I/O Instruction (Previous command set M5-4 = 10, SPI Mode only)

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

7.2.11 Fast Read Quad I/O (EBh)

The Fast Read Quad I/O (EBh) command is similar to the Fast Read Dual I/O (BBh) command except that address and data bits are input and output through four pins IO_0, IO_1, IO_2 and IO_3 and four Dummy clocks are required in SPI mode prior to the data output. The Quad I/O dramatically reduces command overhead allowing faster random access for code execution (XIP) directly from the Quad SPI. The Quad Enable bit (QE) of Status Register-2 must be set to enable the Fast Read Quad I/O Instruction.

Fast Read Quad I/O with "Read Command Bypass Mode"

The Fast Read Quad I/O command can further reduce command overhead through setting the "Read Command Bypass Mode" bits (M7-0) after the input Address bits (A23-0), as shown in Figure 24a. The upper nibble of the (M7-4) controls the length of the next Fast Read Quad I/O command through the inclusion or exclusion of the first byte command code. The lower nibble bits of the (M3-0) are don't care ("x"). However, the IO pins should be high-impedance prior to the falling edge of the first data out clock.

If the "Read Command Bypass Mode" bits M5-4 = (1,0), then the next Fast Read Quad I/O command (after /CS is raised and then lowered) does not require the EBh command code, as shown in Figure 24b. This reduces the command sequence by eight clocks and allows the Read address to be immediately entered after /CS is asserted low. If the "Read Command Bypass Mode" bits M5-4 do not equal to (1,0), the next command (after /CS is raised and then lowered) requires the first byte command code, thus returning to normal operation. It is recommended to input FFh on IO0 for the next command (8 clocks), to ensure M4 = 1 and return the device to normal operation.

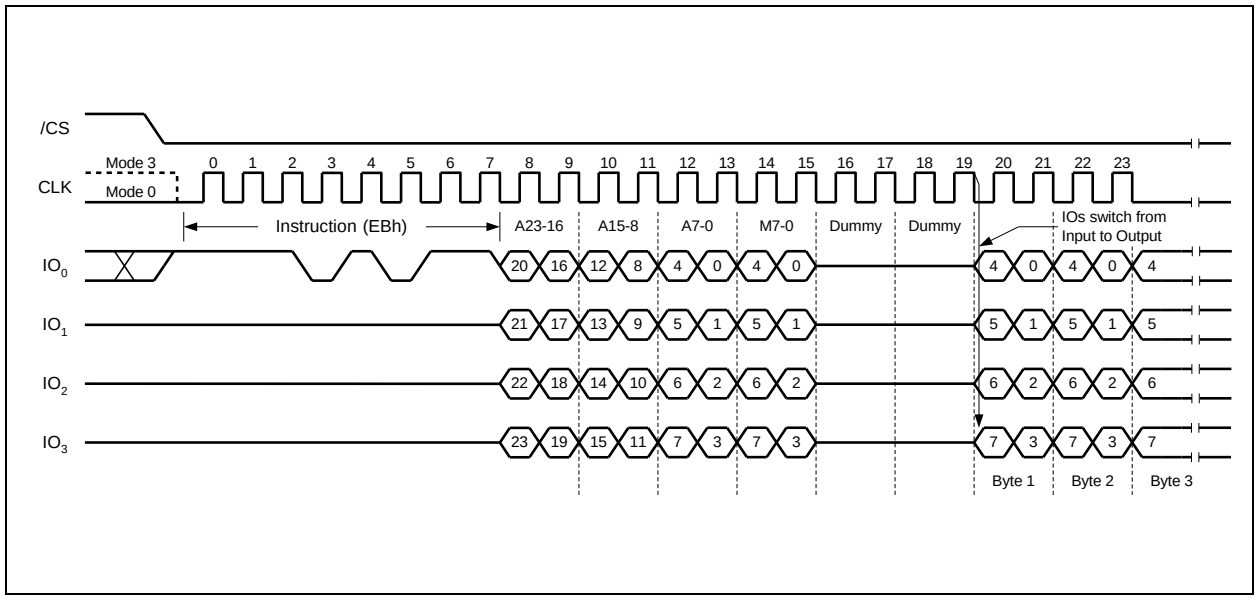


Figure 24a. Fast Read Quad I/O Instruction (Initial command or previous M5-4≠10, SPI Mode)
"Set Read Parameters" command (C0h) can set the number of dummy clocks.

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

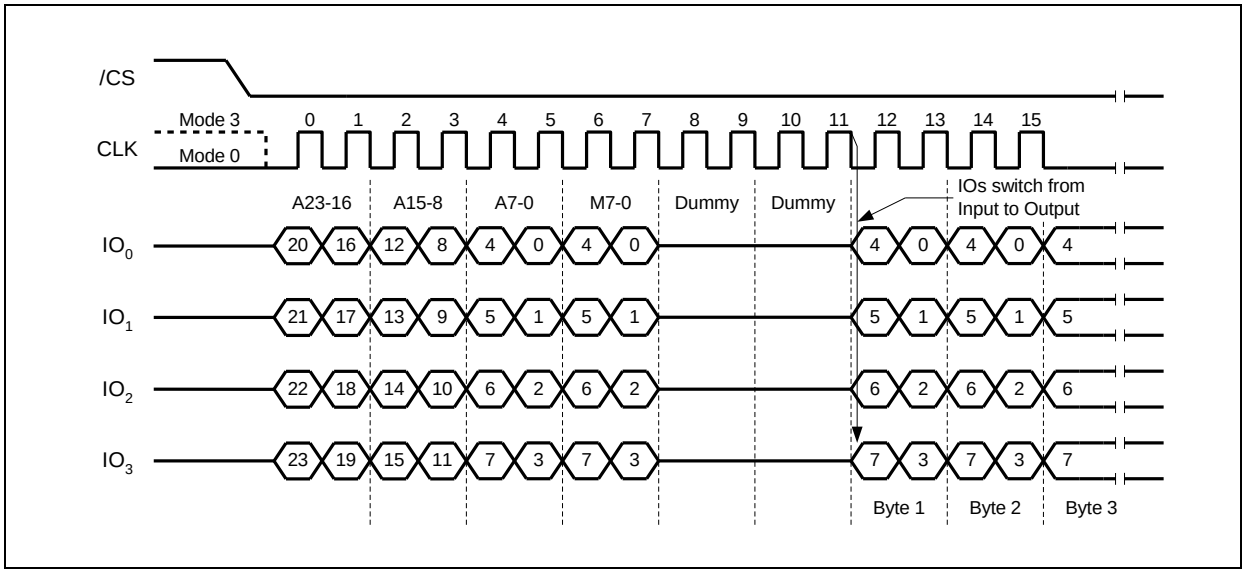


Figure 24b. Fast Read Quad I/O Instruction (Previous command set M5-4 = 10, SPI Mode)

Fast Read Quad I/O with "8/16/32/64-Byte Wrap Around" in Standard SPI mode

The Fast Read Quad I/O command can also be used to access a specific portion within a page by issuing a "Set Burst with Wrap" (77h) command prior to EBh. The "Set Burst with Wrap" (77h) command can either enable or disable the "Wrap Around" feature for the following EBh commands. When "Wrap Around" is enabled, the data being accessed can be limited to either an 8, 16, 32 or 64-byte section of a 256-byte page. The output data starts at the initial address specified in the command. Once it reaches the ending boundary of the 8/16/32/64-byte section, the output will wrap around to the beginning boundary automatically until /CS is pulled high to terminate the command.

The Burst with Wrap feature allows applications that use cache to quickly fetch a critical address and then fill the cache afterwards within a fixed length (8/16/32/64-byte) of data without issuing multiple read commands.

The "Set Burst with Wrap" command allows three "Wrap Bits", W6-4 to be set. The W4 bit is used to enable or disable the "Wrap Around" operation while W6-5 are used to specify the length of the wrap around section within a page. Refer to section 8.2.38 for detail descriptions.

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

Fast Read Quad I/O (EBh) in QPI Mode

The Fast Read Quad I/O command is also supported in QPI mode, as shown in Figure 24c. When QPI mode is enabled, the number of dummy clocks is configured by the “Set Read Parameters (C0h)” command to accommodate a wide range of applications with different needs for either maximum Fast Read frequency or minimum data access latency. Depending on the Read Parameter Bits P[6:4] setting, the number of dummy clocks can be configured as either 6, 8, 10, 12, 14 or 16. The default number of dummy clocks upon power up or after a Reset command is 6. In QPI mode, the “Read Command Bypass Mode” bits M7-0 are also considered as dummy clocks. In the default setting, the data output will follow the Read Command Bypass Mode bits immediately.

“Read Command Bypass Mode” feature is also available in QPI mode for Fast Read Quad I/O command. Please refer to the description on previous pages.

“Wrap Around” feature is not available in QPI mode for Fast Read Quad I/O command. To perform a read operation with fixed data length wrap around in QPI mode, a dedicated “Burst Read with Wrap” (0Ch) command must be used. Please refer to 8.2.39 for details.

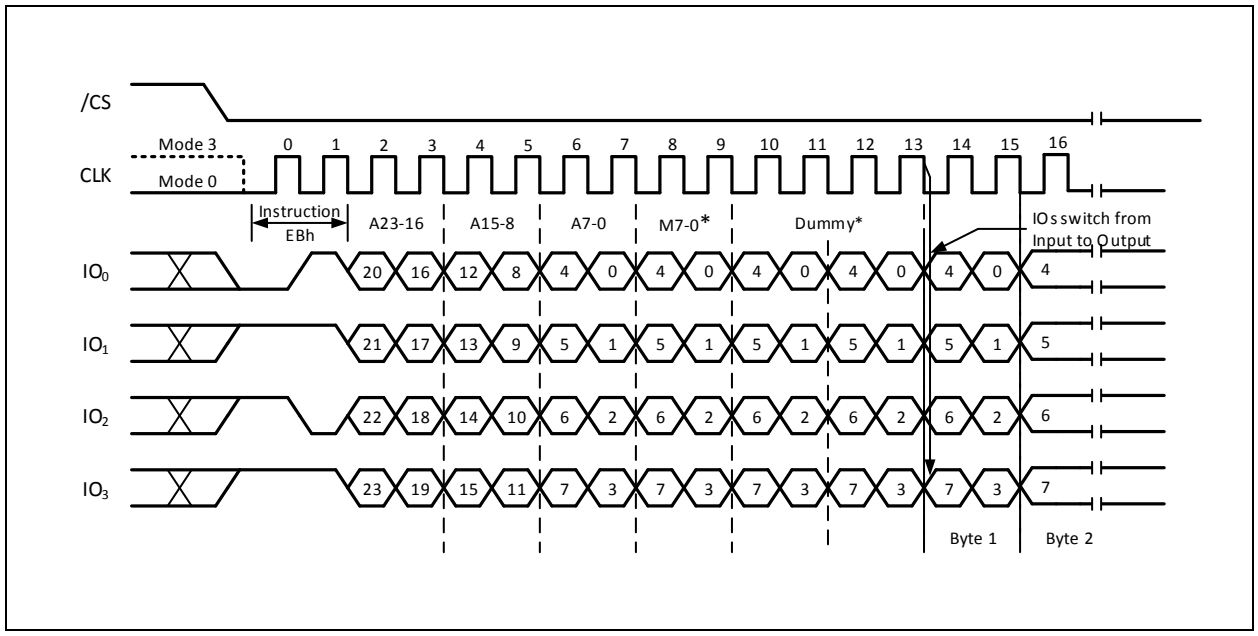


Figure 24c. Fast Read Quad I/O Instruction (Initial command or previous M5-4≠10, QPI Mode)
"Set Read Parameters" command (C0h) can set the number of dummy clocks.

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

7.2.12 Set Burst with Wrap (77h)

In Standard SPI mode, the Set Burst with Wrap (77h) command is used in conjunction with "Fast Read Quad I/O" commands to access a fixed length of 8/16/32/64-byte section within a 256-byte page. Certain applications can benefit from this feature and improve the overall system code execution performance.

Similar to a Quad I/O command, the Set Burst with Wrap command is initiated by driving the /CS pin low and then shifting the command code "77h" followed by 24 dummy bits and 8 "Wrap Bits", W7-0. The command sequence is shown in Figure 28. Wrap bit W7 and the lower nibble W3-0 are not used.

W6, W5	W4 = 0		W4 =1 (DEFAULT)	
	Wrap Around	Wrap Length	Wrap Around	Wrap Length
0 0	Yes	8-byte	No	N/A
0 1	Yes	16-byte	No	N/A
1 0	Yes	32-byte	No	N/A
1 1	Yes	64-byte	No	N/A

Once W6-4 is set by a Set Burst with Wrap command, the following "Fast Read Quad I/O" commands will use the W6-4 setting to access the 8/16/32/64-byte section within any page. To exit the "Wrap Around" function and return to normal read operation, another Set Burst with Wrap command should be issued to set W4 = 1. The default value of W4 upon power on or after a software/hardware reset is 1.

In QPI mode, the "Burst Read with Wrap (0Ch)" command should be used to perform the Read operation with "Wrap Around" feature. The Wrap Length set by W5-4 in Standard SPI mode is still valid in QPI mode and can also be re-configured by "Set Read Parameters (C0h)" command. Refer to "Burst Read with Wrap (0Ch)" and "Set Read Parameters (C0h)" for details.

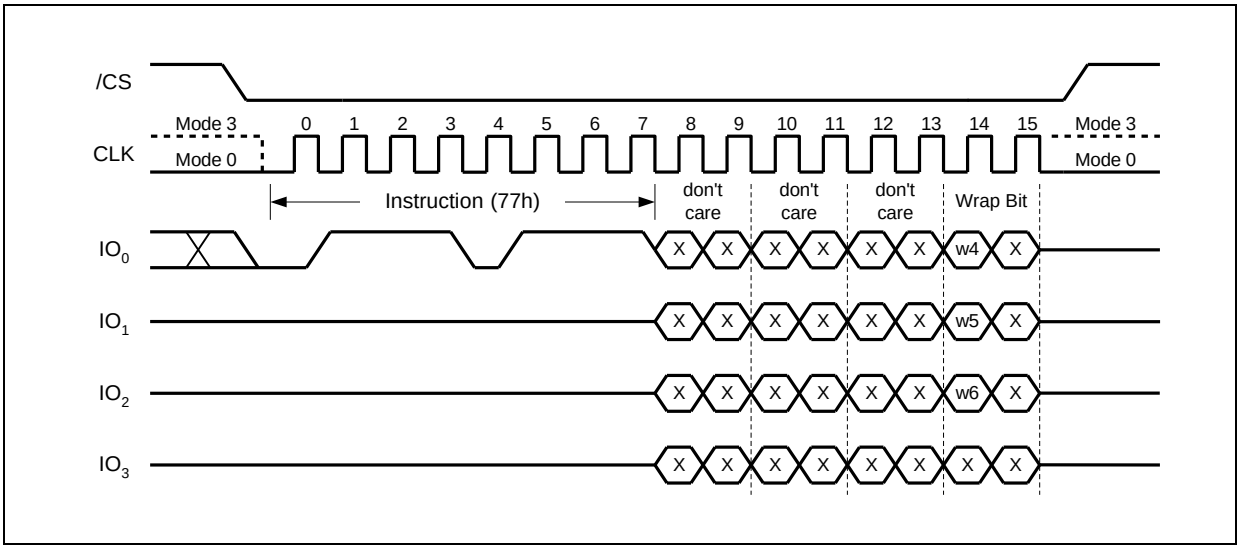


Figure 28. Set Burst with Wrap Instruction (SPI Mode only)

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

7.2.13 Page Program (02h)

The Page Program command allows from one byte to 256 bytes (a page) of data to be programmed at previously erased (FFh) memory locations. A Write Enable command must be executed before the device will accept the Page Program Instruction (Status Register bit WEL= 1). The command is initiated by driving the /CS pin low then shifting the command code “02h” followed by a 24-bit address (A23-A0) and at least one data byte, into the DI pin. The /CS pin must be held low for the entire length of the command while data is being sent to the device. The Page Program command sequence is shown in Figure 29.

If an entire 256 byte page is to be programmed, the last address byte (the 8 least significant address bits) should be set to 0. If the last address byte is not zero, and the number of clocks exceeds the remaining page length, the addressing will wrap to the beginning of the page. In some cases, less than 256 bytes (a partial page) can be programmed without having any effect on other bytes within the same page. One condition to perform a partial page program is that the number of clocks cannot exceed the remaining page length. If more than 256 bytes are sent to the device, the addressing will wrap to the beginning of the page and overwrite previously sent data.

As with the write and erase commands, the /CS pin must be driven high after the eighth bit of the last byte has been latched. If this is not done, the Page Program command will not be executed. After /CS is driven high, the self-timed Page Program command will commence for a time duration of tpp (See AC Characteristics). While the Page Program cycle is in progress, the Read Status Register command may still be accessed for checking the status of the BUSY bit. The BUSY bit is a 1 during the Page Program cycle and becomes a 0 when the cycle is finished and the device is ready to accept other commands again. After the Page Program cycle has finished, the Write Enable Latch (WEL) bit in the Status Register is cleared to 0. The Page Program command will not be executed if the addressed page is protected by the Block Protect (CMP, SEC, TB, BP2, BP1, and BP0) bits.

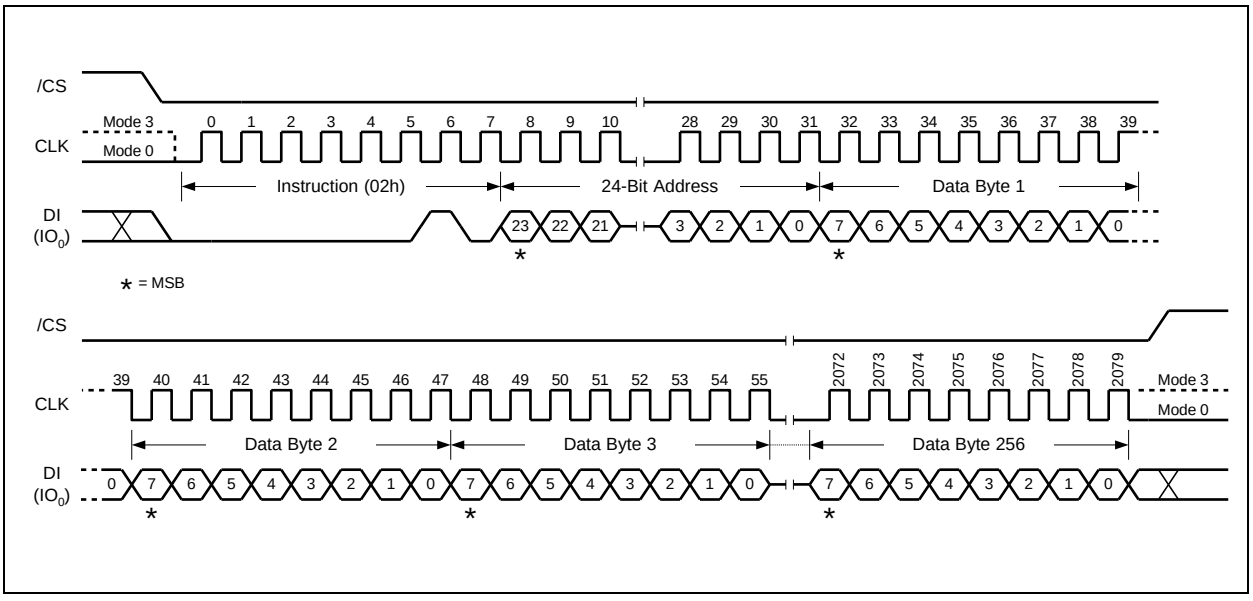


Figure 29a. Page Program Instruction (SPI Mode)

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

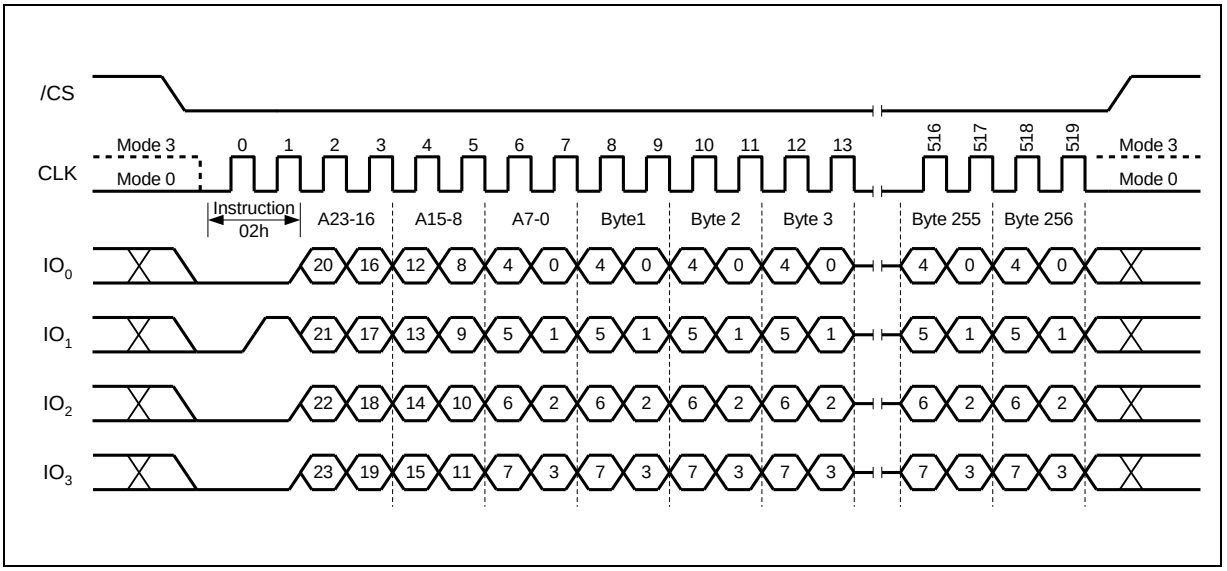


Figure 29b. Page Program Instruction (QPI Mode)

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

7.2.14 Quad Input Page Program (32h)

The Quad Page Program command allows up to 256 bytes of data to be programmed at previously erased (FFh) memory locations using four pins: IO_0, IO_1, IO_2, and IO_3. The Quad Page Program can improve performance for PROM Programmers and applications that have slow clock speeds <5MHz. Systems with faster clock speed will not realize much benefit for the Quad Page Program command since the inherent page program time is much greater than the time it take to clock-in the data.

To use Quad Page Program, the Quad Enable (QE) bit in Status Register-2 must be set to 1. A Write Enable command must be executed before the device will accept the Quad Page Program command (Status Register-1, WEL=1). The command is initiated by driving the /CS pin low then shifting the command code "32h" followed by a 24-bit address (A23-A0) and at least one data byte, into the IO pins. The /CS pin must be held low for the entire length of the command while data is being sent to the device. All other functions of Quad Page Program are identical to standard Page Program. The Quad Page Program command sequence is shown in Figure 30.

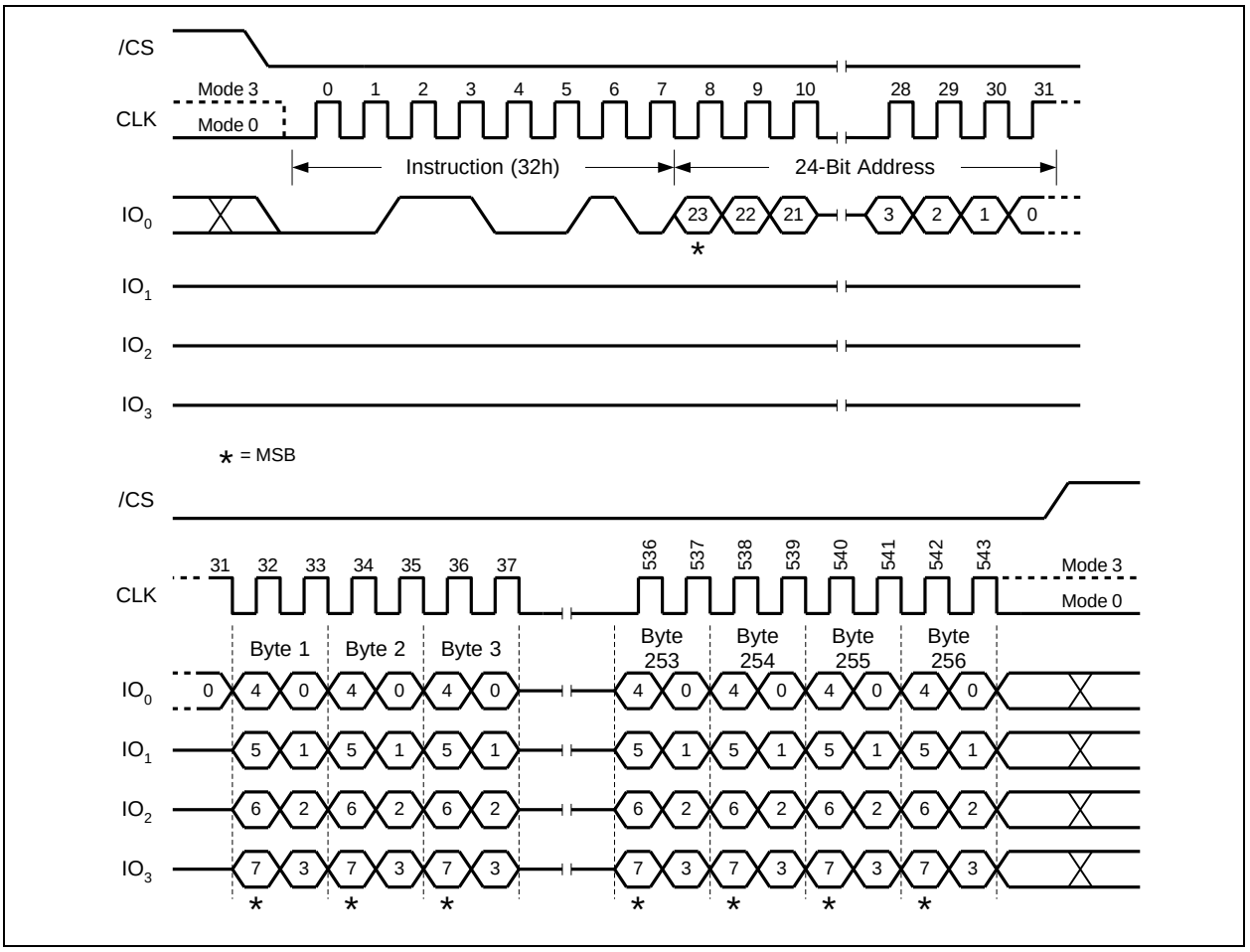


Figure 30. Quad Input Page Program Instruction (SPI Mode only)

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

7.2.15 Sector Erase (20h)

The Sector Erase command sets all memory within a specified sector (4K-bytes) to the erased state of all 1s (FFh). A Write Enable command must be executed before the device will accept the Sector Erase Instruction (Status Register bit WEL must equal 1). The command is initiated by driving the /CS pin low and shifting the command code “20h” followed by a 24-bit sector address (A23-A0). The Sector Erase command sequence is shown in Figure 31a & 31b.

The /CS pin must be driven high after the eighth bit of the last byte has been latched. If this is not done, the Sector Erase command will not be executed. After /CS is driven high, the self-timed Sector Erase command will commence for a time duration of t_{SE} (See AC Characteristics). While the Sector Erase cycle is in progress, the Read Status Register command may still be accessed for checking the status of the BUSY bit. The BUSY bit is a 1 during the Sector Erase cycle and becomes a 0 when the cycle is finished and the device is ready to accept other commands again. After the Sector Erase cycle has finished, the Write Enable Latch (WEL) bit in the Status Register is cleared to 0. The Sector Erase command will not be executed if the addressed page is protected by the Block Protect (CMP, SEC, TB, BP2, BP1, and BP0) bits.

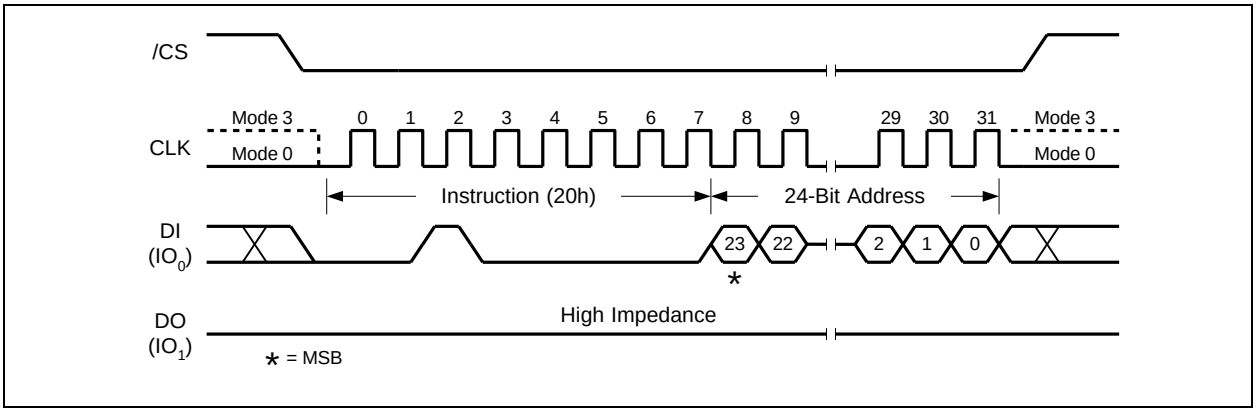


Figure 31a. Sector Erase Instruction (SPI Mode)

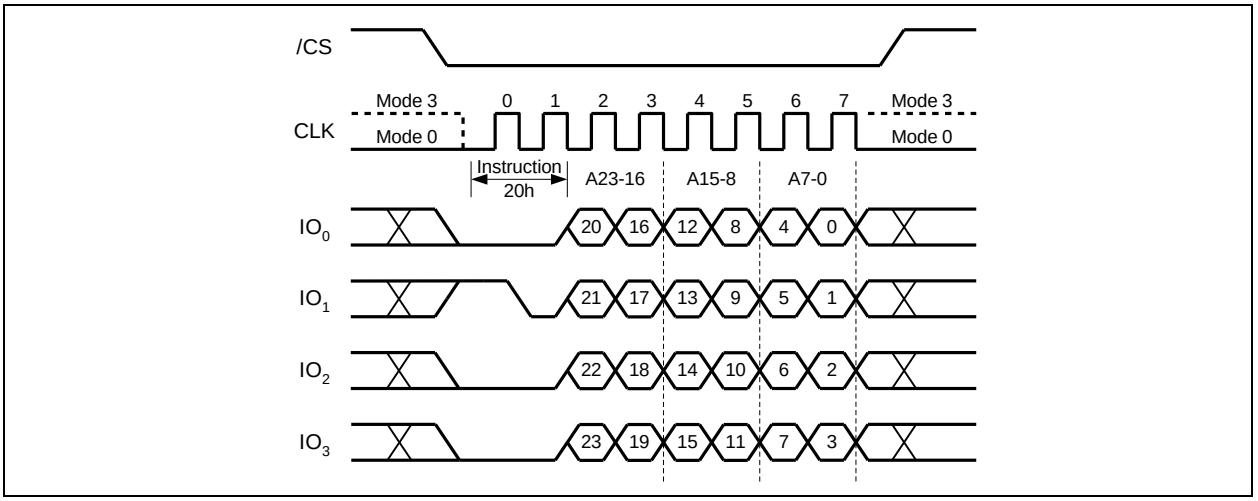


Figure 31b. Sector Erase Instruction (QPI Mode)

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

7.2.16 32KB Block Erase (52h)

The Block Erase command sets all memory within a specified block (32K-bytes) to the erased state of all 1s (FFh). A Write Enable command must be executed before the device will accept the Block Erase Instruction (Status Register bit WEL must equal 1). The command is initiated by driving the /CS pin low and shifting the command code “52h” followed a 24-bit block address (A23-A0). The Block Erase command sequence is shown in Figure 32a & 32b.

The /CS pin must be driven high after the eighth bit of the last byte has been latched. If this is not done, the Block Erase command will not be executed. After /CS is driven high, the self-timed Block Erase command will commence for a time duration of t_{BE1} (See AC Characteristics). While the Block Erase cycle is in progress, the Read Status Register command may still be accessed for checking the status of the BUSY bit. The BUSY bit is a 1 during the Block Erase cycle and becomes a 0 when the cycle is finished, and the device is ready to accept other commands again. After the Block Erase cycle has finished, the Write Enable Latch (WEL) bit in the Status Register is cleared to 0. The Block Erase command will not be executed if the addressed page is protected by the Block Protect (CMP, SEC, TB, BP2, BP1, and BP0) bits.

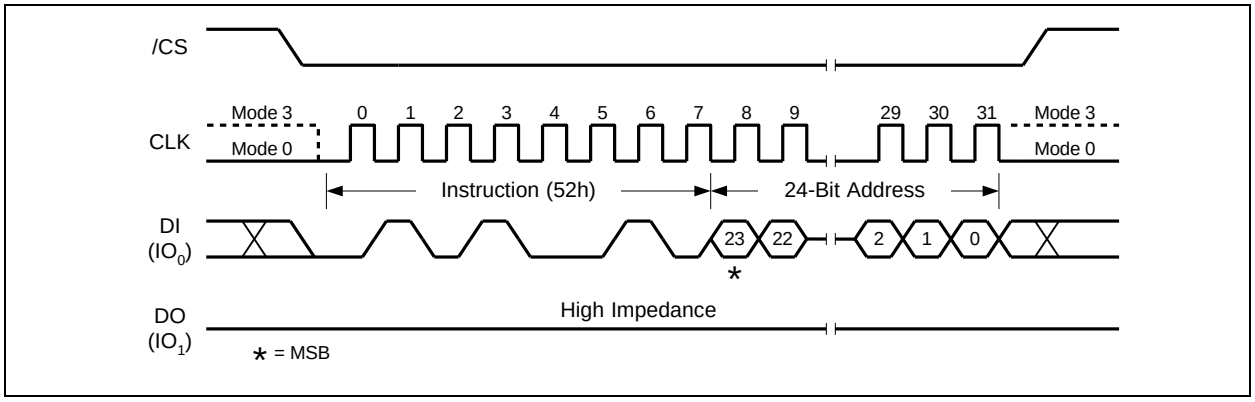


Figure 32a. 32KB Block Erase Instruction (SPI Mode)

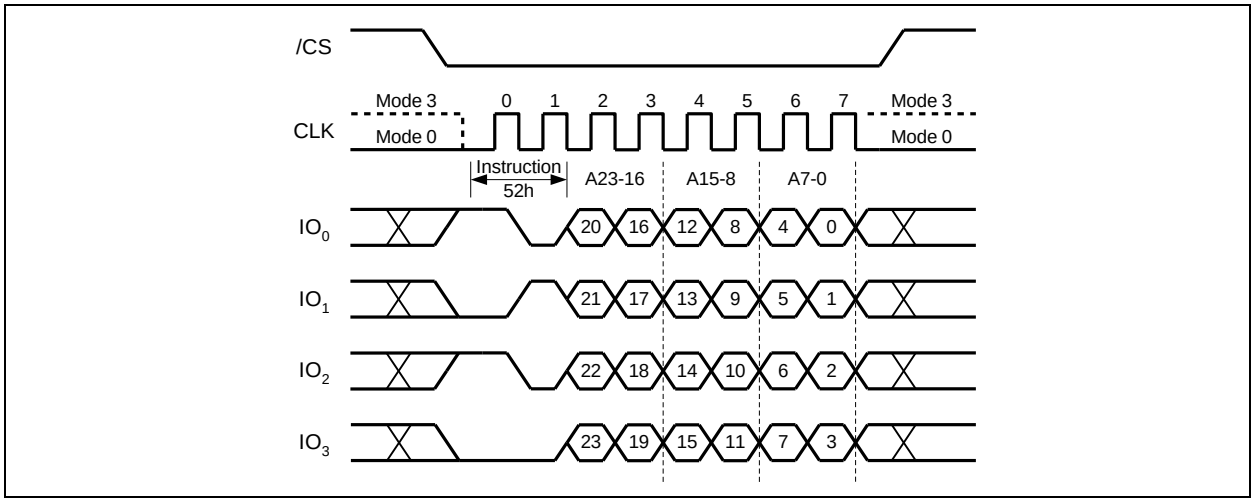


Figure 32b. 32KB Block Erase Instruction (QPI Mode)

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

7.2.17 64KB Block Erase (D8h)

The Block Erase command sets all memory within a specified block (64K-bytes) to the erased state of all 1s (FFh). A Write Enable command must be executed before the device will accept the Block Erase Instruction (Status Register bit WEL must equal 1). The command is initiated by driving the /CS pin low and shifting the command code “D8h” followed a 24-bit block address (A23-A0). The Block Erase command sequence is shown in Figure 33a & 33b.

The /CS pin must be driven high after the eighth bit of the last byte has been latched. If this is not done, the Block Erase command will not be executed. After /CS is driven high, the self-timed Block Erase command will commence for a time duration of t_{BE} (See AC Characteristics). While the Block Erase cycle is in progress, the Read Status Register command may still be accessed for checking the status of the BUSY bit. The BUSY bit is a 1 during the Block Erase cycle and becomes a 0 when the cycle is finished, and the device is ready to accept other commands again. After the Block Erase cycle has finished the Write Enable Latch (WEL) bit in the Status Register is cleared to 0. The Block Erase command will not be executed if the addressed page is protected by the Block Protect (CMP, SEC, TB, BP2, BP1, and BP0) bits.

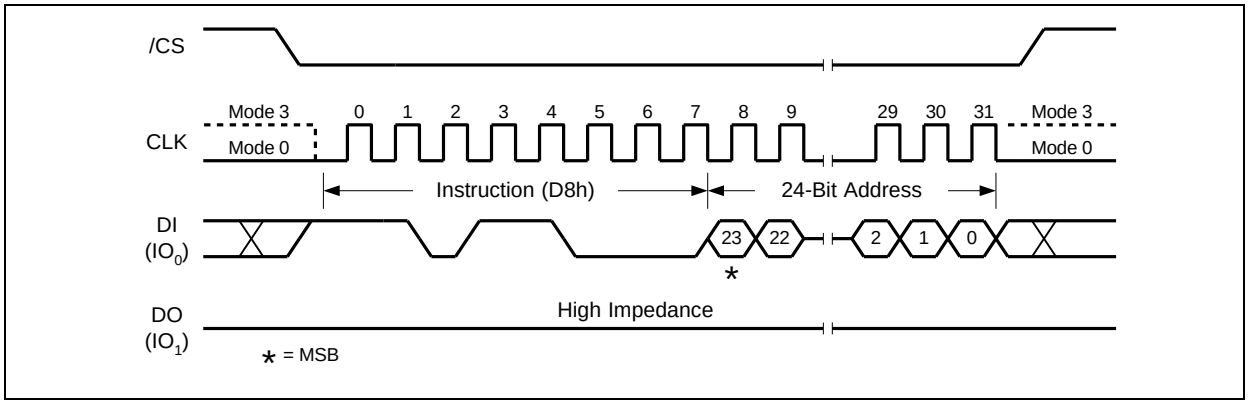


Figure 33a. 64KB Block Erase Instruction (SPI Mode)

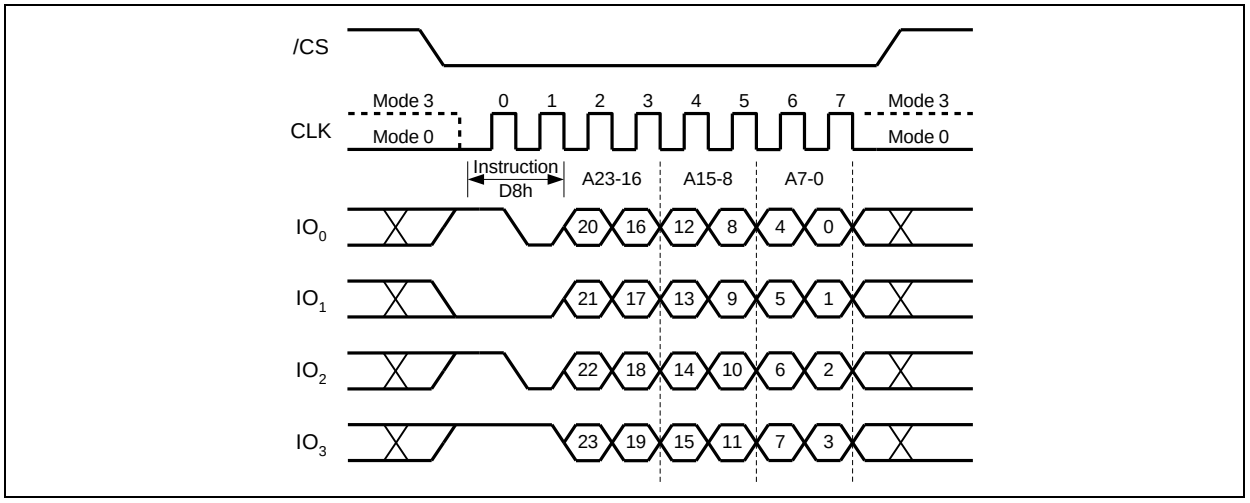


Figure 33b. 64KB Block Erase Instruction (QPI Mode)

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

7.2.18 Chip Erase (C7h / 60h)

The Chip Erase command sets all memory within the device to the erased state of all 1s (FFh). A Write Enable command must be executed before the device will accept the Chip Erase Instruction (Status Register bit WEL must equal 1). The command is initiated by driving the /CS pin low and shifting the command code “C7h” or “60h”. The Chip Erase command sequence is shown in Figure 34.

The /CS pin must be driven high after the eighth bit has been latched. If this is not done, the Chip Erase command will not be executed. After /CS is driven high, the self-timed Chip Erase command will commence for a time duration of t_{CE} (See AC Characteristics). While the Chip Erase cycle is in progress, the Read Status Register command may still be accessed to check the status of the BUSY bit. The BUSY bit is a 1 during the Chip Erase cycle and becomes a 0 when finished and the device is ready to accept other commands again. After the Chip Erase cycle has finished the Write Enable Latch (WEL) bit in the Status Register is cleared to 0. The Chip Erase command will not be executed if any memory region is protected by the Block Protect (CMP, SEC, TB, BP2, BP1, and BP0) bits.

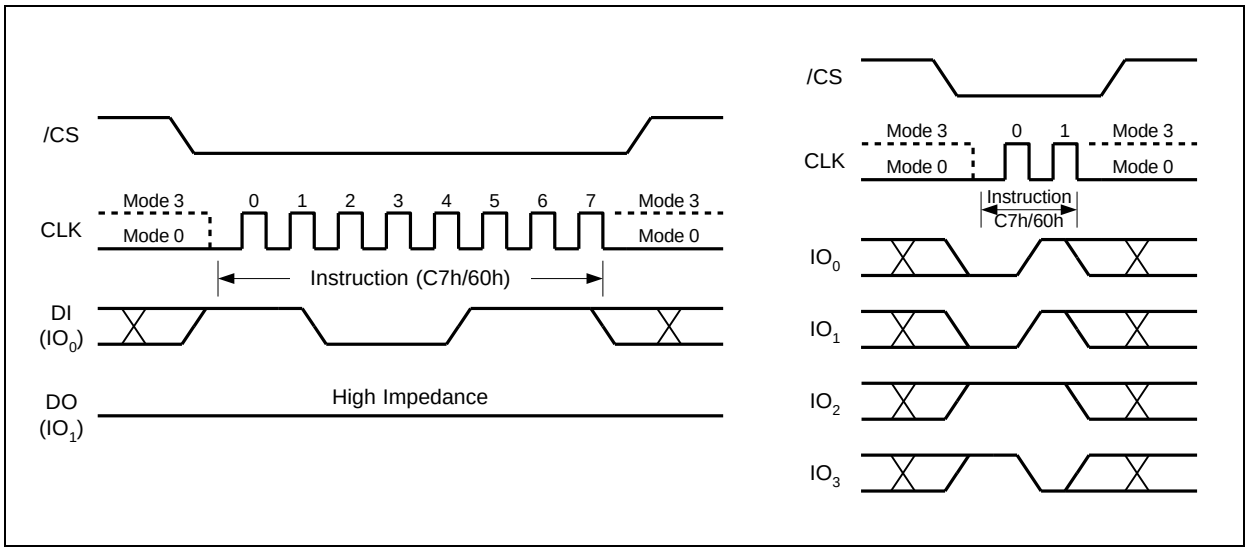


Figure 34. Chip Erase Instruction for SPI Mode (left) or QPI Mode (right)

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

7.2.19 Erase / Program Suspend (75h)

The Erase/Program Suspend command “75h”, allows the system to interrupt a Sector or Block Erase operation or a Page Program operation and then read from or program/erase data to any other sectors or blocks. The Erase/Program Suspend command sequence is shown in Figure 35a & 35b.

The Write Status Register command (01h/31h/11h) and Erase commands (20h, 52h, D8h, C7h, 60h, 44h) are not allowed during Erase Suspend. Erase Suspend is valid only during the Sector or Block erase operation. If written during the Chip Erase operation, the Erase Suspend command is ignored. The Write Status Register command (01h/31h/11h) and Program commands (02h, 32h, 42h) are not allowed during Program Suspend. Program Suspend is valid only during the Page Program or Quad Page Program operation.

The Erase/Program Suspend command “75h” will be accepted by the device only if the SUS bit in the Status Register equals to 0 and the BUSY bit equals to 1 while a Sector or Block Erase or a Page Program operation is on-going. If the SUS bit equals to 1 or the BUSY bit equals to 0, the Suspend command will be ignored by the device. A maximum time “t_{SUS}” (See AC Characteristics) is required to suspend the erase or program operation. The BUSY bit in the Status Register will be cleared from 1 to 0 within “t_{SUS}” and the SUS bit in the Status Register will be set from 0 to 1 immediately after the Erase/Program Suspend. For a previously resumed Erase/Program operation, it is also required that the Suspend command “75h” is not issued earlier than a minimum of time of “t_{SUS}” following the preceding Resume command “7Ah”.

Unexpected power off during the Erase/Program suspend state will reset the device and release the suspend state. SUS bit in the Status Register will also reset to 0. The data within the page, sector or block that was being suspended may become corrupted. It is recommended for the user to implement system design techniques against accidental power interruption to preserve data integrity during erase/program suspend state.

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

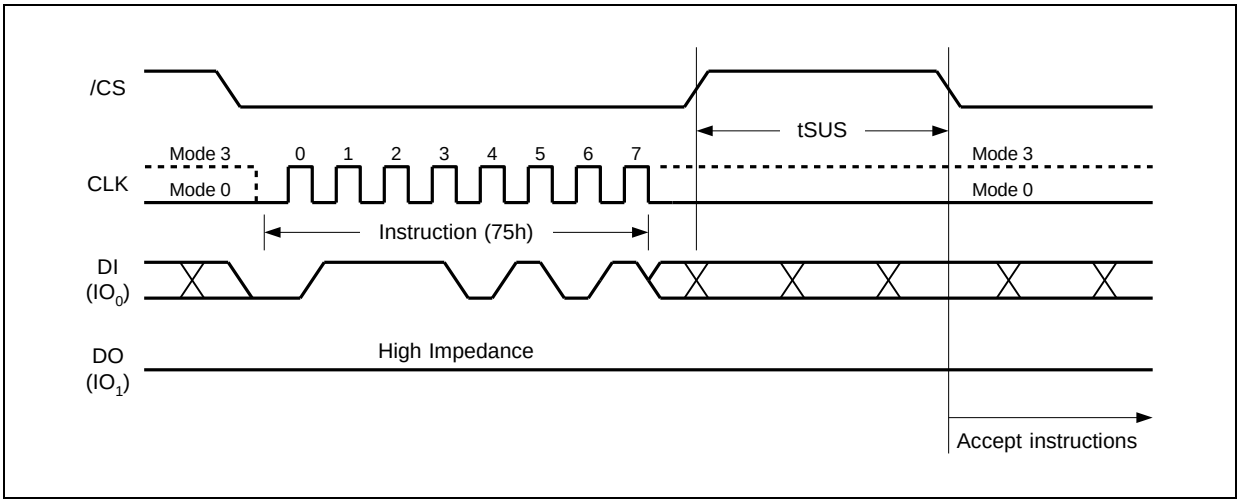


Figure 35a. Erase/Program Suspend Instruction (SPI Mode)

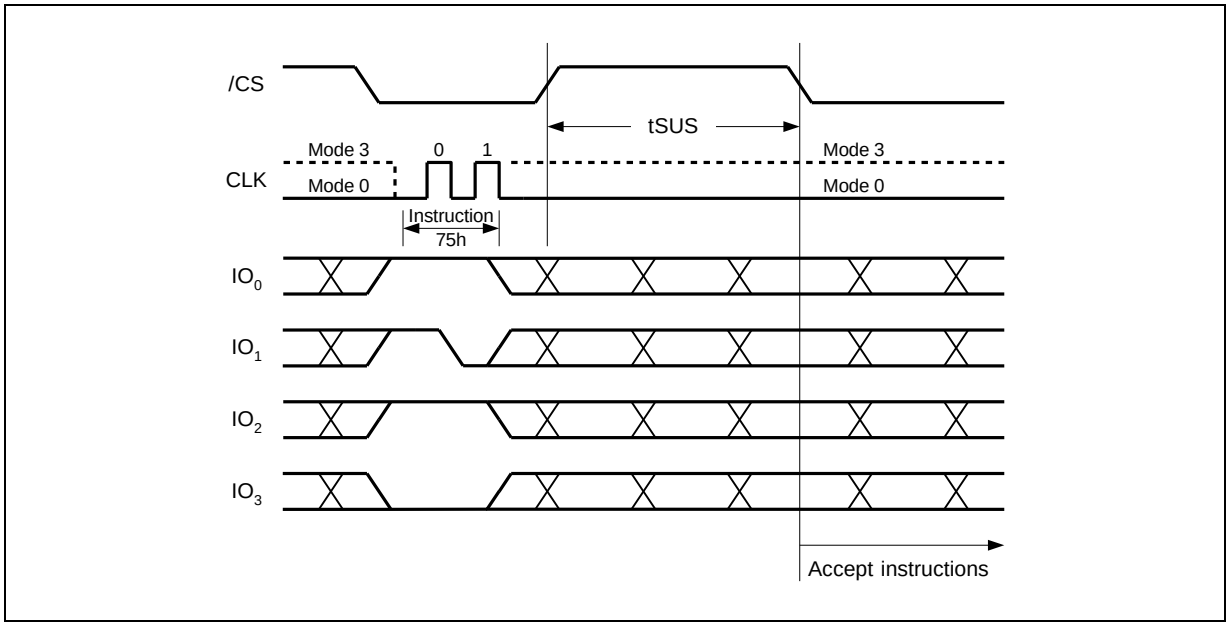


Figure 35b. Erase/Program Suspend Instruction (QPI Mode)

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

7.2.20 Erase / Program Resume (7Ah)

The Erase/Program Resume command “7Ah” must be written to resume the Sector or Block Erase operation or the Page Program operation after an Erase/Program Suspend. The Resume command “7Ah” will be accepted by the device only if the SUS bit in the Status Register equals to 1 and the BUSY bit equals to 0. After the command is issued, the SUS bit will be cleared from 1 to 0 immediately, the BUSY bit will be set from 0 to 1 within 200ns and the Sector or Block will complete the erase operation or the page will complete the program operation. If the SUS bit equals to 0 or the BUSY bit equals to 1, the Resume command “7Ah” will be ignored by the device. The Erase/Program Resume command sequence is shown in Figure 36a & 36b.

The Resume command is ignored if the previous Erase/Program Suspend operation was interrupted by unexpected power off. It is also required that a subsequent Erase/Program Suspend command not to be issued within a minimum time “t_{SUS}” following a previous Resume command.

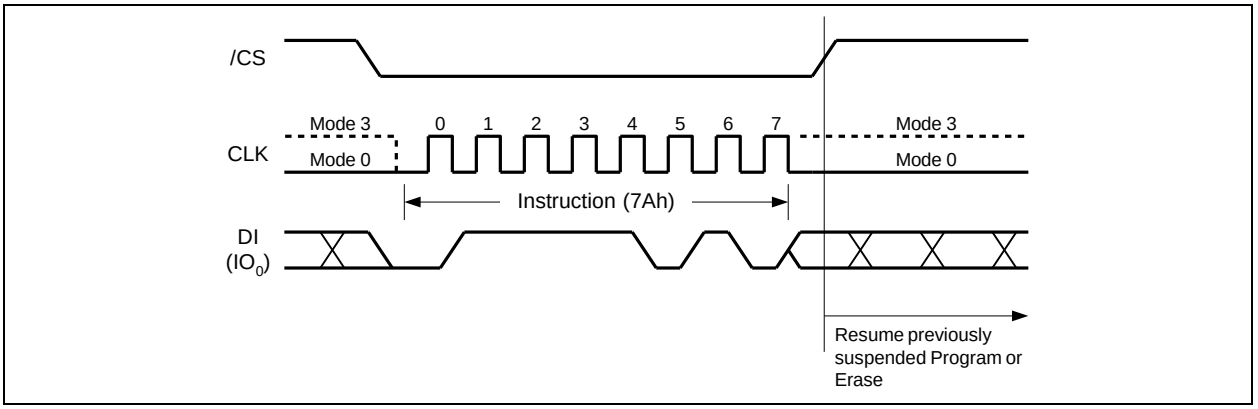


Figure 36a. Erase/Program Resume Instruction (SPI Mode)

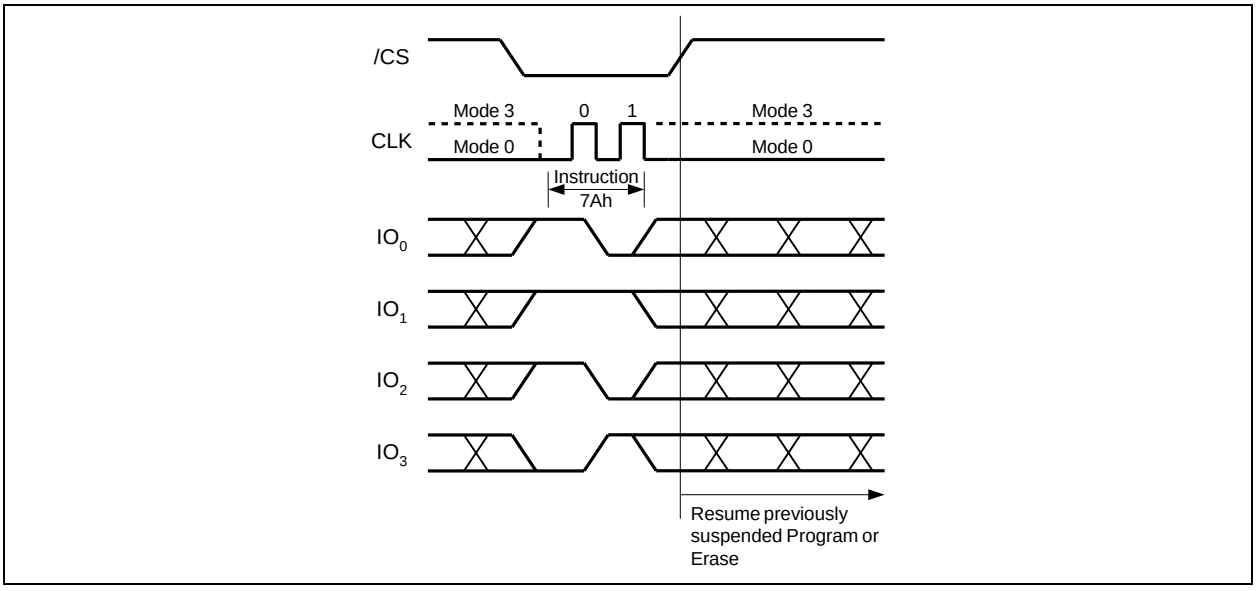


Figure 36b. Erase/Program Resume Instruction (QPI Mode)

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

7.2.21 Power-down (B9h)

Although the standby current during normal operation is relatively low, standby current can be further reduced with the Power-down command. The lower power consumption makes the Power-down command especially useful for battery powered applications (See ICC1 and ICC2 in AC Characteristics). The command is initiated by driving the /CS pin low and shifting the command code “B9h” as shown in Figure 37a & 37b.

The /CS pin must be driven high after the eighth bit has been latched. If this is not done, the Power-down command will not be executed. After /CS is driven high, the power-down state will entered within the time duration of t_{DP} (See AC Characteristics). While in the power-down state, only the Release Power-down / Device ID (ABh) command, which restores the device to normal operation, will be recognized. All other commands are ignored. This includes the Read Status Register command, which is always available during normal operation. Ignoring all but one command makes the Power Down state a useful condition for securing maximum write protection. The device always powers-up in normal operation with the standby current of ICC1.

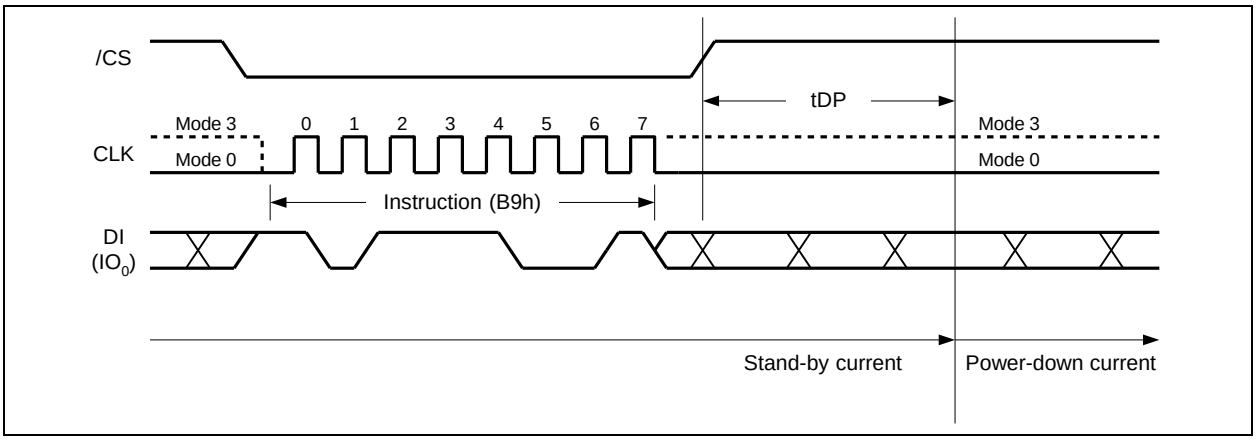


Figure 37a. Deep Power-down Instruction (SPI Mode)

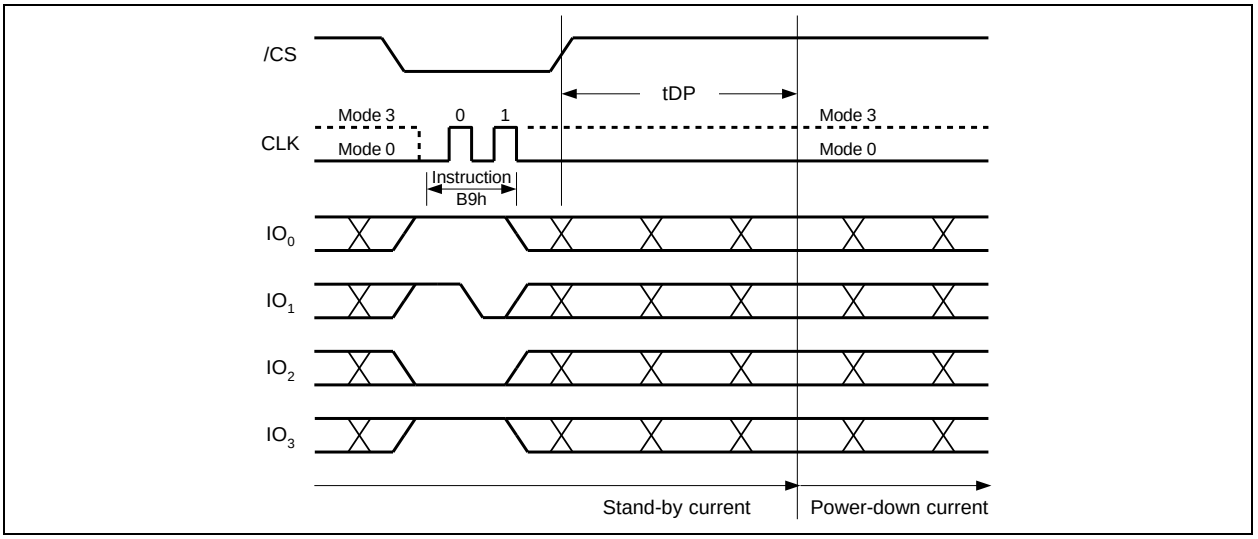


Figure 37b. Deep Power-down Instruction (QPI Mode)

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

7.2.22 Release Power-down / Device ID (ABh)

The Release from Power-down / Device ID command is a multi-purpose command. It can be used to release the device from the power-down state, or obtain the devices electronic identification (ID) number.

To release the device from the power-down state, the command is issued by driving the /CS pin low, shifting the command code “ABh” and driving /CS high as shown in Figure 38a & 38b. Release from power-down will take the time duration of t_{RES1} (See AC Characteristics) before the device will resume normal operation and other commands are accepted. The /CS pin must remain high during the t_{RES1} time duration.

When used only to obtain the Device ID while not in the power-down state, the command is initiated by driving the /CS pin low and shifting the command code “ABh” followed by 3-dummy bytes. The Device ID bits are then shifted out on the falling edge of CLK with most significant bit (MSB) first. The Device ID value for the W25Q80RV is listed in Manufacturer and Device Identification table. The Device ID can be read continuously. The command is completed by driving /CS high.

When used to release the device from the power-down state and obtain the Device ID, the command is the same as previously described, and shown in Figure 38c & 38d, except that after /CS is driven high it must remain high for a time duration of t_{RES2} (See AC Characteristics). After this time duration, the device will resume normal operation and other commands will be accepted. If the Release from Power-down / Device ID command is issued while an Erase, Program or Write cycle is in process (when BUSY equals 1), the command is ignored and will not have any effects on the current cycle.

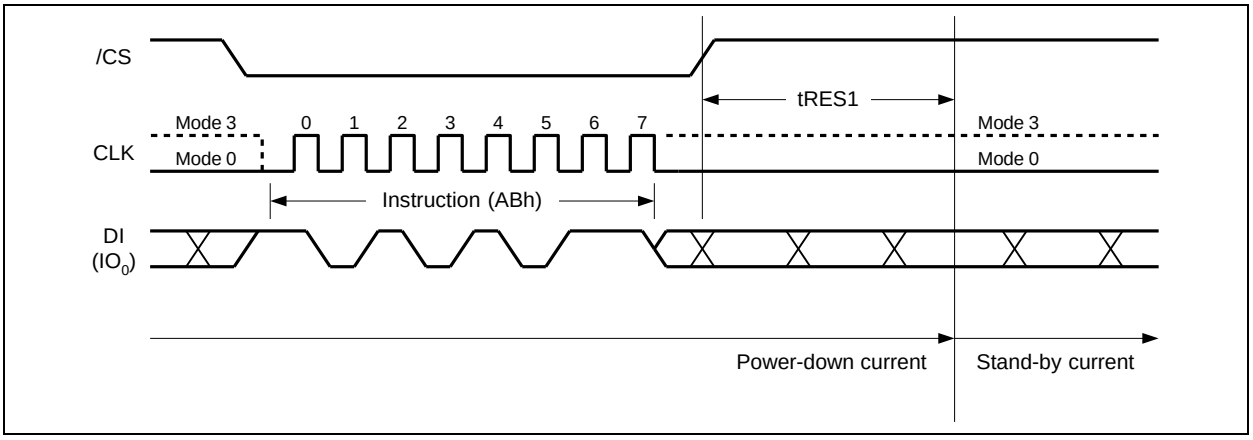


Figure 38a. Release Power-down Instruction (SPI Mode)

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

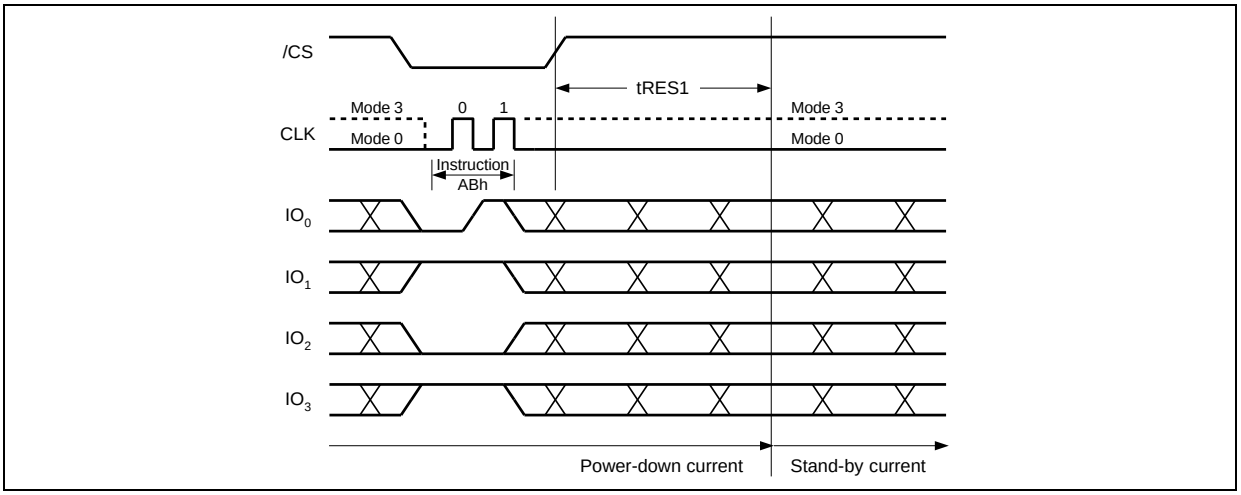


Figure 38b. Release Power-down Instruction (QPI Mode)

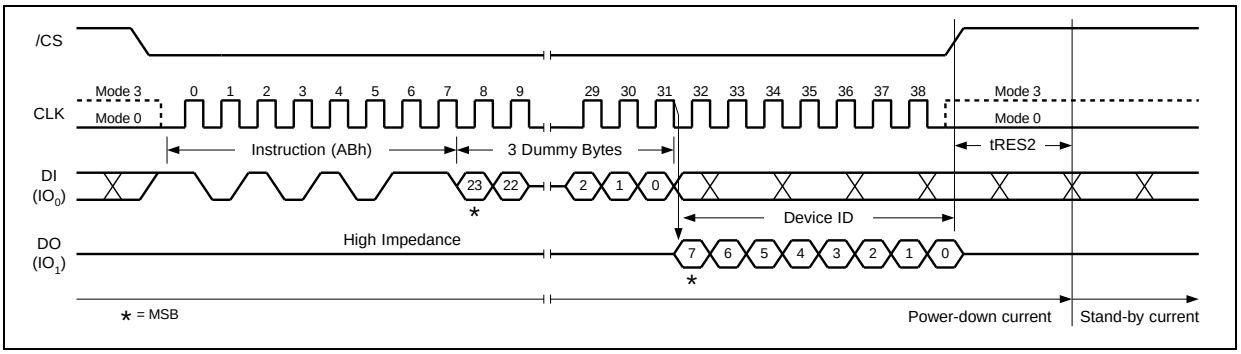


Figure 38c. Release Power-down / Device ID Instruction (SPI Mode)

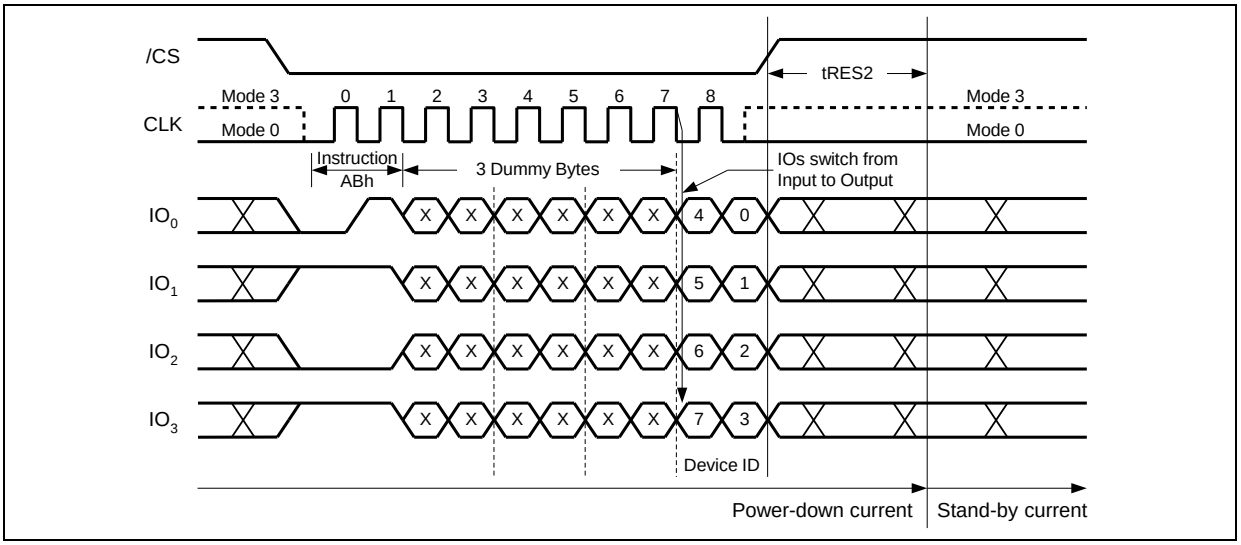


Figure 38d. Release Power-down / Device ID Instruction (QPI Mode)

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

7.2.23 Read Manufacturer / Device ID (90h)

The Read Manufacturer/Device ID command is an alternative to the Release from Power-down / Device ID command that provides both the JEDEC assigned manufacturer ID and the specific device ID.

The Read Manufacturer/Device ID command is very similar to the Release from Power-down / Device ID command. The command is initiated by driving the /CS pin low and shifting the command code “90h” followed by a 24-bit address (A23-A0) of 000000h. After which, the Manufacturer ID for Winbond (EFh) and the Device ID are shifted out on the falling edge of CLK with most significant bit (MSB) first as shown in Figure 39. The Device ID values for the W25Q80RV are listed in Manufacturer and Device Identification table. The command is completed by driving /CS high.

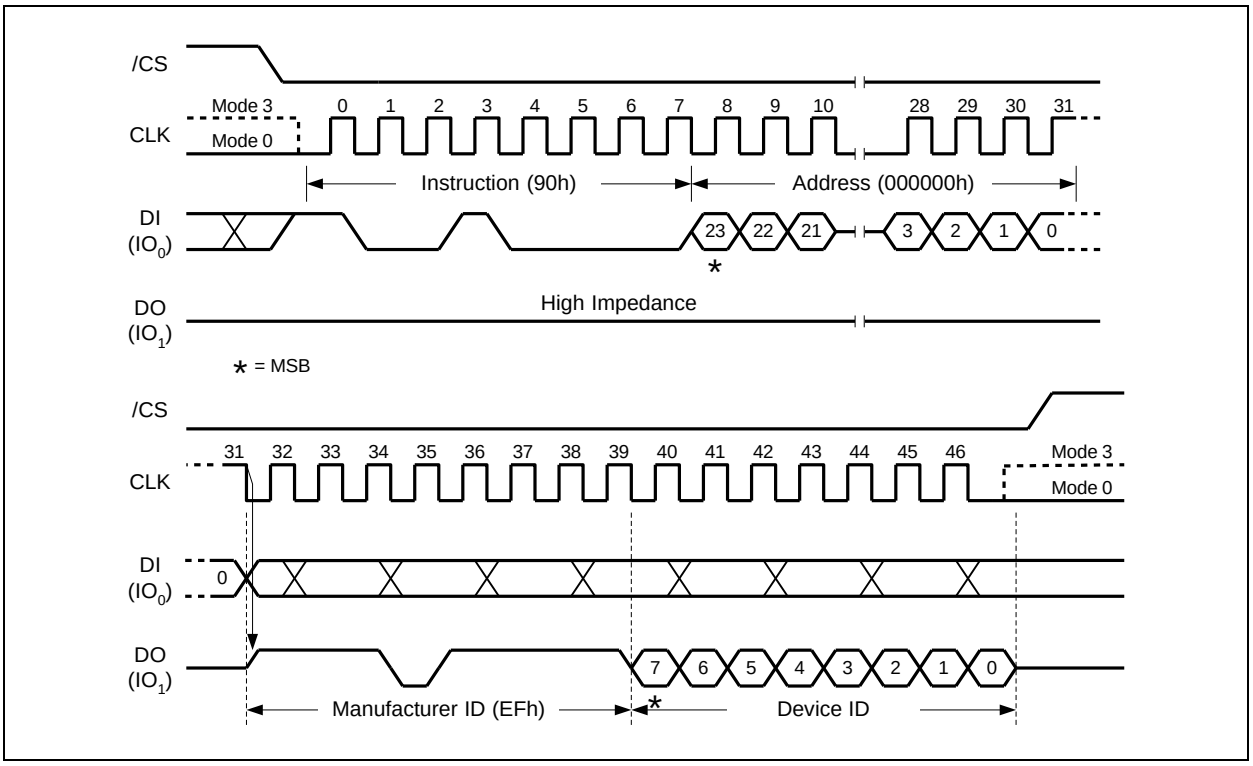


Figure 39. Read Manufacturer / Device ID Instruction (SPI Mode)

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

7.2.24 Read Manufacturer / Device ID Dual I/O (92h)

The Read Manufacturer / Device ID Dual I/O command is an alternative to the Read Manufacturer / Device ID command that provides both the JEDEC assigned manufacturer ID and the specific device ID at 2x speed.

The Read Manufacturer / Device ID Dual I/O command is similar to the Fast Read Dual I/O command. The command is initiated by driving the /CS pin low and shifting the command code “92h” followed by a 24-bit address (A23-A0) of 000000h, but with the capability to input the Address bits two bits per clock. After which, the Manufacturer ID for Winbond (EFh) and the Device ID are shifted out 2 bits per clock on the falling edge of CLK with most significant bits (MSB) first as shown in Figure 40. The Device ID values for the W25Q80RV are listed in Manufacturer and Device Identification table. The Manufacturer and Device IDs can be read continuously, alternating from one to the other. The command is completed by driving /CS high.

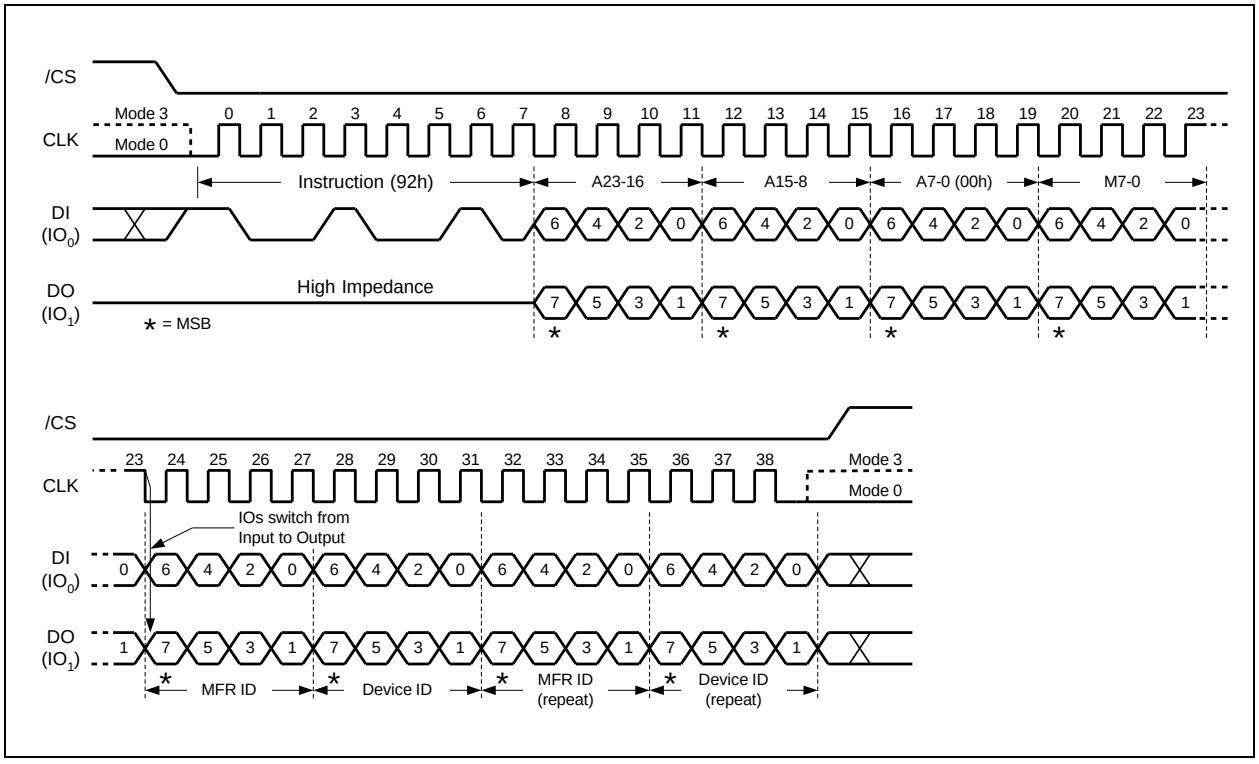


Figure 40. Read Manufacturer / Device ID Dual I/O Instruction (SPI Mode only)

Note:
The “Read Command Bypass Mode” bits M(7-0) must be set to Fxh to be compatible with Fast Read Dual I/O command.

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

7.2.25 Read Manufacturer / Device ID Quad I/O (94h)

The Read Manufacturer / Device ID Quad I/O command is an alternative to the Read Manufacturer / Device ID command that provides both the JEDEC assigned manufacturer ID and the specific device ID at 4x speed.

The Read Manufacturer / Device ID Quad I/O command is similar to the Fast Read Quad I/O command. The command is initiated by driving the /CS pin low and shifting the command code “94h” followed by a four clock dummy cycles and then a 24-bit address (A23-A0) of 000000h, but with the capability to input the Address bits four bits per clock. After which, the Manufacturer ID for Winbond (EFh) and the Device ID are shifted out four bits per clock on the falling edge of CLK with most significant bit (MSB) first as shown in Figure 41. The Device ID values for the W25Q80RV are listed in Manufacturer and Device Identification table. The Manufacturer and Device IDs can be read continuously, alternating from one to the other. The command is completed by driving /CS high.

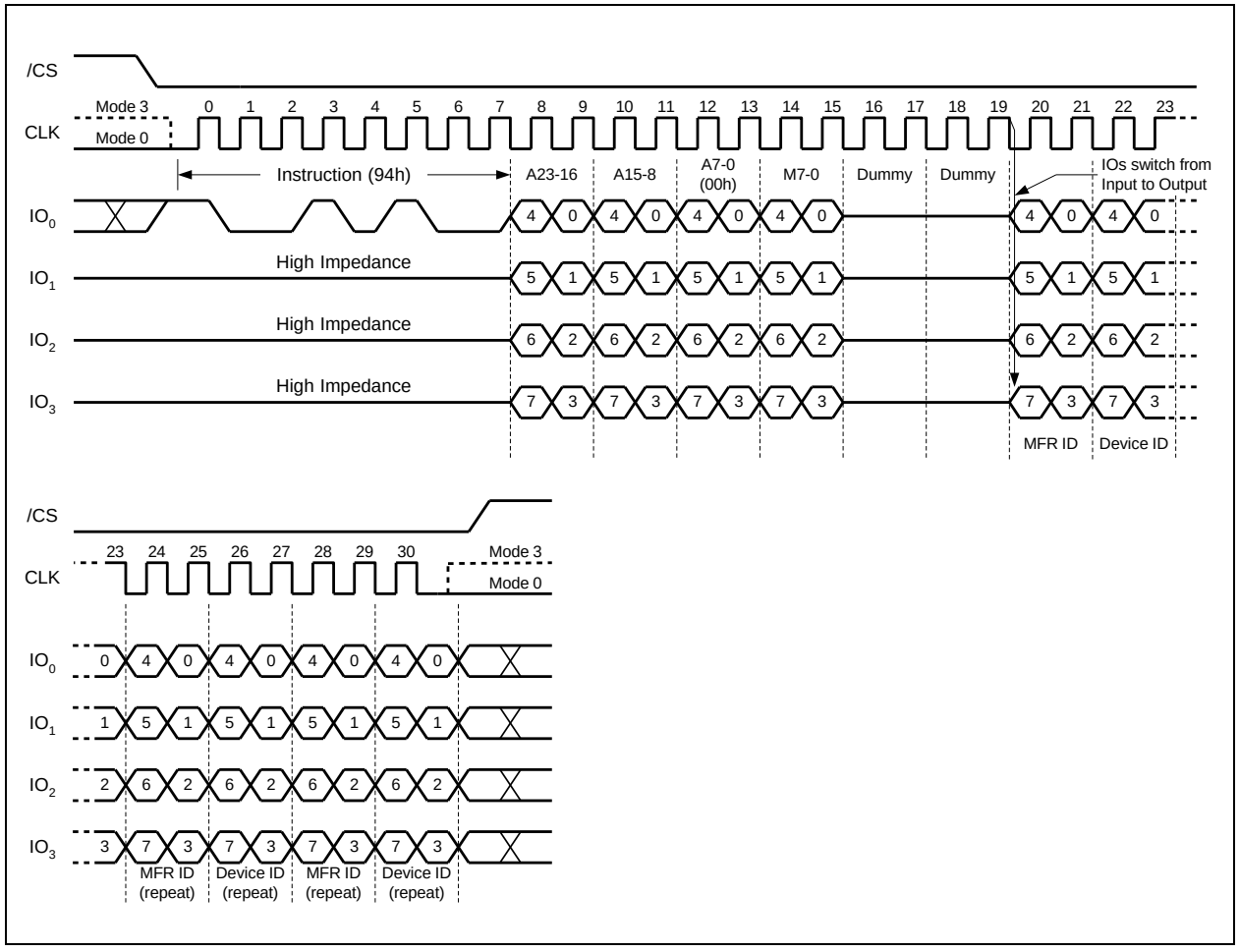


Figure 41. Read Manufacturer / Device ID Quad I/O Instruction (SPI Mode only)

Note:

The “Read Command Bypass Mode” bits M(7-0) must be set to Fxh to be compatible with Fast Read Quad I/O command.

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

7.2.26 Read Unique ID Number (4Bh)

The Read Unique ID Number command accesses a factory-set read-only 64-bit number that is unique to each W25Q80RV device. The ID number can be used in conjunction with user software methods to help prevent copying or cloning of a system. The Read Unique ID command is initiated by driving the /CS pin low and shifting the command code “4Bh” followed by four bytes of dummy clocks. After which, the 64-bit ID is shifted out on the falling edge of the CLK as shown in Figure 42.

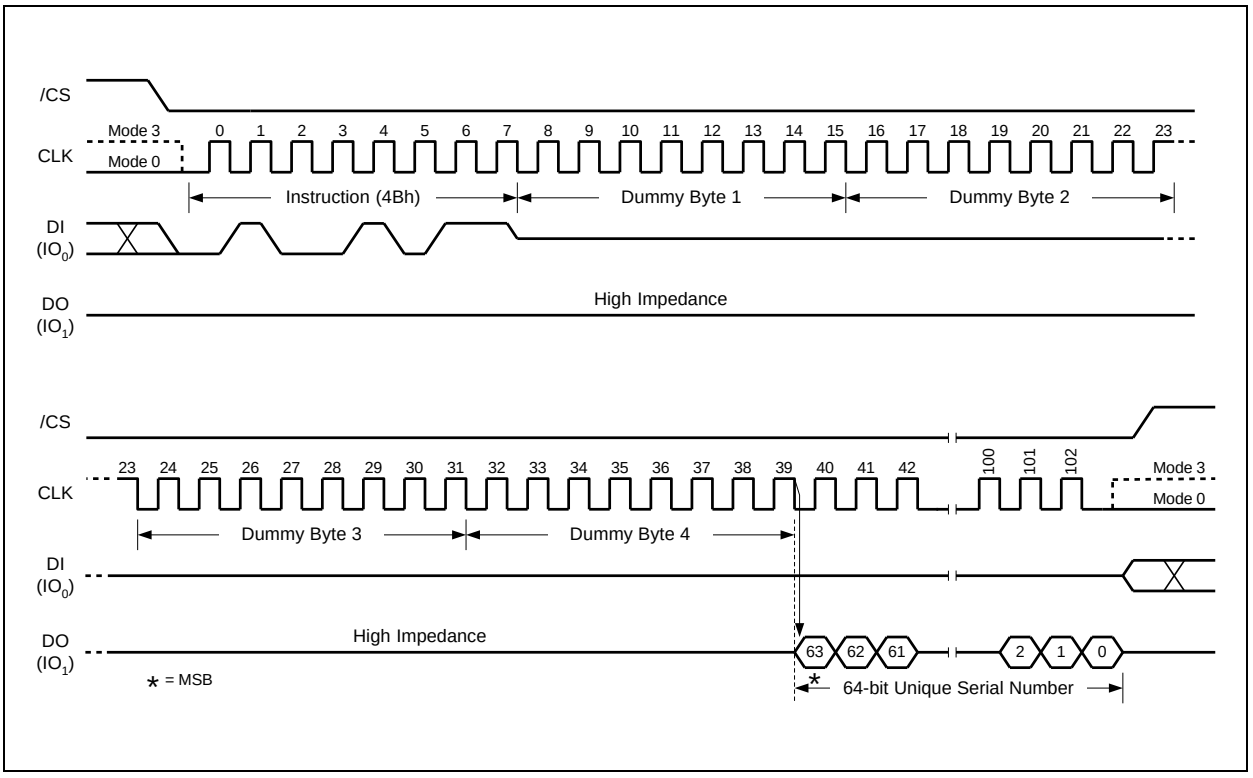


Figure 42. Read Unique ID Number Instruction (SPI Mode only)

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

7.2.27 Read JEDEC ID (9Fh)

For compatibility reasons, the W25Q80RV provides several commands to electronically determine the identity of the device. The Read JEDEC ID command is compatible with the JEDEC standard for SPI compatible serial memories that was adopted in 2003. The command is initiated by driving the /CS pin low and shifting the command code “9Fh”. The JEDEC assigned Manufacturer ID byte for Winbond (EFh) and two Device ID bytes, Memory Type (ID15-ID8) and Capacity (ID7-ID0) are then shifted out on the falling edge of CLK with most significant bit (MSB) first as shown in Figure 43a & 43b. For memory type and capacity values refer to the Manufacturer and Device Identification table.

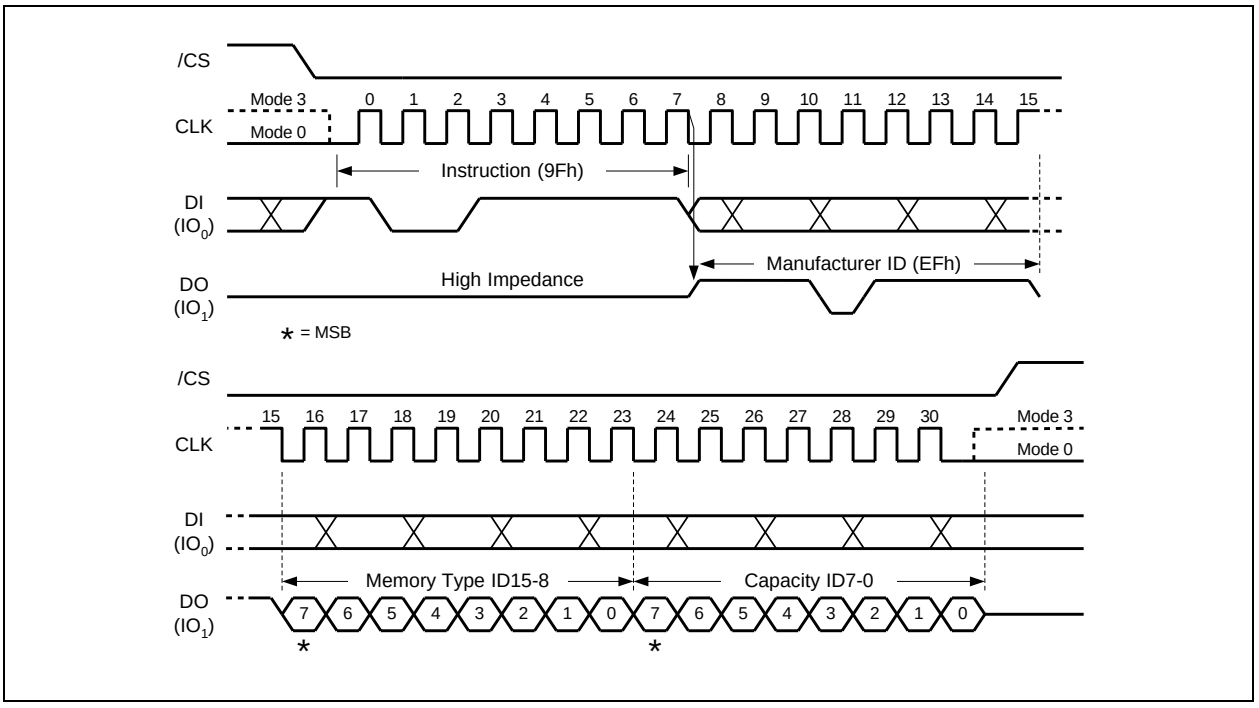


Figure 43a. Read JEDEC ID Instruction (SPI Mode)

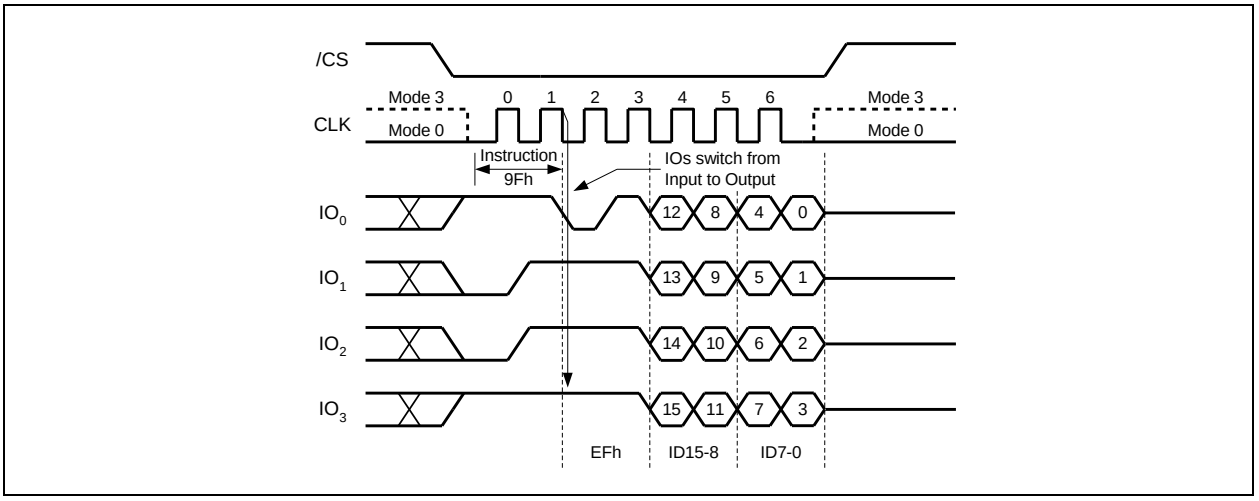


Figure 43b. Read JEDEC ID Instruction (QPI Mode)

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

7.2.28 Read SFDP Register (5Ah)

The W25Q80RV features a 256-Byte Serial Flash Discoverable Parameter (SFDP) register that contains information about device configurations, available commands and other features. The SFDP parameters are stored in one or more Parameter Identification (PID) tables. Currently only one PID table is specified, but more may be added in the future. The Read SFDP Register command is compatible with the SFDP standard initially established in 2010 for PC and other applications, as well as the JEDEC standard JESD216-serials that is published in 2011. Most Winbond SpiFlash Memories shipped after June 2011 (date code 1124 and beyond) support the SFDP feature as specified in the applicable datasheet.

The Read SFDP command is initiated by driving the /CS pin low and shifting the command code "5Ah" followed by a 24-bit address (A23-A0)(1) into the DI pin. Eight "dummy" clocks are also required before the SFDP register contents are shifted out on the falling edge of the 40th CLK with most significant bit (MSB) first as shown in Figure 44. For SFDP register values and descriptions, please refer to the Winbond Application Note for SFDP Definition Table.

Note 1: A23-A8 = 0; A7-A0 are used to define the starting byte address for the 256-Byte SFDP Register.

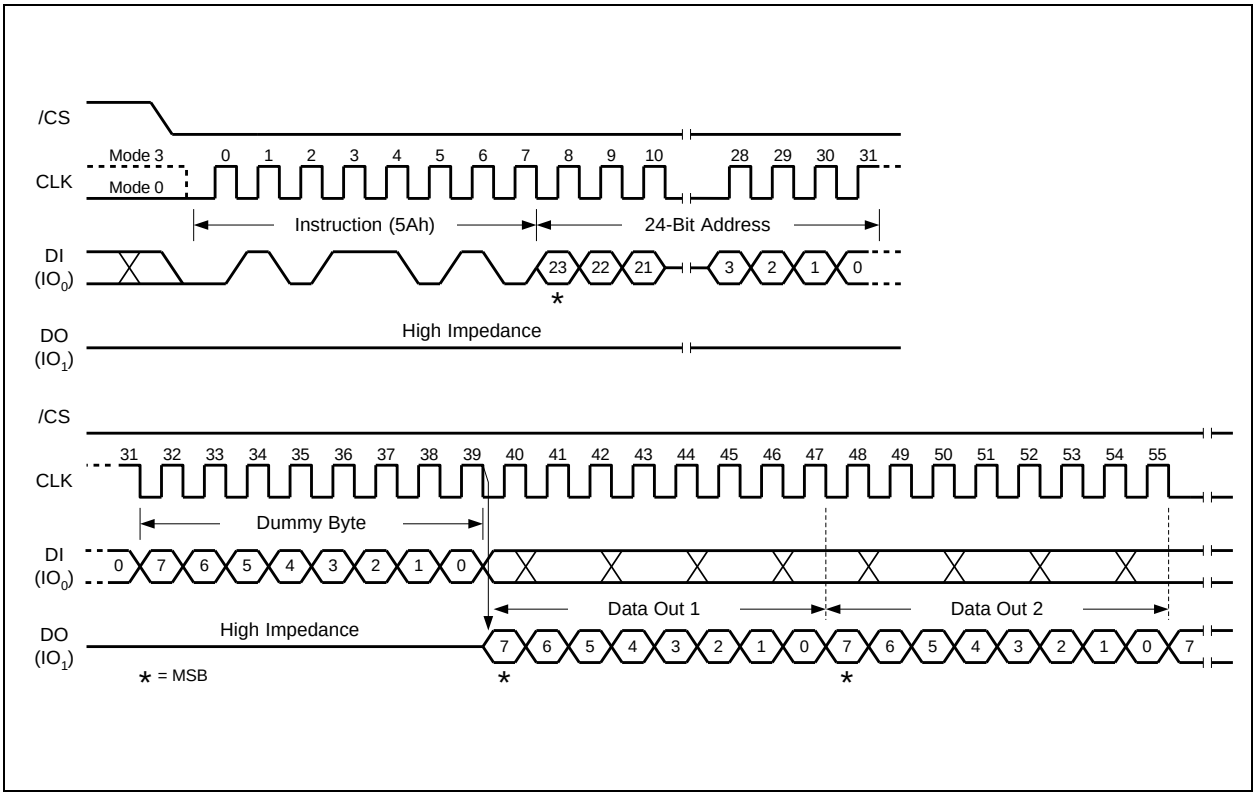


Figure 44. Read SFDP Register Instruction Sequence Diagram

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

7.2.29 Erase Security Registers (44h)

The W25Q80RV offers three 256-byte Security Registers which can be erased and programmed individually. These registers may be used by the system manufacturers to store security and other important information separately from the main memory array.

The Erase Security Register command is similar to the Sector Erase command. A Write Enable command must be executed before the device will accept the Erase Security Register Instruction (Status Register bit WEL must equal 1). The command is initiated by driving the /CS pin low and shifting the command code "44h" followed by a 24-bit address (A23-A0) to erase one of the three security registers.

ADDRESS	A23-16	A15-12	A11-8	A7-0
Security Register #1	00h	0 0 0 1	0 0 0 0	Don't Care
Security Register #2	00h	0 0 1 0	0 0 0 0	Don't Care
Security Register #3	00h	0 0 1 1	0 0 0 0	Don't Care

The Erase Security Register command sequence is shown in Figure 45. The /CS pin must be driven high after the eighth bit of the last byte has been latched. If this is not done the command will not be executed. After /CS is driven high, the self-timed Erase Security Register operation will commence for a time duration of t_{SE} (See AC Characteristics). While the Erase Security Register cycle is in progress, the Read Status Register command may still be accessed for checking the status of the BUSY bit. The BUSY bit is a 1 during the erase cycle and becomes a 0 when the cycle is finished and the device is ready to accept other commands again. After the Erase Security Register cycle has finished the, Write Enable Latch (WEL) bit in the Status Register is cleared to 0. The Security Register Lock Bits (LB3-1) in the Status Register-2 can be used to OTP protect the security registers. Once a lock bit is set to 1, the corresponding security register will be permanently locked, and the Erase Security Register command to that register will be ignored (Refer to section 7.1.8 for detail descriptions).

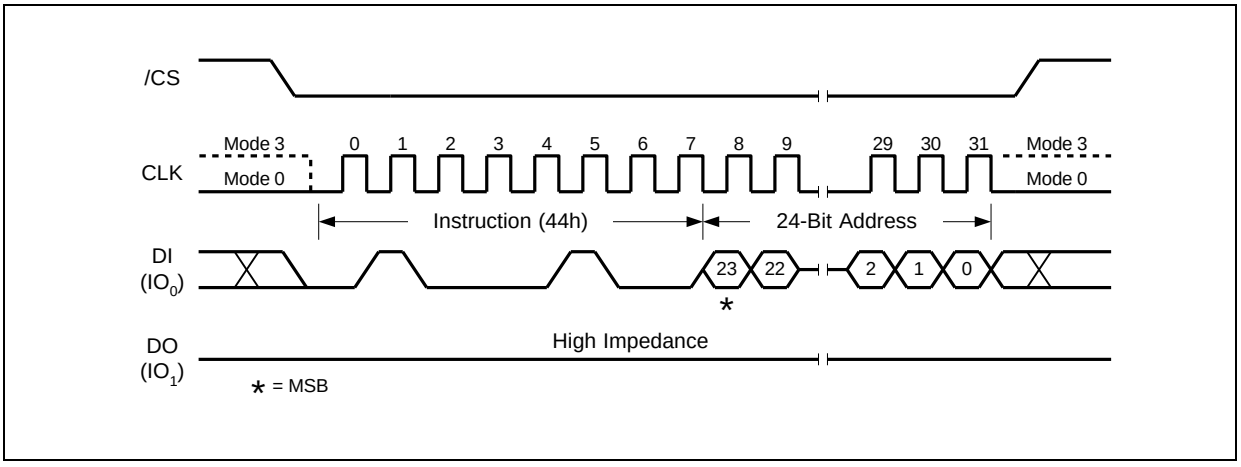


Figure 45. Erase Security Registers Instruction (SPI Mode only)

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

7.2.30 Program Security Registers (42h)

The Program Security Register command is similar to the Page Program command. It allows from one byte to 256 bytes of security register data to be programmed at previously erased (FFh) memory locations. A Write Enable command must be executed before the device will accept the Program Security Register Instruction (Status Register bit WEL= 1). The command is initiated by driving the /CS pin low then shifting the command code “42h” followed by a 24-bit address (A23-A0) and at least one data byte, into the DI pin. The /CS pin must be held low for the entire length of the command while data is being sent to the device.

ADDRESS	A23-16	A15-12	A11-8	A7-0
Security Register #1	00h	0 0 0 1	0 0 0 0	Byte Address
Security Register #2	00h	0 0 1 0	0 0 0 0	Byte Address
Security Register #3	00h	0 0 1 1	0 0 0 0	Byte Address

The Program Security Register command sequence is shown in Figure 46. The Security Register Lock Bits (LB3-1) in the Status Register-2 can be used to OTP protect the security registers. Once a lock bit is set to 1, the corresponding security register will be permanently locked, Program Security Register command to that register will be ignored (See 7.1.8, 8.2.25 for detail descriptions).

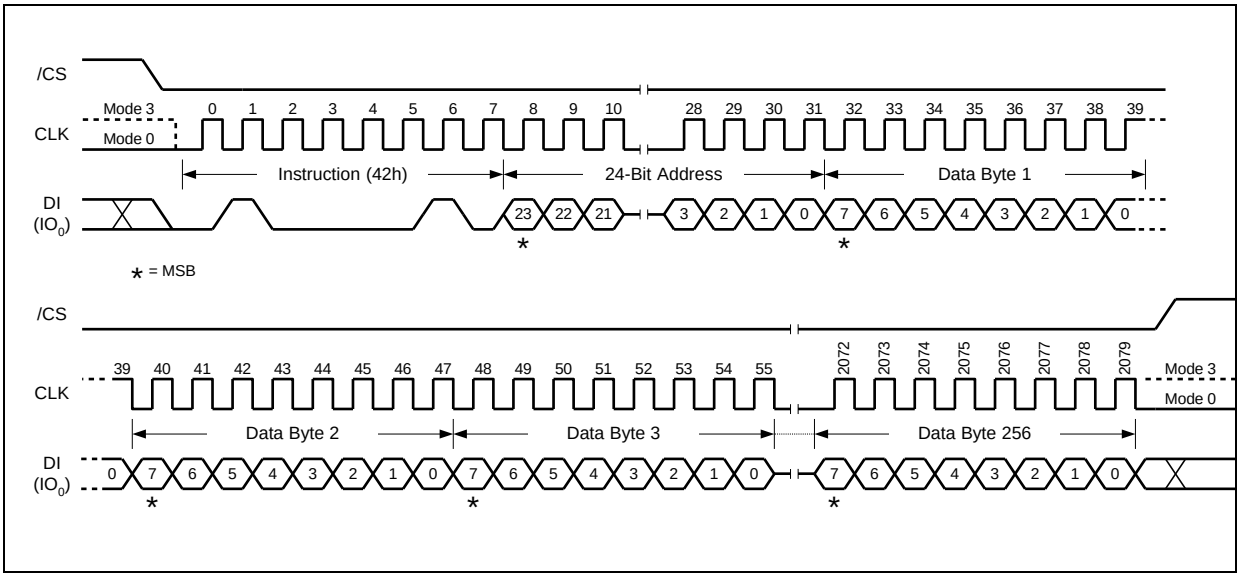


Figure 46. Program Security Registers Instruction (SPI Mode only)

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

7.2.31 Read Security Registers (48h)

The Read Security Register command is similar to the Fast Read command and allows one or more data bytes to be sequentially read from one of the four security registers. The command is initiated by driving the /CS pin low and then shifting the command code “48h” followed by a 24-bit address (A23-A0) and eight “dummy” clocks into the DI pin. The code and address bits are latched on the rising edge of the CLK pin. After the address is received, the data byte of the addressed memory location will be shifted out on the DO pin at the falling edge of CLK with most significant bit (MSB) first. The byte address is automatically incremented to the next byte address after each byte of data is shifted out. Once the byte address reaches the last byte of the register (byte address FFh), it will reset to address 00h, the first byte of the register, and continue to increment. The command is completed by driving /CS high. The Read Security Register command sequence is shown in Figure 47. If a Read Security Register command is issued while an Erase, Program or Write cycle is in process (BUSY=1) the command is ignored and will not have any effects on the current cycle. The Read Security Register command allows clock rates from D.C. to a maximum of F_R (see AC Electrical Characteristics).

ADDRESS	A23-16	A15-12	A11-8	A7-0
Security Register #1	00h	0 0 0 1	0 0 0 0	Byte Address
Security Register #2	00h	0 0 1 0	0 0 0 0	Byte Address
Security Register #3	00h	0 0 1 1	0 0 0 0	Byte Address

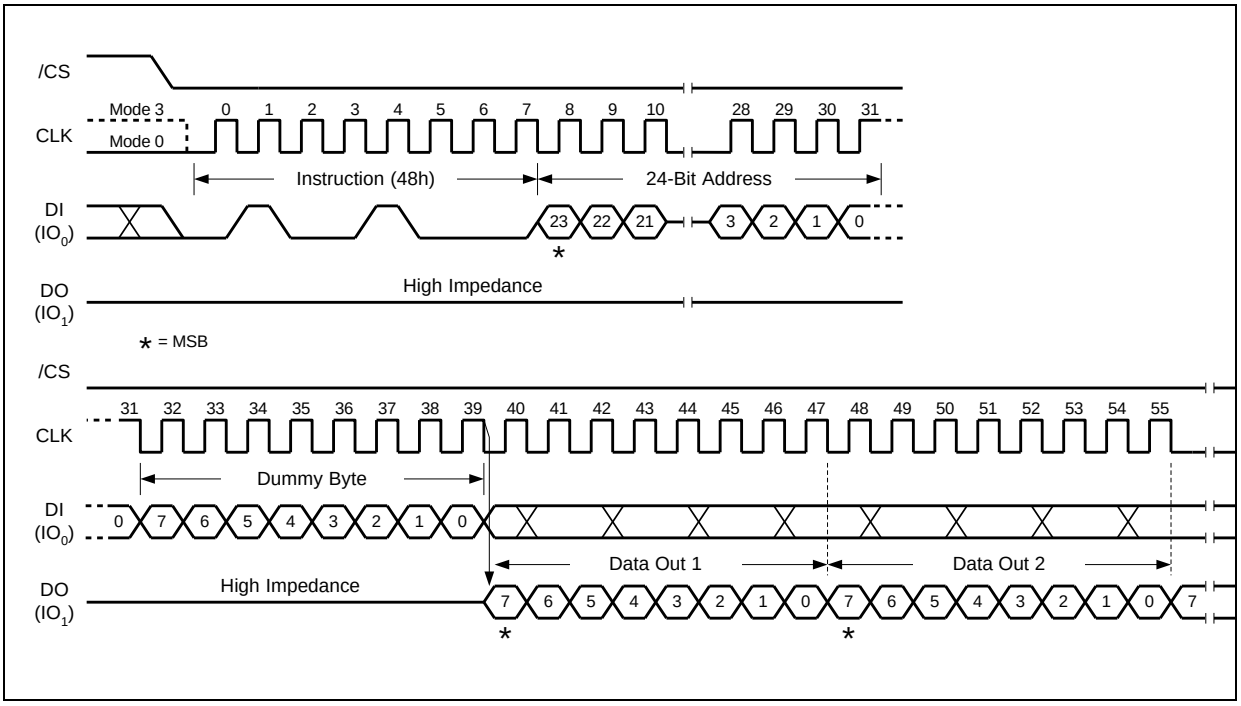


Figure 47. Read Security Registers Instruction (SPI Mode only)

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

7.2.32 Set Read Parameters (C0h)

"Set Read Parameters (C0h)" command is used to accommodate a wide range of applications with different needs for either maximum read frequency or minimum data access latency. This is accomplished by setting the number of dummy clocks and wrap length configurations for set of selected commands. Set Read Parameters (C0h) command writes to the Read Parameter Register (P[7:0]). P[6:4] bits is the dummy clocks configuration, while P[1:0] bits is the wrap length configuration for QPI mode only.

In SPI mode, SPI Set Read Parameters (C0h)" command writes to 'Dummy Clocks' P[6:4] bits only, while it will ignore 'Wrap Length' P[1:0] bits input as they are don't care in SPI mode. Conversely, QPI Set Read Parameters command will write both to the P[6:4] and P[1:0] Read Parameter bits. The Set Read Parameters command sequence is shown in Figure 54.

Set Read Parameters command (SPI or QPI) is used to configure the number of dummy cycles through P[6:4] Read Parameter bits for the following SPI and QPI, commands:
- Standard SPI mode: Fast Read Quad I/O (EBh) command
- QPI mode: Fast Read (0Bh), Fast Read Quad I/O (EBh), and Burst Read with Wrap (0Ch) commands

In QPI mode only, Set Read Parameters command to P[1:0] Read Parameter bits is used to configure the "Wrap Length" for the following QPI read with wrap commands:
- QPI mode: Burst Read with Wrap (0Ch) command

QPI "Wrap Length" (P[1:0] bits) is the field setting for the number of bytes to burst read (8, 16, 32, or 64 bytes) before a wrap-around to the starting address. The Wrap Length set by P[1;0] is only applicable in QPI mode and not in SPI mode. The "Fast Read Quad I/O (EBh)", "Fast Read (0Bh)", commands do not support wrap around feature in QPI mode.

The dummy clocks for various Fast Read commands in Standard/Dual/Quad SPI mode are fixed, except for "Fast Read Quad I/O (EBh)" commands. Please refer to the Instruction Tables for details. "Wrap Length" for the SPI "Fast Read Quad I/O (EBh)" command is set by W6-4 bit with the "Set Burst with Wrap (77h)" command.

The Wrap bits (Set Burst with Wrap '77h') as well as Read Parameter bits P[7:0] setting will remain unchanged when the device is switched from Standard SPI mode to QPI mode or vice versa. It is very important that the required dummy cycles and wrap length are set properly before executing the SPI (EBh), QPI (0Bh, EBh, 0Ch) commands.

The default Parameter Read "Dummy Clocks" and "Wrap Length" settings for selected SPI and QPI read commands after power up or reset are defined on the tables below. After power up or reset, Read Parameter bits are reset to 000h. Detailed Read Parameter bits configuration are also shown below.

SPI/QPI P6 P5 P4	DUMMY CLOCKS	MAXIMUM READ FREQ(1)	MAXIMUM READ FREQ.(2)
0 0 0	6 (def)	133MHz	104MHz
0 0 1	6	133MHz	104MHz
0 1 0	6	133MHz	104MHz
0 1 1	8	133MHz	104MHz
1 0 0	10	133MHz	104MHz
1 0 1	12	133MHz	104MHz
1 1 0	14	133MHz	104MHz
1 1 1	16	166MHz	133MHz

QPI P1 – P0	WRAP LENGTH
0 0	8-byte
0 1	16-byte
1 0	32-byte
1 1	64-byte

1. 4-bytes address alignment for Read, start address from [A1,A0]=(0,0).
2. No restrictions on the starting address, such as 4-bytes address alignment for Read

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

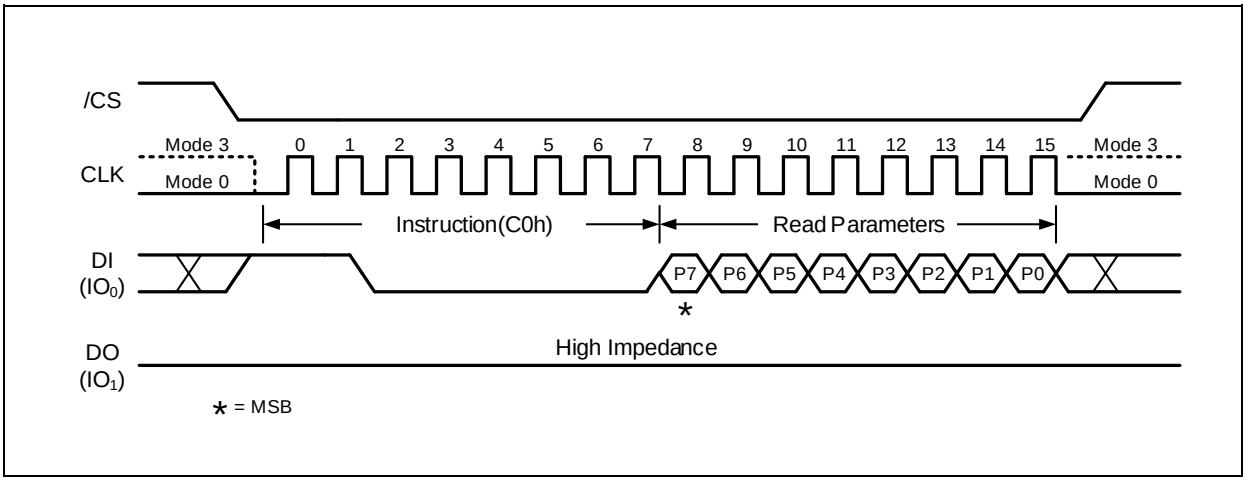


Figure 54a. Set Read Parameters Instruction (SPI Mode)
"Set Read Parameters" command (C0h) can set the number of dummy clocks.

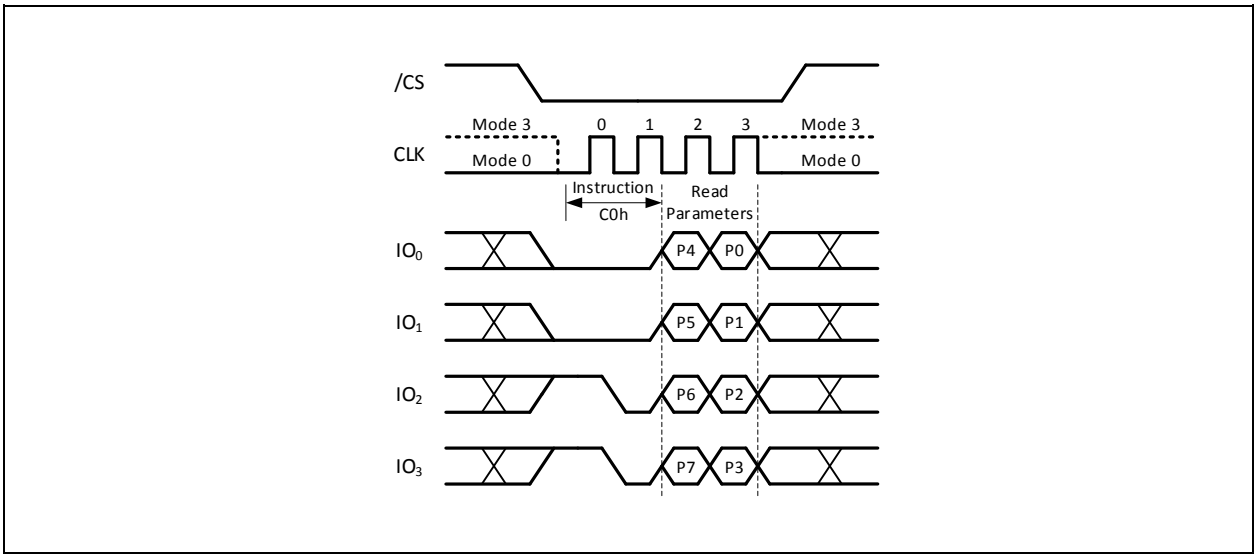


Figure 54b. Set Read Parameters Instruction (QPI Mode)
"Set Read Parameters" command (C0h) can set the number of dummy clocks.

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

7.2.33 Burst Read with Wrap (0Ch)

The “Burst Read with Wrap (0Ch)” command provides an alternative way to perform the read operation with “Wrap Around” in QPI mode. The command is similar to the “Fast Read (0Bh)” command in QPI mode, except the addressing of the read operation will “Wrap Around” to the beginning boundary of the “Wrap Length” once the ending boundary is reached.

The “Wrap Length” and the number of dummy clocks can be configured by the “Set Read Parameters (C0h)” command.

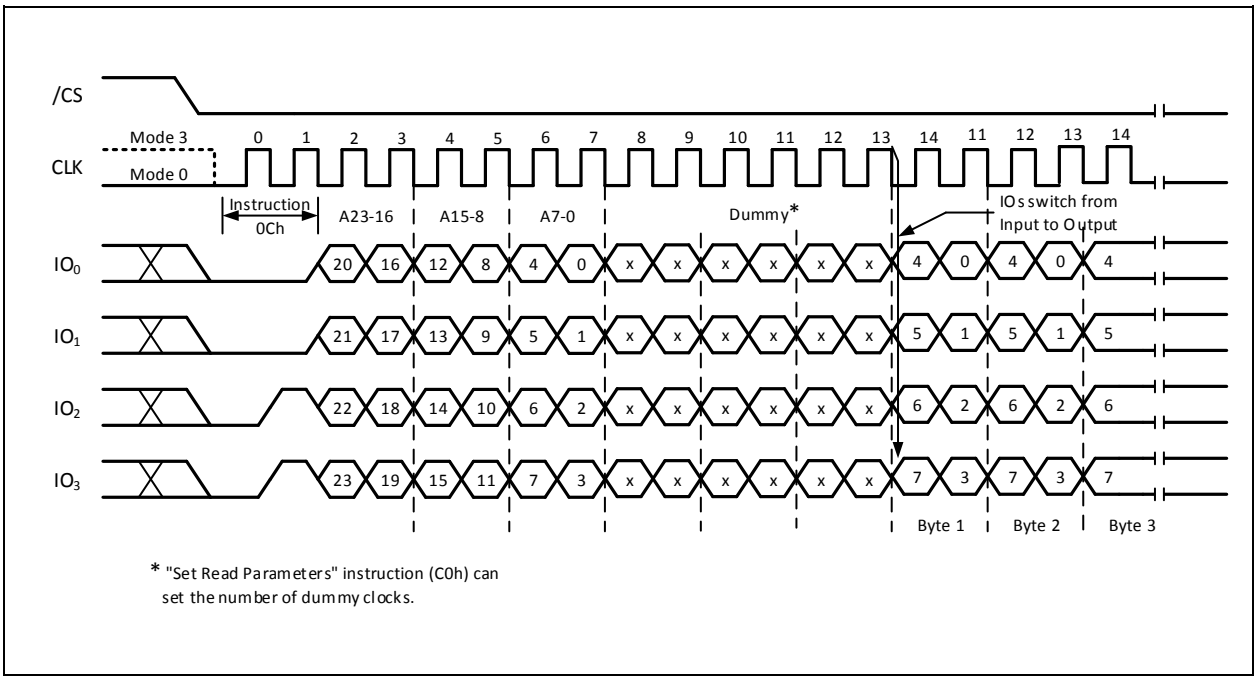


Figure 48. Burst Read with Wrap Instruction (QPI Mode only)

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

7.2.34 Enter QPI Mode (38h)

The W25Q80RV support both Standard/Dual/Quad Serial Peripheral Interface (SPI) and Quad Peripheral Interface (QPI). However, SPI mode and QPI mode cannot be used at the same time. “Enter QPI (38h)” command is the only way to switch the device from SPI mode to QPI mode.

Upon power-up, the default state of the device upon is Standard/Dual/Quad SPI mode. This provides full backward compatibility with earlier generations of Winbond serial flash memories. See Instruction Set Table 1-3 for all supported SPI commands. In order to switch the device to QPI mode, the Quad Enable (QE) bit in Status Register-2 must be set to 1 first, and an “Enter QPI (38h)” command must be issued. If the Quad Enable (QE) bit is 0, the “Enter QPI (38h)” command will be ignored and the device will remain in SPI mode.

See Instruction Set Table 3 for all the commands supported in QPI mode.

When the device is switched from SPI mode to QPI mode, the existing Write Enable and Program/Erase Suspend status, and the Wrap Length setting will remain unchanged.

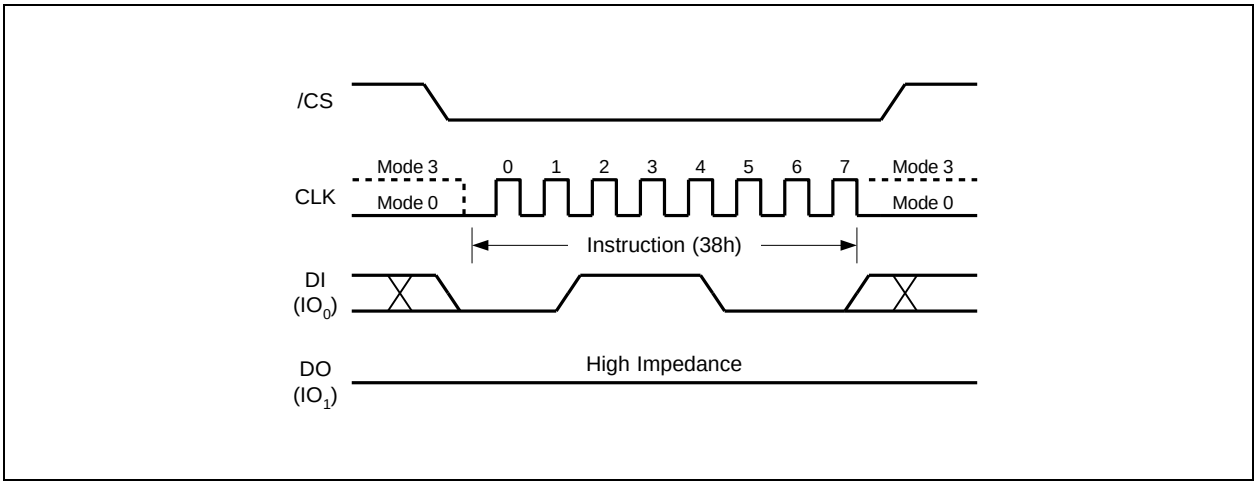


Figure 51. Enter QPI Instruction (SPI Mode only)

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

7.2.35 Exit QPI Mode (FFh)

In order to exit the QPI mode and return to the Standard/Dual/Quad SPI mode, an “Exit QPI (FFh)” command must be issued.

When the device is switched from QPI mode to SPI mode, the existing Write Enable Latch (WEL) and Program/Erase Suspend status, and the Wrap Length setting will remain unchanged.

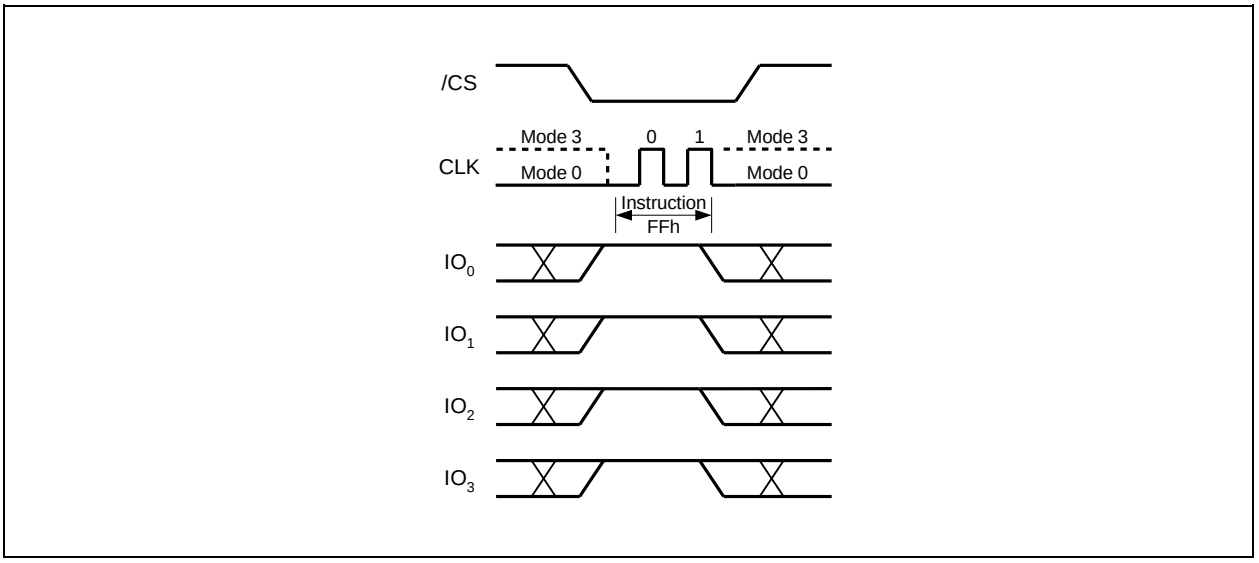


Figure 52. Exit QPI Instruction (QPI Mode only)

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

7.2.36 Enable Reset (66h) and Reset Device (99h)

Because of the small package and the limitation on the number of pins, the W25Q80RV provide a software Reset command instead of a dedicated RESET pin. Once the Reset command is accepted, any on-going internal operations will be terminated and the device will return to its default power-on state and lose all the current volatile settings, such as Volatile Status Register bits, Write Enable Latch (WEL) status, Program/Erase Suspend status, Read parameter setting (P7-P0), Read Command Bypass Mode bit setting (M7-M0) and Wrap Bit setting (W6-W4).

The “Enable Reset (66h)” and “Reset (99h)” commands can be issued in either SPI mode or QPI mode. To avoid accidental reset, both commands must be issued in sequence. Any other commands other than “Reset (99h)” after the “Enable Reset (66h)” command will disable the “Reset Enable” state. A new sequence of “Enable Reset (66h)” and “Reset (99h)” is needed to reset the device. Once the Reset command is accepted by the device, the device will take approximately tRST=30us to reset. During this period, no command will be accepted.

Data corruption may happen if there is an on-going or suspended internal Erase or Program operation when the Reset command sequence is accepted by the device. It is recommended to check the BUSY bit and the SUS bit in the Status Register before issuing the Reset command sequence.

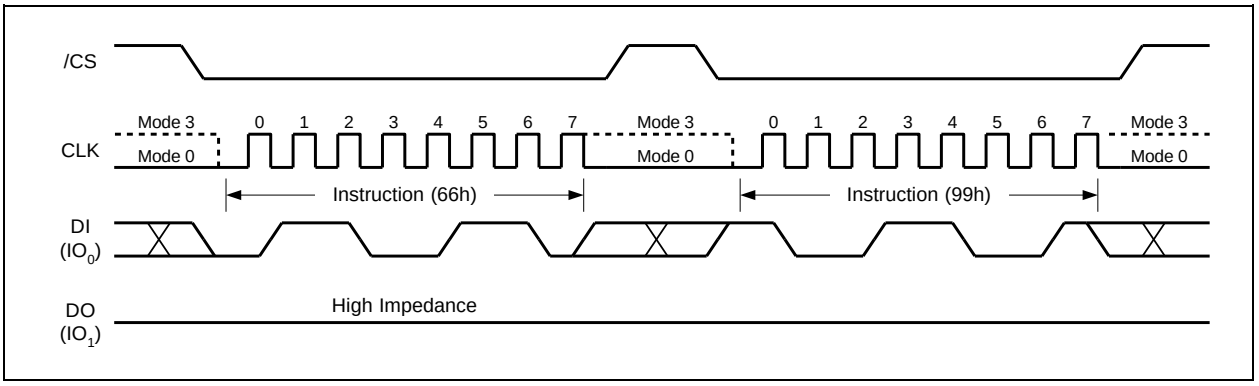


Figure 58a. Enable Reset and Reset Instruction Sequence (SPI Mode)

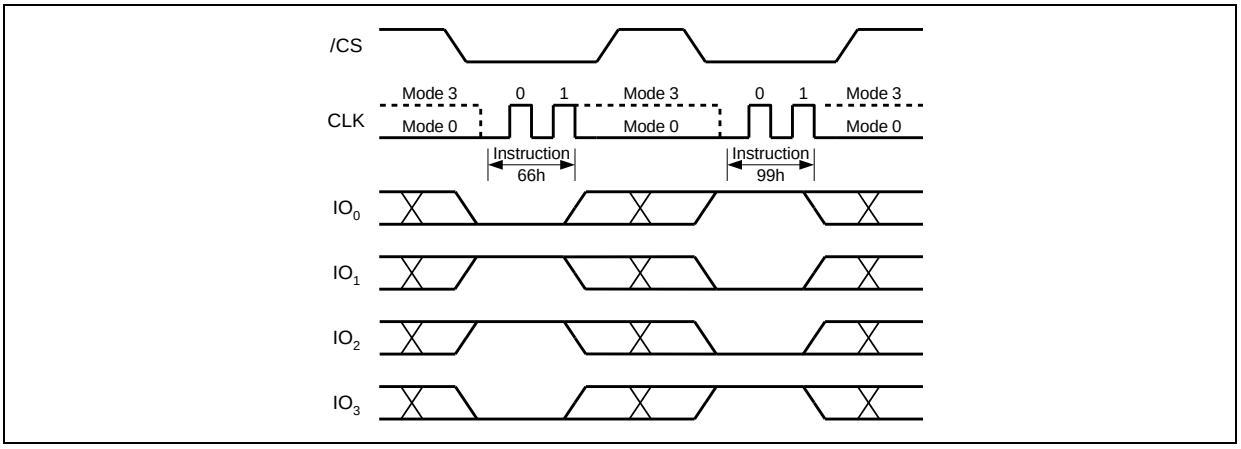


Figure 58b. Enable Reset and Reset Instruction Sequence (QPI Mode)

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

8. ELECTRICAL CHARACTERISTICS

8.1 Absolute Maximum Ratings (1)

PARAMETERS	SYMBOL	CONDITIONS	RANGE	UNIT
Supply Voltage	VCC		–0.6 to 4.6	V
Voltage Applied to Any Pin	VIO	Respect to VSS	–0.6 to VCC+0.4	V
Transient Voltage on any Pin	VIOT	<20nS Transient Respect to VSS	–2.0V to VCC+2.0V	V
Storage Temperature	TSTG		–65 to +150	°C
Lead Temperature	TLEAD		See Note (2)	°C
Electrostatic Discharge Voltage	VESD	Human Body Model(3)	–2000 to +2000	V

Notes:

1. This device has been designed and tested for the specified operation ranges. Proper operation outside of these levels is not guaranteed. Exposure to absolute maximum ratings may affect device reliability. Exposure beyond absolute maximum ratings may cause permanent damage.
2. Compliant with JEDEC Standard J-STD-20C for small body Sn-Pb or Pb-free (Green) assembly and the European directive on restrictions on hazardous substances (RoHS) 2002/95/EU.
3. JEDEC Std JESD22-A114A (C1=100pF, R1=1500 ohms, R2=500 ohms).

8.2 Operating Ranges

PARAMETER	SYMBOL	CONDITIONS	SPEC		UNIT
			MIN	MAX	
Supply Voltage(1)	VCC	F_R = 133MHz, f_R = 66MHz	2.7	3.6	V
Ambient Temperature, Operating	TA	Industrial Plus	–40	+105	°C

Note:

1. VCC voltage during Read can operate across the min and max range but should not exceed ±10% of the programming (erase/write) voltage.

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

8.3 Power-Up Power-Down Timing and Requirements

PARAMETERS	SYMBOL	CONDITIONS	RANGE	UNIT
Supply Voltage	VCC		–0.6 to 4.6	V
Voltage Applied to Any Pin	VIO	Respect to VSS	–0.6 to VCC+0.4	V
Transient Voltage on any Pin	VIOT	<20nS Transient Respect to VSS	–2.0V to VCC+2.0V	V
Storage Temperature	TSTG		–65 to +150	°C
Lead Temperature	TLEAD		See Note (2)	°C
Electrostatic Discharge Voltage	VESD	Human Body Model(3)	–2000 to +2000	V

Note:

1. These parameters are characterized only.

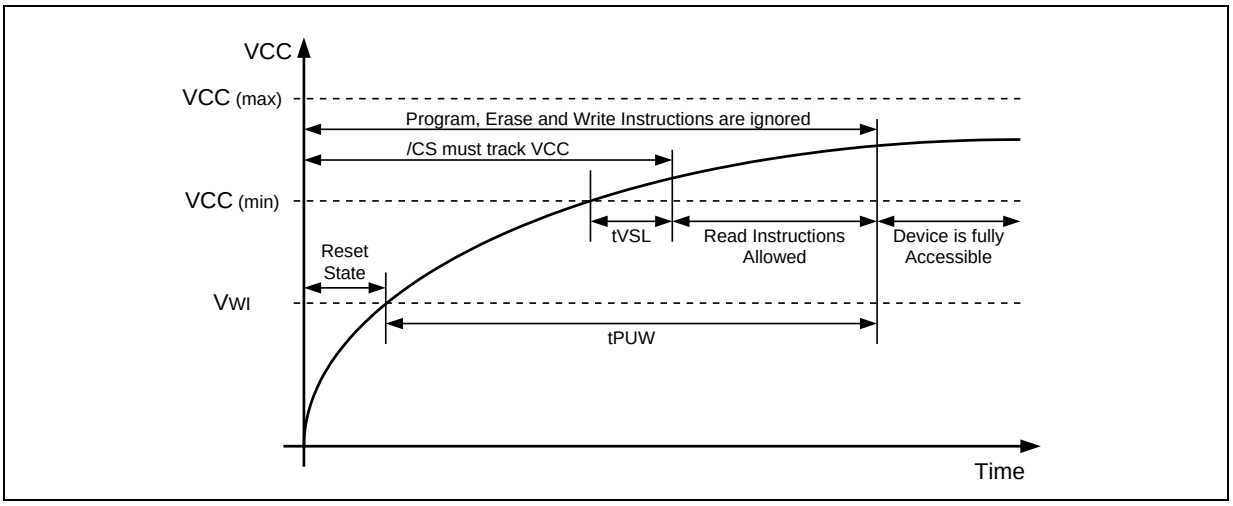


Figure 70a. Power-up Timing and Voltage Levels

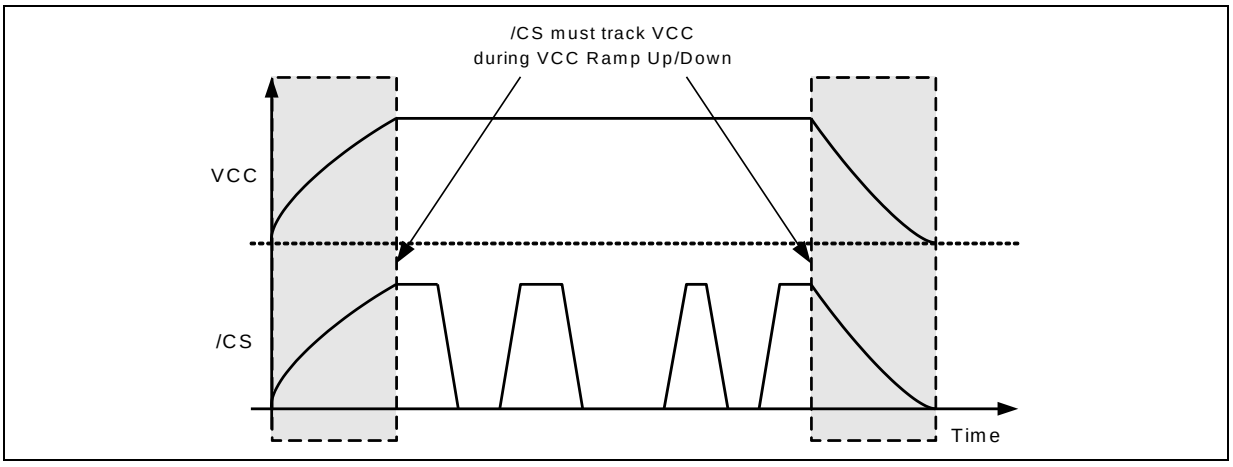


Figure 70b. Power-up, Power-Down Requirement

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

8.3.1 Power Cycle Requirement

For power cycle, the system must not initial the power-up sequence until Vcc drops down to V_{PWD} and keeps a t_{PWD} for device to initialize correctly.

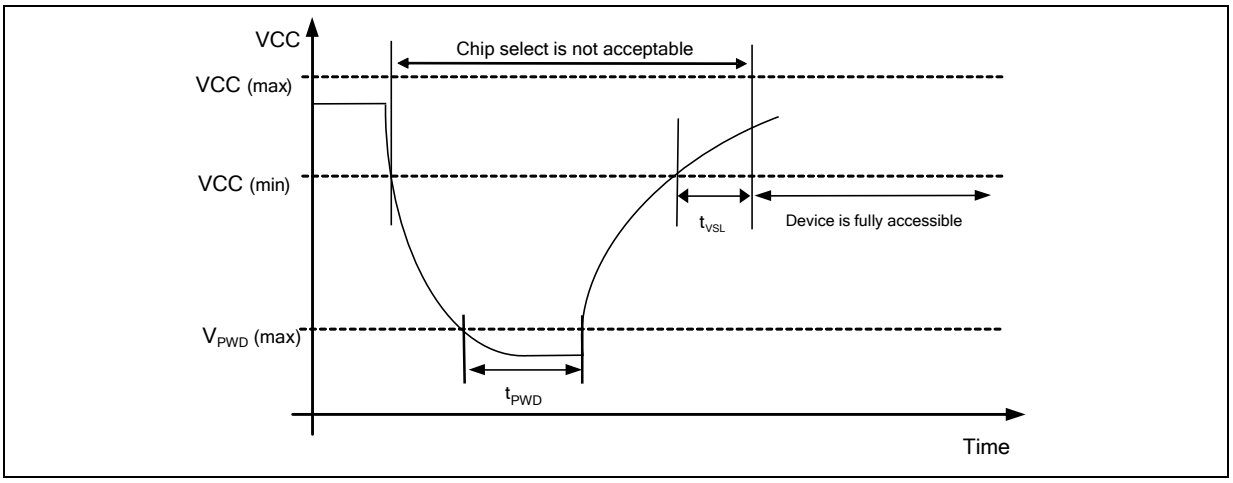


Figure 70c. Power Cycle Requirement

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

8.4 DC Electrical Characteristics(1)-

PARAMETER	SYMBOL	CONDITIONS	SPEC			UNIT
			MIN	TYP	MAX	
Input Capacitance	C_{IN}(1)	V_{IN} = 0V(1)			6	pF
Output Capacitance	Cout(1)	V_{OUT} = 0V(1)			8	pF
Input Leakage	I_{LI}				±2	µA
I/O Leakage	I_{LO}				±2	µA
Standby Current	I_{CC1}	/CS = VCC, (≤85℃) VIN = GND or VCC		10	28(3)	µA
		/CS = VCC, (≤105℃) VIN = GND or VCC			35	µA
Power-down Current	I_{CC2}	/CS = VCC, VIN = GND or VCC		0.1	5	µA
Read Data / Dual /Quad 50MHz(2) Current	I_{CC3}	C = 0.1 VCC / 0.9 VCC DO = Open		6	12	mA
Read Data / Dual /Quad 84MHz(2) Current	I_{CC3}	C = 0.1 VCC / 0.9 VCC DO = Open		7	15	mA
Read Data / Dual /Quad 104MHz(2) Current	I_{CC3}	C = 0.1 VCC / 0.9 VCC DO = Open		9	18	mA
Read Data / Dual /Quad 133MHz(2) Current	I_{CC3}	C = 0.1 VCC / 0.9 VCC DO = Open		11	20	mA
Write Status Register Current	I_{CC4}	/CS = VCC		8	15	mA
Page Program Current	I_{CC5}	/CS = VCC		8	15	mA
Sector/Block Erase Current	I_{CC6}	/CS = VCC		8	15	mA
Chip Erase Current	I_{CC7}	/CS = VCC		8	15	mA
Input Low Voltage	V_{IL}		–0.5		VCC x 0.3	V
Input High Voltage	V_{IH}		VCC x 0.7		VCC + 0.4	V
Output Low Voltage	V_{OL}	I_{OL} = 100 µA			0.2	V
Output High Voltage	V_{OH}	I_{OH} = –100 µA	VCC – 0.2			V

Notes:

1. Tested on sample basis and specified through design and characterization data. TA = 25° C, VCC = 3.0V.
2. Checker Board Pattern.
3. Value guaranteed by design and/or characterization, not 100% tested in production.

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

8.5 AC Measurement Conditions

PARAMETER	SYMBOL	SPEC		UNIT
		MIN	MAX	
Load Capacitance	C_L		30	pF
Input Rise and Fall Times	T_R, T_F		5	ns
Input Pulse Voltages	V_{IN}	0.1 VCC to 0.9 VCC		V
Input Timing Reference Voltages	IN	0.3 VCC to 0.7 VCC		V
Output Timing Reference Voltages	OUT	0.5 VCC to 0.5 VCC		V

Note:

1. Output Hi-Z is defined as the point where data out is no longer driven.

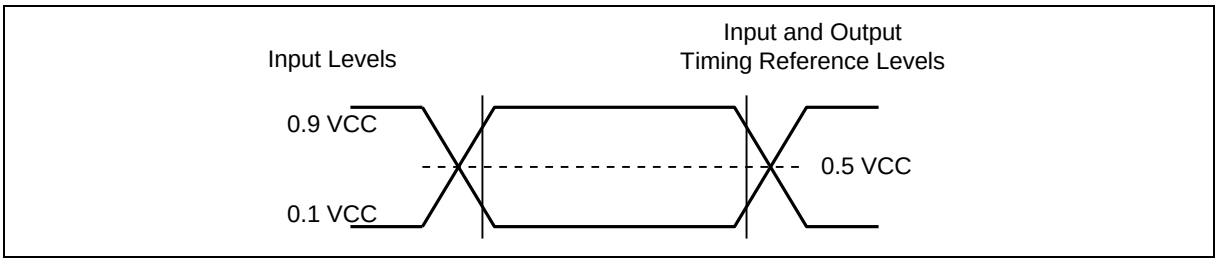


Figure 59. AC Measurement I/O Waveform

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

8.6 AC Electrical Characteristics[9]

DESCRIPTION	SYMBOL	ALT	SPEC			UNIT
			MIN	TYP	MAX	
Clock frequency for SPI & QPI Instructions with various dummy cycle[8]	F_R	f_{C1}	D.C.		166[6]	MHz
					133[7]	
Clock frequency for SPI & QPI Instructions except for Read Data (03h)	F_R	f_{C1}	D.C.		133[6]	MHz
					104[7]	
Clock frequency for Read Data Instruction (03h)	f_R		D.C.		84 [6]	MHz
					66[7]	
Clock High, Low Time for all commands except for Read Data (03h)	t_{CLH}, t_{CLL}[1]		45% PC			ns
Clock High, Low Time for Read Data (03h) command	t_{CRLH}, t_{CRLL}[1]		45% PC			ns
Clock Rise Time peak to peak	t_{CLCH}[2]		0.1			V/ns
Clock Fall Time peak to peak	t_{CHCL}[2]		0.1			V/ns
/CS Active Setup Time relative to CLK	t_{SLCH}	t_{CSS}	5			ns
/CS Not Active Hold Time relative to CLK	t_{CHSL}		5			ns
Data In Setup Time	t_{DVCH}	t_{DSU}	2			ns
Data In Hold Time	t_{CHDX}	t_{DH}	2.5			ns
/CS Active Hold Time relative to CLK	t_{CHSH}		3			ns
/CS Not Active Setup Time relative to CLK	t_{SHCH}		3			ns
/CS Deselect Time (for Read)	t_{SHSL1}	t_{CSH}	10			ns
/CS Deselect Time (for Erase or Program or Write)	t_{SHSL2}	t_{CSH}	50			ns
Output Disable Time	t_{SHQZ}[2]	t_{DIS}			7	ns
Clock Low to Output Valid	t_{CLQV}	t_V			4.5	ns
Output Hold Time	t_{CLQX}	t_{HO}	1			ns

Continued – next page AC Electrical Characteristics (cont'd)

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

AC Electrical Characteristics (cont'd)

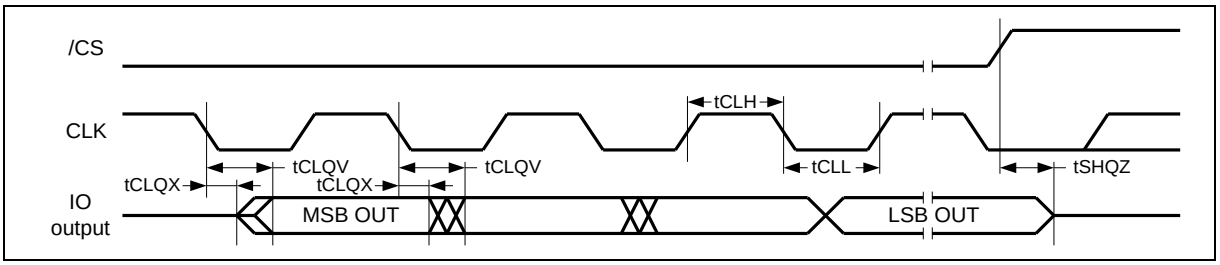
DESCRIPTION	SYMBOL	ALT	SPEC			UNIT
			MIN	TYP	MAX	
/HOLD Active Setup Time relative to CLK	t_{HLCH}		5			ns
/HOLD Active Hold Time relative to CLK	t_{CHHH}		5			ns
/HOLD Not Active Setup Time relative to CLK	t_{HHCH}		5			ns
/HOLD Not Active Hold Time relative to CLK	t_{CHHL}		5			ns
/HOLD to Output Low-Z	t_{HHQX}(2)	t_{LZ}			7	ns
/HOLD to Output High-Z	t_{HLQZ}(2)	t_{HZ}			12	ns
Write Protect Setup Time Before /CS Low	t_{WHSL}(3)		20			ns
Write Protect Hold Time After /CS High	t_{SHWL}(3)		100			ns
/CS High to Power-down Mode	t_{DP}(2)				3	µs
/CS High to Standby Mode without ID Read	t_{RES1}(2)				3	µs
/CS High to Standby Mode with ID Read	t_{RES2}(2)				1.8	µs
/CS High to next Instruction after Suspend	t_{SUS}(2)				20	µs
/CS High to next Instruction after Reset	t_{RST}(2)				30	µs
/RESET pin Low period to reset the device(5)	t_{RESET}(2)		1(4)			µs
Write Status Register Time	t_W			1.5	15	ms
Page Program Time	t_{PP}			0.25	2	ms
Sector Erase Time (4KB)	t_{SE}			30	240	ms
Block Erase Time (32KB)	t_{BE1}			80	800	ms
Block Erase Time (64KB)	t_{BE2}			120	1200	ms
Chip Erase Time	t_{CE}			2	10	s

Notes:

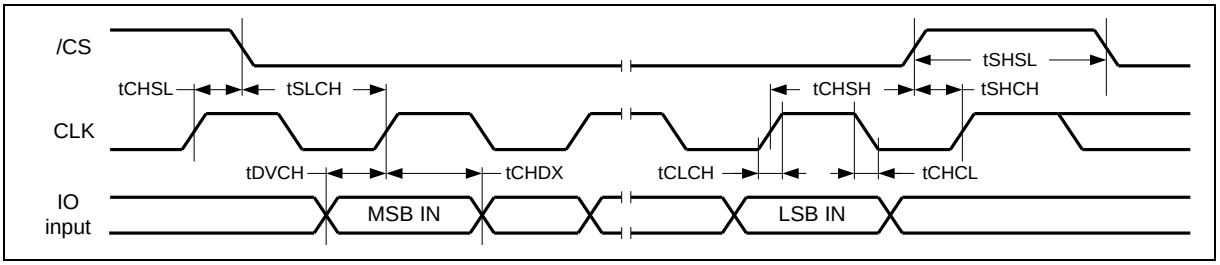
1. Clock high or Clock low must be more than or equal to 45%Pc. Pc=1/$fC_{(MAX)}$
2. Value guaranteed by design and/or characterization, not 100% tested in production.
3. Only applicable as a constraint for a Write Status Register command when SRP=1.
4. It's possible to reset the device with shorter t_{RESET} (as short as a few hundred ns), A1us minimum is recommended to ensure reliable operation.
5. Tested on sample basis and specified through design and characterization data. T_A = 25° C, VCC = 3.0V, 50-ohm driver strength.
6. 4-bytes address alignment for Read, start address from [A1,A0]=(0,0).
7. No restrictions on the starting address, such as 4-bytes address alignment for Read.
8. Please refer to the Set Read Parameters(C0h) section.
9. The functionality of QPI instructions is guaranteed by design and/or characterization, but they are not 100% tested.

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

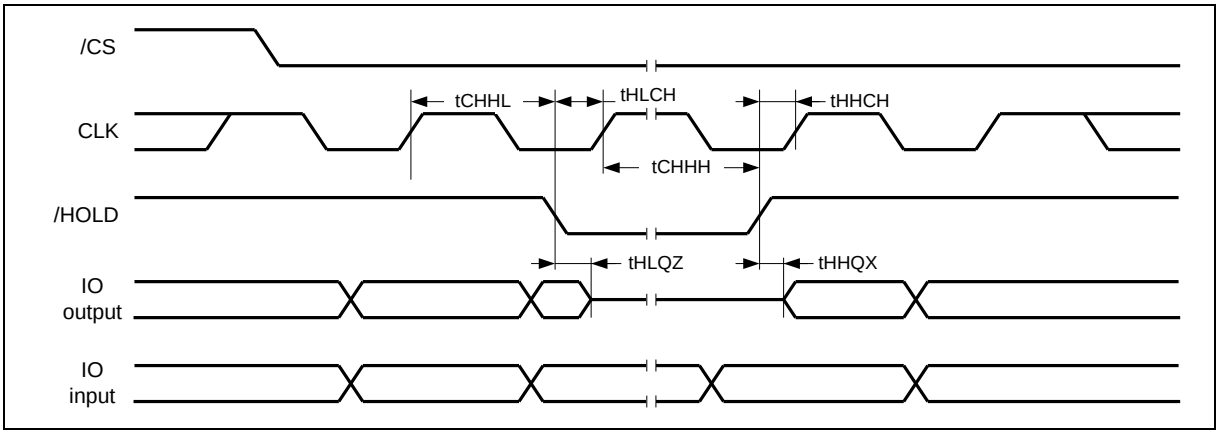
8.7 Serial Output Timing



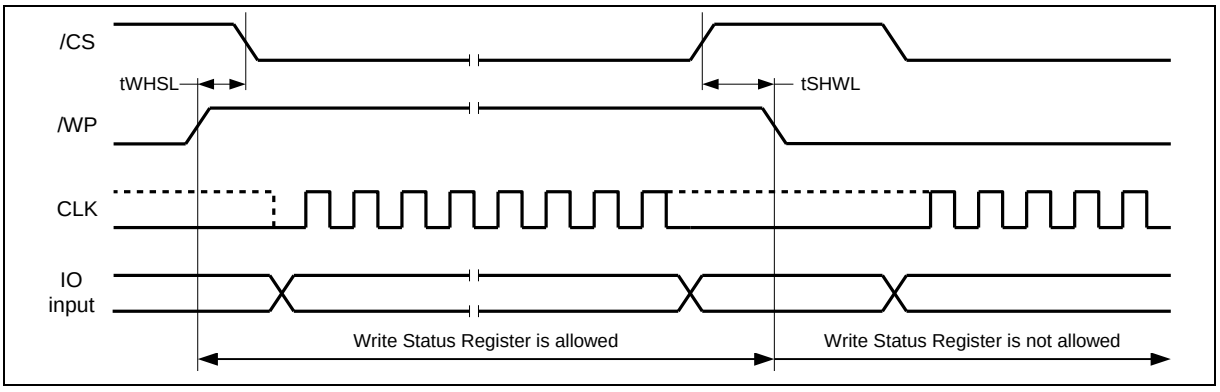
8.8 Serial Input Timing



8.9 /HOLD Timing



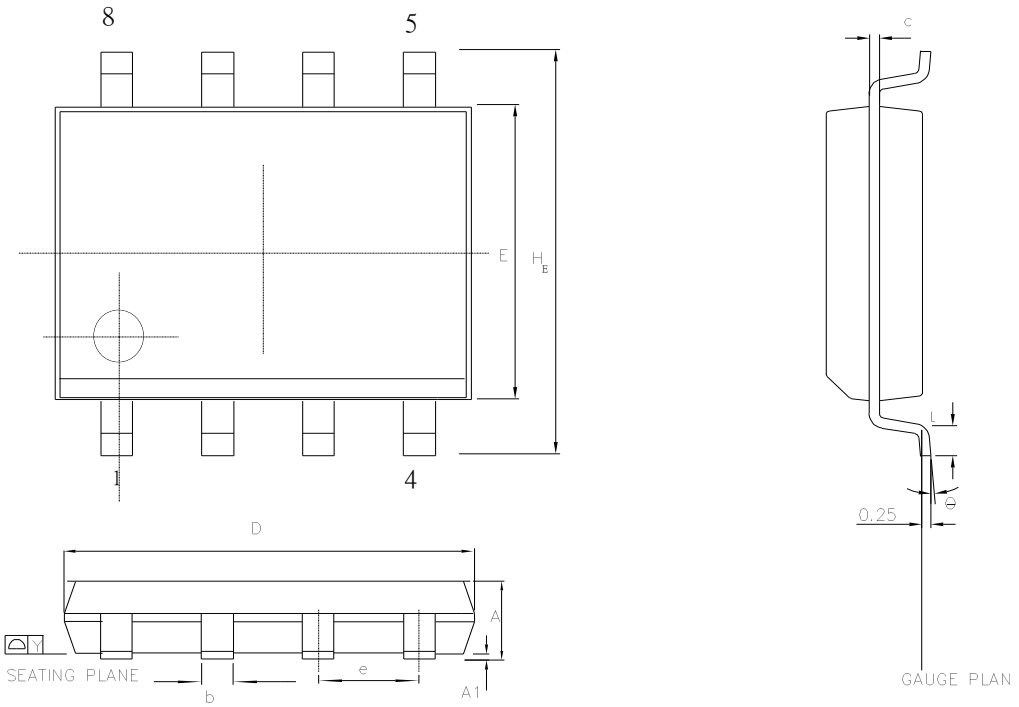
8.10 WP Timing



深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

9. PACKAGE SPECIFICATIONS

9.1 8-Pin SOP 150-mil (Package Code SN)

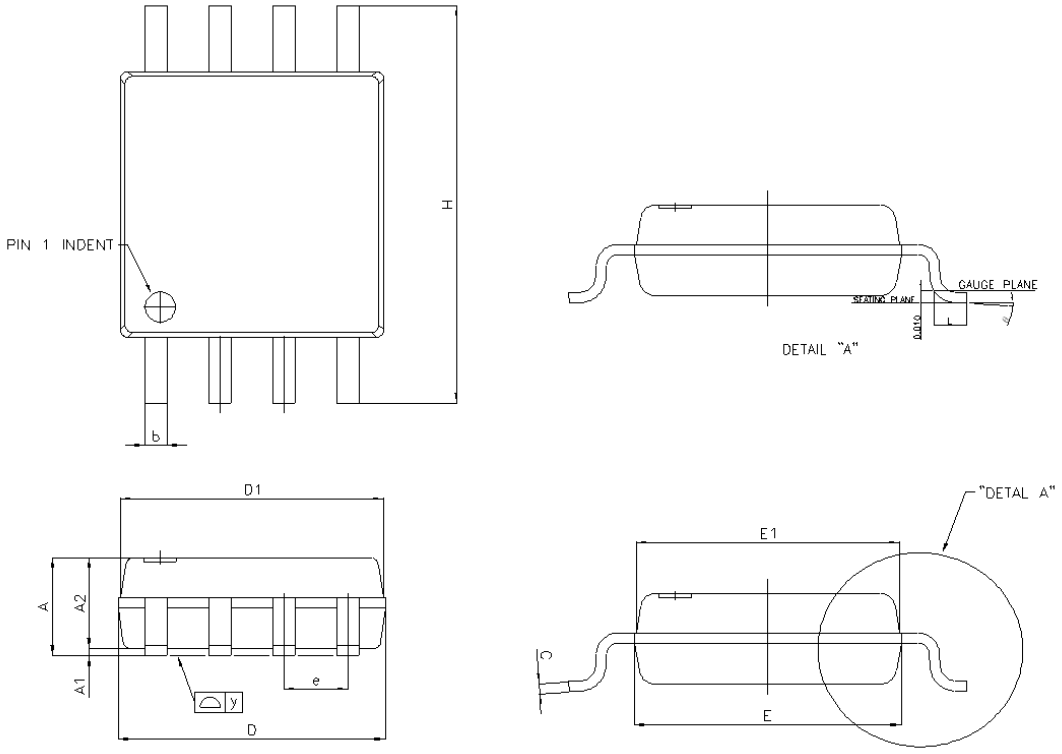


SYMBOL	MILLIMETERS			INCHES		
	Min	Nom	Max	Min	Nom	Max
A	1.35	1.60	1.75	0.053	0.062	0.069
A1	0.10	0.15	0.25	0.004	0.006	0.010
b	0.33	0.41	0.51	0.013	0.016	0.020
C	0.19	0.20	0.25	0.0075	0.0078	0.0098
D	4.80	4.85	5.00	0.188	0.190	0.197
E	3.80	3.90	4.00	0.150	0.153	0.157
H_E	5.80	6.00	6.20	0.228	0.236	0.244
e	1.27BSC			0.050BSC		
L	0.40	0.71	1.27	0.016	0.027	0.050
y	---	---	0.10	---	---	0.004
θ°	0°	---	10°	0°	---	10°

Note:
1. Control dimensions are in millimeter.
2. Both the package length and width do not include the mold flash. (Refer JEDEC MS-012)

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

9.2 8-Pin SOP 208-mil (Package Code SS)

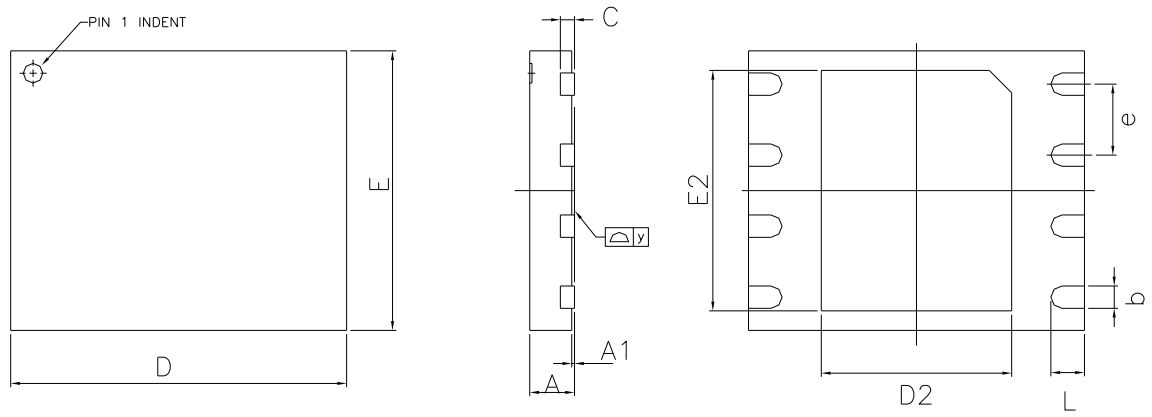


Symbol	Millimeters			Inches		
	Min	Nom	Max	Min	Nom	Max
A	1.75	1.95	2.16	0.069	0.077	0.085
A1	0.05	0.15	0.25	0.002	0.006	0.010
A2	1.70	1.80	1.91	0.067	0.071	0.075
b	0.35	0.42	0.48	0.014	0.017	0.019
C	0.19	0.20	0.25	0.007	0.008	0.010
D	5.18	5.28	5.38	0.204	0.208	0.212
D1	5.13	5.23	5.33	0.202	0.206	0.210
E	5.18	5.28	5.38	0.204	0.208	0.212
E1	5.13	5.23	5.33	0.202	0.206	0.210
e	1.27 BSC			0.050 BSC		
H	7.70	7.90	8.10	0.303	0.311	0.319
L	0.50	0.65	0.80	0.020	0.026	0.031
y	---	---	0.10	---	---	0.004
θ	0°	---	8°	0°	---	8°

Note:
1. Control dimensions are in millimeter.
2. Both the package length and width do not include the mold flash. (Refer JEDEC MS-012)

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

9.3 8-Pad WSON 6x5-mm (Package Code ZP)



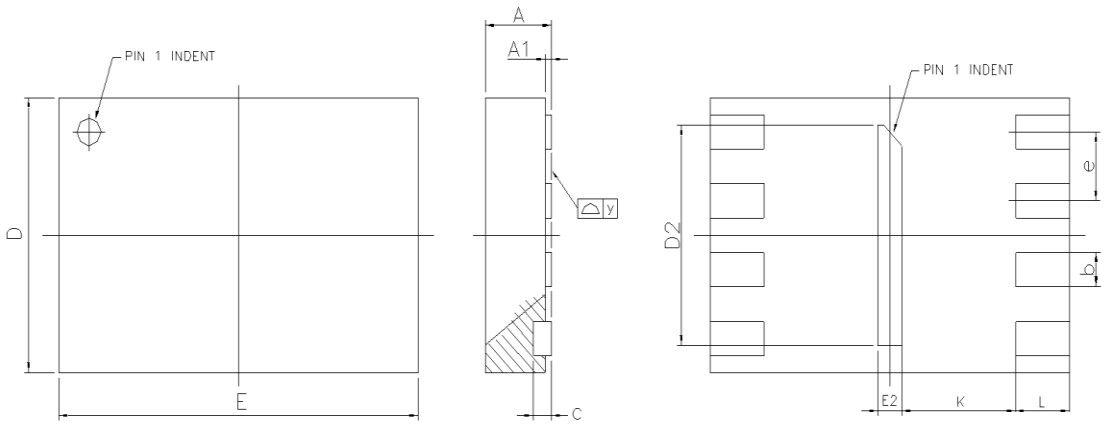
Symbol	Millimeters			Inches		
	Min	Nom	Max	Min	Nom	Max
A	0.70	0.75	0.80	0.028	0.030	0.031
A1	0.00	0.02	0.05	0.000	0.001	0.002
b	0.35	0.40	0.48	0.014	0.016	0.019
C	---	0.20 REF	---	---	0.008 REF	---
D	5.90	6.00	6.10	0.232	0.236	0.240
D2	3.35	3.40	3.45	0.132	0.134	0.136
E	4.90	5.00	5.10	0.193	0.197	0.201
E2	4.25	4.30	4.35	0.167	0.169	0.171
e	1.27 BSC			0.050 BSC		
L	0.55	0.60	0.65	0.022	0.024	0.026
y	0.00	---	0.075	0.000	---	0.003

Note:

The metal pad area on the bottom center of the package is not connected to any internal electrical signals. It can be left floating or connected to the device ground (VSS pin). Avoid placement of exposed PCB vias under the pad.

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

9.4 8-Pad XSON 2x3x0.4-mm (Package Code XH)



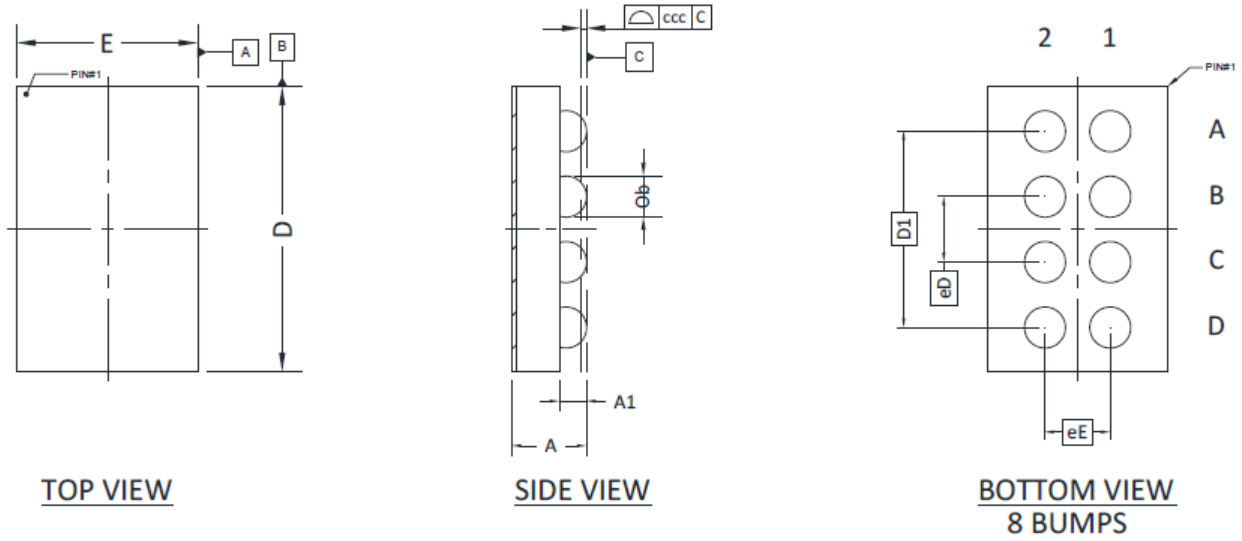
Symbol	Millimeters		
	Min	Nom	Max
A	0.30	0.35	0.40
A1	0.00	0.02	0.05
b	0.20	0.25	0.30
C	---	0.127 Ref.	---
D	1.90	2.00	2.10
D2	1.55	1.60	1.65
E	2.90	3.00	3.10
E2	0.15	0.20	0.25
e	---	0.50	---
K	0.95 Ref.		
L	0.40	0.45	0.50
y	0.00	---	0.075

Note:

The metal pad area on the bottom center of the package is not connected to any internal electrical signals. It can be left floating or connected to the device ground (VSS pin). Avoid placement of exposed PCB vias under the pad.

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

9.5 8-Ball WLCSP (Package Code BY)



Symbol	Millimeters			Inches		
	Min	Nom	Max	Min	Nom	Max
A	0.360	0.400	0.440	0.014	0.016	0.017
A1	0.125	0.145	0.165	0.005	0.006	0.006
D1	1.050 BSC			0.041 BSC		
eD	0.350 BSC			0.014 BSC		
eE	0.350 BSC			0.014 BSC		
b	0.195	0.220	0.245	0.008	0.009	0.010
aaa	0.100			0.004		
bbb	0.100			0.004		
ccc	0.050			0.002		
ddd	0.015			0.001		

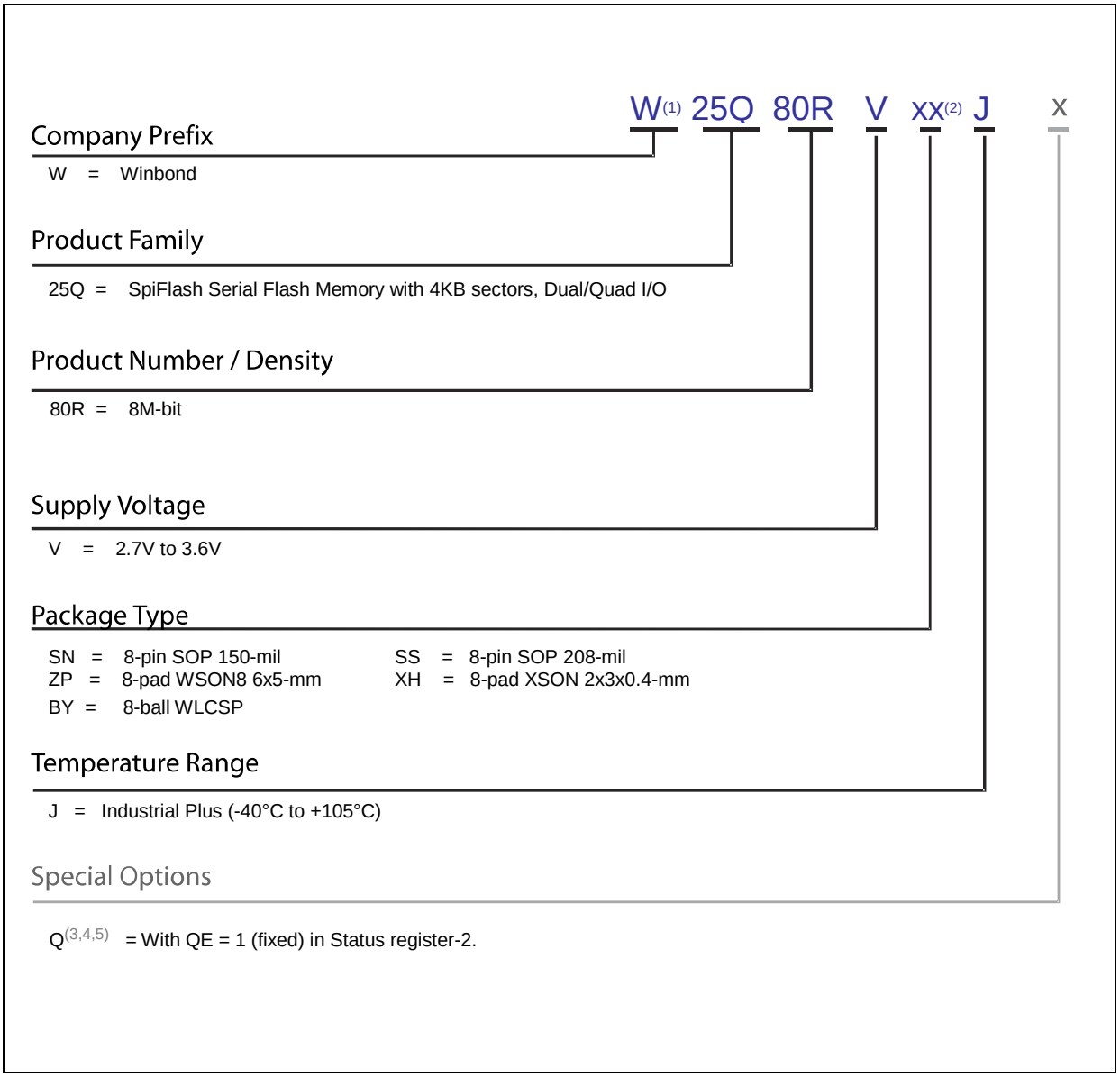
Note:

Dimension b is measured at the maximum solder bump diameter, parallel to primary datum C.

Dimension D/D1 and E/E1; please contact Winbond for details

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

10. ORDERING INFORMATION



Notes:

1. The “W” prefix is not included on the part marking.
2. Only the 2nd letter is used for the part marking; WSON package type ZP are not used for the part marking.
3. Standard bulk shipments are in Tube (shape E). Please specify alternate packing method, such as Tape and Reel (shape T) or Tray (shape S), when placing orders.
4. /HOLD function is disabled to support Standard, Dual and Quad I/O without user setting.
5. All devices are in compliance of RoHS, Halogen free, TSCA, REACH.
6. For DTR support or for the M option (QE=0), please refer to the W25Q80RV_ DTR datasheet.

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

10.1 Valid Part Numbers and Top Side Marking

The following table provides the valid part numbers for the W25Q80RV SpiFlash Memory. Please contact Winbond for specific availability by density and package type. Winbond SpiFlash memories use a 12-digit Product Number for ordering. However, due to limited space, the Top Side Marking on all packages uses an abbreviated 10-digit number.

W25Q80RV-JQ(-40°C to +105°C) valid part numbers:

PACKAGE TYPE	DENSITY	PRODUCT NUMBER	TOP SIDE MARKING
SN SOP-8 150-mil	8M-bit	W25Q80RVSNJQ	25Q80RVNJQ
SS SOP-8 208-mil	8M-bit	W25Q80RVSSJQ	25Q80RVSJQ
ZP WSON-8 6x5-mm	8M-bit	W25Q80RVZPJQ	25Q80RVJQ
XH(1) **XSON-8** 2x3x0.4(max.)mm³	8M-bit	W25Q80RVXHJQ	V4ywH(2,3) JQxxxx
BY(4) WLCSP-8	8M-bit	W25Q80RVBYJQ	aYA *yw(4)

Note:

1. These package types are special order, please contact Winbond for more information.
2. USON. has special top side marking due to size limitation
3. “yw” is date code
   “xxxx” is lot ID
4. “yw” is date code
5. For DTR support or for the M option (QE=0), please refer to the W25Q80RV_ DTR datasheet.

10.2 Initial delivery status

The memory array is delivered in the erased state, where all data bits are set to '1' (FFh per byte). This covers all Part Numbers listed in Section "Valid Part Numbers and Top Side Marking".

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

11. REVISION HISTORY

VERSION	DATE	PAGE	DESCRIPTION
A	11/02/2022	73 64 62,78-79	New Create Preliminary Datasheet Updated 50-ohm driver strength of note 5 Added 0Ch waveform Removed duplicated C0h & -IG part no.
B	09/27/2023	4,68,71,79 15 68 70 4,79 72	Removed preliminary Updated VCC at 2.7~3.6v Updated LB0 and QE bit information Updated Relative to Ground to Respect to VSS Updated ICC3 typ. & 133MHz & “current” location Updated GND as VSS Updated TCLQX value
C	12/28/2023	64	Updated C0h waveform
D	01/25/2024	70 73	Removed 85℃ Spec Added industrial plus information Updated ICC1~7 Spec Updated TW,TPP,TSE,TBE1,TBE2
E	06/06/2024	79	Updated Order inform
F	11/21/2025	70-71 63-64 74 77-78 6, 81-83 63-64, 74	Added Power cy Power Cycle Requirement Updated the 6T/16T clock of SPI/QPI Updated the 03h clock rate from 66MHz to 84MHz Added notice for SOP-150/208mil Added WLCSP information Added Note 7 “No restrictions on the starting address” for Read Clock
G	01/24/2025	75	Updated TCE Added note 9 for QPI instruction
H	06/09/2025	5,11,77-78,82-83	Updated format setting Updated SOIC to SOP
I	05/21/2026	7,11 72 26,48 87	Removed dedicated Reset pin information Updated TCE Added 31h/11h in 50h/75h Added Initial delivery status

Trademarks

Winbond and SpiFlash are trademarks of Winbond Electronics Corporation.
All other marks are the property of their respective owner

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com

Important Notice

Winbond products are not designed, intended, authorized or warranted for use as components in systems or equipment intended for surgical implantation, atomic energy control instruments, airplane or spaceship instruments, transportation instruments, traffic signal instruments, combustion control instruments, or for other applications intended to support or sustain life. Furthermore, *Winbond* products are not intended for applications wherein failure of *Winbond* products could result or lead to a situation wherein personal injury, death or severe property or environmental damage could occur. *Winbond* customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify *Winbond* for any damages resulting from such improper use or sales.

Information in this document is provided solely in connection with Winbond products. Winbond reserves the right to make changes, corrections, modifications or improvements to this document and the products and services described herein at any time, without notice.

Please note that all data and specifications are subject to change without notice.
All the trademarks of products and companies mentioned in this datasheet belong to their respective owners.

深圳市满度科技有限公司
Web:www.manduic.com
Tel:150-1290-5940
Email:sales@manduic.com